## Digitally Controllable Off-Line CV/CC ZVS Flyback <br> Switcher IC with 750 V and 900 V PowiGaN Switch, Synchronous Rectification and FluxLink Feedback

## Product Highlights

New in InnoSwitch5-Pro

- Zero voltage switching (ZVS) using advanced SR FET control - no active clamp required
- Supports very wide output voltage range 3 V to 30 V
- Native support for 28 V USB PD Extended Power Range (EPR)
- Lossless input line voltage sensing on the secondary-side for adaptive DCM/CCM/ZVS control
- Enables <2\% CC accuracy for UFCS protocol

Highly Integrated, Compact Footprint

- Robust 750 V and 900 V PowiGaN ${ }^{\text {TM }}$ primary switch options
- Steady-state switching frequency up to 140 kHz minimizes transformer size
- Synchronous rectification driver and secondary-side sensing
- Integrated FluxLink ${ }^{\text {TM }}$, HIPOT-isolated, feedback link
- Drives low-cost N-channel FET series load switch
- Integrated 3.6 V supply for external MCU

Digitally Controlled via $\mathbf{I}^{2} \mathbf{C}$ Interface

- Precise CV, CC, CP Control
- Dynamic adjustment of power supply voltage and current
- Selectable DCM-only operation to reduce SR FET voltage stress
- Optimized command set to reduce $I^{2} C$ traffic
- Telemetry for power supply status and fault monitoring

EcoSmart ${ }^{\text {TM }}$ - Energy Efficient

- Enables >95\% efficiency
- Less than 30 mW no-load including line sense and MCU

Advanced Protection / Safety Features

- Series load switch short-circuit protection
- Disable output fault response
- Fast input line UV/OV protection
- Programmable Output OV/UV fault detection and response
- Open SR FET gate detection
- Hysteretic thermal shutdown
- Programmable watchdog timer for system faults

Full Safety and Regulatory Compliance

- Reinforced isolation >4000 VAC
- $100 \%$ production HIPOT testing
- UL1577 isolation voltage 4000 VAC (max) safety approved. TUV (EN62368-1) and CQC (GB4943.1) safety pending


## Green Package

- Halogen free and RoHS compliant


## Applications

- High density power adapters
- Multiprotocol adapters including USB PD + PPS, 28 V USB PD EPR, QC, VOOC, VFC, SCP, UFCS
- Direct-charge mobile device chargers
- Multi-chemistry tool and general purpose battery chargers
- Adjustable CV and CC LED ballast


## Description

The InnoSwitch ${ }^{\text {TM } 5-P r o ~ f a m i l y ~ o f ~ I C s ~ s u b s t a n t i a l l y ~ r e d u c e s ~ t h e ~ s i z e ~ o f ~}$ power adapters. Switching frequency of up to 140 kHz and a very high level of integration combine to reduce the component volume and PCB board area required by a typical adapter implementation.


Figure 1. Typical Application schematic.


Figure 2. High Creepage, Safety-Compliant InSOP-T28D Package.

## Output Power Table ${ }^{1}$

| Product ${ }^{4,5}$ | 750 V PowiGaN Switch |  |  |  |
| :---: | :---: | :---: | :---: | :---: |
|  | 230 VAC $\pm 15 \%$ |  | 85-264 VAC |  |
|  | Adapter ${ }^{2}$ | Open Frame ${ }^{3}$ | Adapter ${ }^{2}$ | Open Frame ${ }^{3}$ |
| INN5375F | 90 W | 100 W | 75 W | 90 W |
| INN5376F | 115 W | 125 W | 80 W | 115 W |
| INN5377F | 135 W | 145 W | 90 W | 135 W |
| Product ${ }^{4,5}$ | 900 V PowiGaN Switch |  |  |  |
| INN5396F | 115 W | 125 W | 80 W | 115 W |
| Product ${ }^{4,5}$ | 750 PowiGaN Switch |  |  |  |
|  | 230 VAC $\pm 15 \%$ |  | 385 VDC (PFC Input) |  |
|  | Adapter ${ }^{2}$ | Open Frame ${ }^{3}$ | Adapter ${ }^{2}$ | Open Frame ${ }^{3}$ |
| INN5475F | 105 W | 130 W | 160 W | 180 W |
| INN5476F | 140 W | 160 W | 180 W | 200 W |
| INN5477F | 170 W | 190 W | 200 W | 220 W |
| Product ${ }^{4,5}$ | 900 V PowiGaN Switch |  |  |  |
| INN5496F | 140 W | 160 W | 180 W | 200 W |

Table 1. Output Power Table.
Notes:

1. Maximum output power is dependent on the design, with maximum IC package temperature kept $<125^{\circ} \mathrm{C}$.
2. Minimum continuous power in a typical non-ventilated enclosed typical size adapter measured at $40^{\circ} \mathrm{C}$ ambient.
3. Minimum peak power capability.
4. F Package: InSOP-T28D.
5. INN53xx series optimized for universal AC input designs.

INN54xx series optimized for peak power designs with PFC input.
InnoSwitch5-Pro ICs achieve zero voltage switching in discontinuous conduction mode using advanced SR FET control. Overall system efficiency exceeds $95 \%$, allowing designers to eliminate heat sinks, spreaders and potting materials for thermal management, further reducing size, component cost and manufacturing complexity. The integration of PowiGaN primary switch and controller, isolated feedback and secondary controller with an $\mathrm{I}^{2} \mathrm{C}$ interface simplifies the development and manufacturing of fully programmable, highly efficient power supplies.


Figure 3. Primary Controller Block Diagram.


Figure 4. Secondary Controller Block Diagram.

## Pin Functional Description

## ISENSE (IS) Pin (Pin 1)

Connection to the power supply return output terminals. An external current sense resistor should be connected between this and the SECONDARY GROUND pin.

## SECONDARY GROUND (GND) (Pin 2)

Ground reference for the secondary IC. Note this is not the power supply output ground due to the presence of the sense resistor between this and the ISENSE pin.

## NC Pin (Pin 3)

Leave it open. Should not be connected to any other pins.
SECONDARY BYPASS (BPS) Pin (Pin 4)
It is the connection point for an external bypass capacitor for the secondary IC supply.

## $\mathbf{I}^{2} \mathbf{C}$ Clock (SCL) Pin (Pin 5)

$\mathrm{I}^{2} \mathrm{C}$ serial communication protocol clock line sourced by the Bus master.

## $I^{2} \mathbf{C}$ Serial Data (SDA) Pin (Pin 6)

$I^{2} \mathrm{C}$ serial communication protocol data line sourced by the Bus master.

## External VCC Supply (uVCC) Pin (Pin 7)

This is 3.6 V supply for an external controller.
VBUS Series Switch Drive and Load Discharge (VB/D) Pin (Pin 8) VBUS enable and driver for NMOS gate for VOUT to VBUS series pass FET(s). This pin is also used to discharge output load voltage (VBUS).

## SYNCHRONOUS RECTIFIER DRIVE (SR) Pin (Pin 9)

Gate driver output and connection to external SR FET gate.

## OUTPUT VOLTAGE (VOUT) Pin (Pin 10)

Connected directly to the output voltage providing current for the secondary IC and sense for output voltage regulation. This pin also has an active/programmable pull-down current source.

## FORWARD (FWD) Pin (Pin 11)

The connection point to the switching node of the transformer output winding provides information on the primary switch timing plus providing power for the secondary IC when VOUT is below a threshold value.
NC Pin (Pin 12-14)
Leave it open. Should not be connected to any other pins.


Figure 5. Pin Configuration.

## UNDER/OVER INPUT VOLTAGE (V) Pin (Pin 15)

A high-voltage pin connected to the AC or DC side of the input bridge for detecting under and overvoltage conditions at the power supply input. When connected to the AC side of the bridge, a high-voltage switch is opened when not sensing to reduce power consumption. This pin should be tied to GND to disable UV/OV protection.
NC Pin (Pin 16)
Leave open or connect to SOURCE pin or BPP pin.

## PRIMARY BYPASS (BPP) Pin (Pin 17)

The connection point for an external bypass capacitor for the primary IC supply. This is also the ILIM selection pin for choosing standard ILIM or ILIM+1.
HSD Pin (Pin 18)
HSD pin should be tied to ground.

## SOURCE (S) Pin (Pin 19)

These pins are the power switch source connection. It is also ground reference for primary BYPASS pin.

## DRAIN (D) Pin (Pin 28)

This pin is the power switch drain connection.

## InnoSwitch5-Pro Functional Description

The InnoSwitch5-Pro combines a high-voltage power switch, along with both primary-side and secondary-side controllers in one device.
The architecture incorporates a novel inductive coupling feedback scheme (FluxLink) using the package lead frame and bond wires to provide a safe, reliable, and cost-effective means to transmit accurate, output voltage and current information from the secondary controller to the primary controller.
The InnoSwitch5-Pro secondary controller consists of a transmitter circuit that is magnetically coupled to the primary receiver, an $\mathrm{I}^{2} \mathrm{C}$ interface to control power supply parameters and telemetry functions, a 4.5 V regulator on the SECONDARY BYPASS pin, synchronous rectifier FET driver, oscillator and timing functions, and a host of integrated protection features.
The primary controller on InnoSwitch5-Pro is a Quasi-Resonant (QR) flyback controller that has the ability to operate in continuous conduction mode (CCM). The controller uses both variable frequency and variable current limit control schemes. The primary controller consists of a frequency jitter oscillator; a receiver circuit magnetically coupled to the secondary controller, a current limit controller, 5 V regulator on the PRIMARY BYPASS pin, bypass overvoltage detection circuit, a lossless input line sensing circuit, current limit selection circuitry, over-temperature protection and leading edge blanking.
Figure 3 and Figure 4 show the functional block diagrams of the primary and secondary controller with the most important features.

## Primary Controller

InnoSwitch5-Pro is a variable frequency controller allowing CCM/CrM/ DCM operation for enhanced efficiency and extended output power capability.

## PRIMARY BYPASS Pin Regulator

The PRIMARY BYPASS pin has an internal regulator that charges the PRIMARY BYPASS pin capacitor to $\mathrm{V}_{\text {BPP }}$ by drawing current from the DRAIN pin whenever the power switch is off. The PRIMARY BYPASS pin is the internal supply voltage node. When the power switch is on, the device operates from the energy stored in the PRIMARY BYPASS pin capacitor.

In addition, a shunt regulator clamps the PRIMARY BYPASS pin voltage to $\mathrm{V}_{\text {SHUNT }}$ when current is provided to the PRIMARY BYPASS pin through an external resistor. This allows the InnoSwitch5-Pro to be powered externally through a bias winding, decreasing the no-load consumption to less than 30 mW in a 5 V output design.

## Primary Bypass ILIM Programming

InnoSwitch5-Pro ICs allows the user to adjust current limit (ILIM) settings through the selection of the PRIMARY BYPASS pin capacitor value. A ceramic capacitor can be used.

There are 2 selectable capacitor sizes $-0.47 \mu \mathrm{~F}$ and $4.7 \mu \mathrm{~F}$ for setting standard and increased ILIM settings respectively.
Primary Bypass Undervoltage Threshold
The PRIMARY BYPASS pin undervoltage circuitry disables the power switch when the PRIMARY BYPASS pin voltage drops below $\sim 4.5 \mathrm{~V}$ $\left(\mathrm{V}_{\text {BPP }}-\mathrm{V}_{\mathrm{BP}(\mathrm{H})}\right)$ in steady-state operation. Once the PRIMARY BYPASS
pin voltage falls below this threshold, it must rise to $\mathrm{V}_{\text {SHunt }}$ to re-enable turn-on of the power switch.

## Primary BYPASS Pin Overvoltage Function

The PRIMARY BYPASS pin has an optional latching OV protection feature. A Zener diode in parallel with the resistor in series with the PRIMARY BYPASS pin capacitor is typically used to detect an overvoltage on the primary bias winding and activate the protection mechanism. In the event that the current into the PRIMARY BYPASS pin exceeds $I_{\text {so }}$ the device will latch-off or disable the power switch switching for a time $\mathrm{t}_{\text {AR(OFF), }}$, after which time the controller will restart and attempt to return to regulation.
VOUT OV protection is also included as an integrated feature on the secondary controller (see Output Voltage Protection).

## Over-Temperature Protection

The thermal shutdown circuitry senses the primary switch die temperature. The threshold is set to $\mathrm{T}_{\text {SD }}$ with either a hysteretic or latch-off response.
Hysteretic response: If the die temperature rises above the threshold, the power switch is disabled and remains disabled until the die temperature falls by $\mathrm{T}_{\mathrm{SD}(H)}$ at which point switching is re-enabled. A large amount of hysteresis is provided to prevent over-heating of the PCB due to a continuous fault condition.
Latch-off response: If the die temperature rises above the threshold the power switch is disabled. The latching condition is reset by bringing the PRIMARY BYPASS pin below $\mathrm{V}_{\text {BPP(RESET) }}$ or by going below the UNDER/OVER INPUT VOLTAGE pin UV ( $\mathrm{I}_{\text {uv. }}$ ) threshold.


Figure 6. Normalized Primary Current vs. Frequency.

## Current Limit Operation

The primary-side controller has a current limit threshold ramp that is inversely proportional to the time from the end of the previous primary switching cycle (i.e. from the time the primary switch turns off at the end of a switching cycle).
This characteristic produces a primary current limit that increases as the switching frequency (load) increases (Figure 6).

This algorithm enables the most efficient use of the primary switch with the benefit that this algorithm responds to digital feedback information immediately when a feedback switching cycle request is received.

At full load, switching cycles have a maximum current approaching $100 \% \mathrm{I}_{\text {LIIIT }}$. This gradually reduces to $30 \%$ of the full current limit as load decreases. Once $30 \%$ current limit is reached, there is no further reduction in current limit (since this is low enough to avoid audible noise). The time between switching cycles will continue to increase as load reduces.

## Jitter

The normalized current limit is modulated between $100 \%$ and $95 \%$ at a modulation frequency of $f_{m}$ this results in a frequency jitter of $\sim 7 \mathrm{kHz}$ with average frequency of $\sim 100 \mathrm{kHz}$.

## Auto-Restart

In the event a fault condition occurs (such as an output overload, output short-circuit, or external component/pin fault), the InnoSwitch5-Pro enters auto-restart (AR) or latches off. The latching condition is reset by bringing the PRIMARY BYPASS pin below $\mathrm{V}_{\text {BPP(RESET) }}$ or by going below the UNDER/OVER INPUT VOLTAGE pin UV ( $\mathrm{I}_{\mathrm{uv}}$ ) threshold.
In auto-restart, switching of the power switch is disabled for $\mathrm{t}_{\text {AR(OFF) }}$. There are 2 ways to enter auto-restart:

1. Continuous secondary requests at above the overload detection frequency $\mathrm{f}_{\text {ovL }}$ for longer than $82 \mathrm{~ms}\left(\mathrm{t}_{\mathrm{AR}}\right)$.
2. No requests for switching cycles from the secondary for $>\mathrm{t}_{\mathrm{AR}(\mathrm{SK})}$.

The second is included to ensure that if communication is lost, the primary tries to restart. Although this should never be the case in normal operation, it can be useful when system ESD events (for example) causes a loss of communication due to noise disturbing the secondary controller. The issue is resolved when the primary restarts after an auto-restart off-time.

The auto-restart is reset as soon as an AC reset occurs.

## SOA Protection

In the event that there are two consecutive cycles where $110 \% \mathrm{I}_{\text {Limit }}$ is reached within $\sim 500 \mathrm{~ns}$ (the blanking time + current limit delay time), the controller will skip 2.5 cycles or $\sim 25 \mu \mathrm{~s}$. This provides sufficient time for the transformer to reset with large capacitive loads without extending the start-up time.

## Input Line Voltage Monitoring

The UNDER/OVER INPUT VOLTAGE pin is used for input undervoltage and overvoltage sensing and protection.

A sense resistor is tied between the high-voltage DC bulk capacitor after the bridge (or to the AC side of the bridge rectifier for fast AC reset) and the UNDER/OVER INPUT VOLTAGE pin to enable this functionality. This function can be disabled by shorting the UNDER/ OVER INPUT VOLTAGE pin to primary GND.

At power-up, after the primary bypass capacitor is charged and the ILIM state is latched, and prior to switching, the state of the UNDER/ OVER INPUT VOLTAGE pin is checked to confirm that it is above the brown-in and below the overvoltage shutdown thresholds.
In normal operation, if the UNDER/OVER INPUT VOLTAGE pin current falls below the brown-out threshold and remains below brown-out for longer than $\mathrm{t}_{\mathrm{uv}-\mathrm{I}}$ the controller enters auto-restart. Switching will only resume once the UNDER/OVER INPUT VOLTAGE pin current is above the brown-in threshold.
In the event that the UNDER/OVER INPUT VOLTAGE pin current is above the overvoltage threshold, the controller will also enter auto-restart. Again, switching will only resume once the UNDER/ OVER INPUT VOLTAGE pin current has returned to within its normal operating range.
The input line UV/OV function makes use of a internal high-voltage MOSFET on the UNDER/OVER INPUT VOLTAGE pin to reduce power consumption. If the cycle off-time $\mathrm{t}_{\text {off }}$ is greater than $50 \mu \mathrm{~s}$, the internal high-voltage MOSFET will disconnect the external sense resistor from the internal IC to eliminate current drawn through the sense resistor. The line sensing function will activate again at the beginning of the next switching cycle.

## Primary-Secondary Handshake

At start-up, the primary-side initially switches without any feedback information (this is very similar to the operation of a standard TOPSwitch ${ }^{\text {TM }}$, TinySwitch ${ }^{\text {TM }}$ or LinkSwitch ${ }^{\text {TM }}$ controllers).
If no feedback signals are received during the auto-restart on-time $\left(t_{A R}\right)$, the primary goes into auto-restart mode. Under normal conditions, the secondary controller will power-up via the FORWARD pin or from the OUTPUT VOLTAGE pin and take over control. From this point onwards the secondary controls switching.
If the primary controller stops switching or does not respond to cycle requests from the secondary during normal operation (when the secondary has control), the handshake protocol is initiated to ensure that the secondary is ready to assume control once the primary begins to switch again. An additional handshake is also triggered if the secondary detects that the primary is providing more cycles than were requested.

The most likely event that could require an additional handshake is when the primary stops switching as the result of a momentary line brown-out event. When the primary resumes operation, it will default to a start-up condition and attempt to detect handshake pulses from the secondary.

If secondary does not detect that the primary responds to switching requests for 8 consecutive cycles, or if the secondary detects that the primary is switching without cycle requests for 4 or more consecutive cycles, the secondary controller will initiate a second handshake sequence. This provides additional protection against cross-conduction of the SR FET while the primary is switching. This protection mode also prevents an output overvoltage condition in the event that the primary is reset while the secondary is still in control.

## Wait and Listen

When the primary resumes switching after initial power-up recovery from an input line voltage fault (UV or OV) or an auto-restart event, it will assume control and require a successful handshake to relinquish control to the secondary controller.
As an additional safety measure the primary will pause for an auto-restart on-time period, $\mathrm{t}_{\mathrm{AR}}$ ( $\sim 82 \mathrm{~ms}$ ), before switching. During this "wait" time, the primary will "listen" for secondary requests. If it sees two consecutive secondary requests, separated by $\sim 30 \mu \mathrm{~s}$, the primary will infer secondary control and begin switching in slave mode. If no pulses occurs during the $\mathrm{t}_{\mathrm{AR}}$ "wait" period, the primary will begin switching under primary control until handshake pulses are received.

## Secondary Controller

As shown in the block diagram in Figure 4, the IC is powered by a $4.5 \mathrm{~V}\left(\mathrm{~V}_{\text {BPS }}\right)$ regulator which is supplied by either VOUT or FWD. The SECONDARY BYPASS pin is connected to an external decoupling capacitor and fed internally from the regulator block.

The FORWARD pin also connects to the negative edge detection block used for both handshaking and timing to turn on the SR FET connected to the SYNCHRONOUS RECTIFIER DRIVE pin. The FORWARD pin voltage is used to determine when to turn off the SR FET in discontinuous mode operation. This is when the voltage across the $\mathrm{R}_{\mathrm{DS}(0) \mathrm{N})}$ of the SR FET drops below zero volts.
In continuous conduction mode (CCM) the SR FET is turned off before the pulse request is sent to the primary to demand the next switching cycle, providing excellent synchronous operation, free of any overlap for the FET turn-off.

The output voltage is regulated on the VOUT pin and defaults to 5 V at start-up.
The external current sense resistor connected between ISENSE and SECONDARY GROUND pins is used to regulate the output current in constant current regulation mode.

## Programmable Voltage and Current

The operating voltage and current set points are set fully programmable through $\mathrm{I}^{2} \mathrm{C}$ interface. The output voltage is fully user programmable with a range from 3 V to 30 V . The fast response feedback loop of the IC features 10 mV ( $\triangle$ VOUT) voltage change resolution. The programmable current set point features $15 \%$ to $100 \%$ operating range, with a programming step size of $0.52 \%$ of full scale current. Below 5 V and for load current less than 50 mA , voltage command step size of 10 mV may result in non-montonicity since operating frequency is very low.

## Minimum Off-Time

The secondary controller initiates a cycle request using the FluxLink connection to the primary. The maximum frequency of secondarycycle requests is limited by a minimum cycle off-time of $\mathrm{t}_{\text {OFF(MIN). }}$. This is in order to ensure that there is sufficient reset time after primary conduction to deliver energy to the load.

## Maximum Switching Frequency

The maximum switch-request frequency of the secondary controller is $f_{\text {SREQ }}$.

## Internal uVCC Generation, Bus Switch Driver and Discharge

The internal LDO generates 3.6 V uVCC for MCU which simplifies the system design. InnoSwitch5-Pro also has an internal driver that guarantees turn-on of an $n$-channel FET series bus switch with source voltage as high as 30 V . The VB/D pin which enables the bus switch is also configurable as the discharge path for the load.

## Programmable Protections

User programmable protection features include output undervoltage (UV) and overvoltage (OV) protection and over-temperature protection.
The UV/OV thresholds are dynamically programmable. Users can program four responses to these protections, including auto-restart, latch-off, disable output, and no-response. An auto-restart (AR) or latch-off (LO) response does not inherently open the series bus switch. The $\mathrm{I}^{2} \mathrm{C}$ master must send a command to open it if this is the desired behavior.

The secondary controller also features generation of an interrupt signal if one or more of the faults is detected. The SCL pin is pulled down for $\sim 55 \mu$ s to generate an interrupt for MCU.
In the case when the MCU loses communication with the secondary controller, a watchdog timer triggers a reset to reassert a safe 5 V condition and opens the series bus switch.

## Telemetry Feature

The controller communicates to the MCU to report back the status of the power supply. Output voltage and current is measured by internal ADC and available to MCU through $\mathrm{I}^{2} \mathrm{C}$. The telemetry features also covers CV, CC and constant power set points, OV/UV thresholds, all protection settings, interrupt status, and complete fault status.

## Frequency Soft-Start

At start-up the primary controller is limited to a maximum switching frequency of $\mathrm{f}_{\mathrm{sw}}$ and $75 \%$ of the maximum programmed current limit at the switch-request frequency of 100 kHz .
After hand-shake is completed the secondary controller linearly ramps up the switching frequency from $f_{\text {sw }}$ to $f_{\text {SREQ }}$ over the $\sim 10 \mathrm{~ms}$ time period.

In the event of a short-circuit or overload at start-up, the device will move directly into CC (constant-current) mode. The device will go into auto-restart (AR), if the output voltage does not rise above the 3.6 V before the expiration of the soft-start timer after handshake has occurred.

If the output voltage reaches regulation within the soft-start time period, the frequency ramp is immediately aborted and the secondary controller is permitted to go full frequency. This will allow the controller to maintain regulation in the event of a sudden transient loading soon after regulation is achieved. The frequency ramp will only be aborted if quasi-resonant-detection programming has already occurred.

## Maximum Secondary Inhibit Period

Secondary requests to initiate primary switching are inhibited to maintain operation below maximum frequency and ensure minimum off-time. Besides these constraints, secondary-cycle requests are also inhibited during the "ON" time cycle of the primary switch (time between the cycle request and detection of FORWARD pin falling edge). The maximum time-out in the event that a FORWARD pin falling edge is not detected after a cycle requested is $\sim 30 \mu \mathrm{~s}$.

## SR Disable Protection

In each cycle SR is only engaged if a set cycle was requested by the secondary controller and the negative edge is detected on the FORWARD pin. In the event that the voltage on the ISENSE pin exceeds approximately 3 times the CC threshold, the SR FET drive is disabled until the surge current has diminished to nominal levels.
In SRZVS mode of operation, it is recommended to write 0x0E09 into the command register address $0 \times 38$ (with parity) to disable SR gate drive under any circumstances of primary switching without any cycle request from the secondary controller or cross conduction detection event. The detection is based on the signal on FORWARD pin and if the signal FORWARD pin has rings going below ground ( $<0 \mathrm{~V}$, during DCM mode of operation), this can result in SR gate drive being disabled in the subsequent switching cycles. It is recommended to improve the FORWARD pin signal to not have any DCV ringing going below ground during normal operation to avoid SR gate drive disable protection to trigger. In such designs, bit[2:0] of the command above can be incremented in steps of $1 \mathrm{~b}^{\prime} 1$ to avoid this protection feature to trigger under normal operation conditions.

When the SR gate drive is disabled due to this protection feature, Quasi-resonant switching also gets disable and both SR gate drive and Quasi-resonant switching get reinstated automatically once the fault condition is cleared. If this protection feature interferes with normal operation at certain conditions, and of not desirable, it can be disabled by writing $0 \times 0201$ into $0 \times 38$ (with parity) command register.
In non-SRZVS mode of opeation, it is recommended to write 0x0A09 into the command register address $0 \times 38$ (with parity) to enable this protection feature. To disable the protection feature write $0 \times 0201$ into the same command register.

## SR Static Pull-Down

To ensure that the SR gate is held low when the secondary is not in control, the SYNCHRONOUS RECTIFIER DRIVE pin has internal nominally "ON" device to pull the pin low and reduce any voltage on the SR gate due to capacitive coupling from the FORWARD pin.

## Open SR Protection

In order to protect against an open SYNCHRONOUS RECTIFIER DRIVE pin system fault the secondary controller has a protection mode to ensure the SYNCHRONOUS RECTIFIER DRIVE pin is connected to an external FET. If the external capacitance on the SYNCHRONOUS RECTIFIER DRIVE pin is below $\sim 200 \mathrm{pF}$, the device will assume the SYNCHRONOUS RECTIFIER DRIVE pin is "open" and there is no FET to drive. If the pin capacitance detected is above $\sim 200 \mathrm{pF}$, the controller will assume an SR FET is connected.
In the event the SYNCHRONOUS RECTIFIER DRIVE pin is detected to be open, the secondary controller will stop requesting pulses from the primary to initiate auto-restart.

If the SYNCHRONOUS RECTIFIER DRIVE pin is tied to ground at start-up, the SR drive function is disabled and the open SYNCHRONOUS RECTIFIER DRIVE pin protection mode is also disabled.

## Dynamically Programmable ZVS Operation in DCM mode using Synchronous Rectifier

In order to improve the conversion efficiency and eliminate switching losses, the InnoSwitch5-Pro IC features a means of achieving zero voltage switching of the primary switch by enabling the synchronous rectifier for short period before sending the switching request in DCM mode of operation. During this time magnetizing current is charged in negative direction at the rate determined by the reflected output voltage on the primary. At the end of SR conduction time, the magnetizing energy will start discharging the drain node capacitance on the primary switch to force the voltage across the primary power switch to zero before every conduction cycle. This mode of operation is available only in the Discontinuous Conduction Mode and the feature gets disabled automatically when there is a CCM switching request. Power converter can be enforced to operate in DCM only mode by sending $\mathrm{I}^{2} \mathrm{C}$ command. Enabling SR-ZVS mode benefits the SRFET as well by limiting the peak voltage across the SRFET when primary switch turns ON. See Figure 7.
Rather than detecting the magnetizing ring peak on the primary-side, the valley voltage of the FORWARD pin voltage as it falls below the output voltage is used to initiate the SR-ZVS operation. The details of $\mathrm{I}^{2} \mathrm{C}$ programming commands for this mode are provided in the command register section of the data sheet.
SRZVS mode of operation uses output energy to achieve the zero-voltage switching of the primary power switch. It is beneficial when used at high input line condition and higher load conditions with sufficient reflected output voltage to charge the magnetizing current in negative direction in short period.
In SR-ZVS mode, a TVS diode in the primary clamp circuit is required to limit the peak drain voltage of InnoSwitch5-Pro primary switch during abnormal transient events such as ESD and EFT.

## Intelligent Quasi-Resonant Mode Switching

In order to improve conversion efficiency and reduce switching losses, the InnoSwitch5-Pro IC features a means to force switching when the voltage across the primary switch is near its minimum voltage when the converter operates in discontinuous conduction mode (DCM). This mode of operation is automatically engaged in DCM and disabled once the converter moves to continuous conduction mode (CCM). See Figure 8.
Rather than detecting the magnetizing ring valley on the primaryside, the peak voltage of the FORWARD pin voltage as it rises above the output voltage level is used to gate secondary requests to initiate the switch "ON" cycle in the primary controller.

The secondary controller detects when the controller enters in discontinuous-mode and opens secondary cycle request windows corresponding to minimum switching voltage across the primary power switch.

Quasi-Resonant (QR) mode is enabled for $\sim 20 \mu \mathrm{sec}$ after DCM is detected. QR switching is disabled after $\sim 20 \mu \mathrm{sec}$, at which point switching may occur at any time a secondary request is initiated. The secondary controller includes blanking of $\sim 1 \mu \mathrm{sec}$ to prevent false detection of primary "ON" cycle when the FORWARD pin rings below ground.

## ZVS and QR Switching Window Optimization

The InnoSwitch5-Pro IC allows for optimization of switching to achieve QR / Valley switching as close to the peak / minimum FORWARD pin voltage respectively. Command register $0 \times 02=0 \times 1 F$ is recommended foroptimal switching.

Default value is $0 \times 01$.


Figure 7. Intelligent Zero Voltage Mode Switching.


Figure 8. Intelligent Quasi-Resonant Mode Switching.

## Register Definition

## $I^{2} \mathbf{C}$ Slave Address

The InnoSwitch5-Pro 7-bit slave address is $0 \times 18$ (7'b001 1000).


Figure 9. PI Slave Address.

## Write and Read Command $\mathbf{I}^{2} \mathbf{C}$ Protocol

[A] denotes a Slave Acknowledgement
[a] denotes a Master Acknowledgement
[na] denotes a Master nack
[W] denotes Write ( $\mathrm{l}^{\prime} \mathrm{b} 0$ )
[r] denotes Read (1'b1)
[PI_SLAVE_ADDRESS] $=0 \times 18$ ( 7 'b001 1000)
[PI_COMMAND] (see PI COMMAND Register Address Assignments, Description and Control Range Section)
[TELEMETRY_REGISTER_ADDRESS] (see Telemetry (Read-Back) Registers Address Assignment and Description Section)
Every $\mathrm{I}^{2} \mathrm{C}$ transaction should have a minimum of $150 \mu \mathrm{sec}$ delay between commands. If this delay is not provided commands may be ignored. The InnoSwitch5-Pro does not support clock stretching.

## $\mathbf{I}^{2} \mathbf{C}$ Protocol Format is 3-Byte Write Command

## Write commands:

[PI_SLAVE_ADDRESS][W][A][PI_COMMAND][A][Byte][A] or
[PI_SLAVE_ADDRESS][W][A][PI_COMMAND][A][Low Byte][A][High Byte][A]


Figure 10. Example Register Write Command Sequence (CV set to 8 V ).

## $\mathbf{I}^{2} \mathbf{C}$ Protocol Format is 2-Byte Read Command

Word Read transaction:
[PI_SLAVE_ADDRESS][W][A][PI_COMMAND][A][START_TELEMETRY_REGISTER_ADDRESS]
[A][END_TELEMETRY_REGISTER_ADDRESS [A]
[PI_SLAVE_ADDRESS] [r][A]\{PI Slave responds Low Byte\}[a]\{PI Slave responds High Byte\}[na]


Figure 11. Example Read Register Sequence (Read Fault Register READ11). Note: START and END TELEMETRY Register Addresses Does Not Have to Point to Same Register to Read multiple Registers in Single Command.

## PI COMMAND Register Address Assignments, Description and Control Range

All command register addresses in InnoSwitch5-Pro are odd-parity addressing. Some select registers (some highlighted below) also employ odd parity error bit to the high and low bytes of data.

| Name | Function | Adjustment Range | Register Address |  | Type | Default | Description |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Address | Address with Odd Parity |  |  |  |  |  |
| VBEN | Series Bus Switch Control | Enable or Disabled? | 0x04 |  | W_Byte | 0x0 | bit[7] | Parity |  |
|  |  |  |  |  | bit[1:0] |  | \{11\} Enable VBEN/Disable VDIS <br> \{01\} Disable VBEN/No Reset <br> \{00\} Disable VBEN/Reset |  |
| BLEEDER ${ }^{\text {B }}$ | Activate Bleeder ( $\mathrm{V}_{\text {out }}$ ) Function | Enable or Disabled? | 0x06 | 0x86 |  | W_Byte | 0xD0 | bit[2] | \{0\}: Auto disable when VOUT<10PCT <br> \{1\}: Auto disable when VOUT<4PCT |  |
|  |  |  |  |  | bit[1:0] |  |  | \{00\}: Disabled <br> \{11\}: Enabled w <br> OTP clears this r | th auto disable egister |
|  |  |  |  |  |  |  | bit[7] | Parity |  |
| VDIS | Load (VBUS) Discharge | Enable or Disabled? |  |  | W_Byte | 0x0 | bit[3:0] | \{0011\} Enable D Disable \{0010\} Enable D Disable \{1110\} Disable | Discharge/ BEN/Reset ischarge/ BEN No Reset Discharge |
| Turn-Off PSU | Latch-Off Device | Enable or Disabled? | 0x0A | 0x8A | W_Byte | 0x0 | bit[0] | \{0\}: Disabled <br> \{1\}: Enabled |  |
| Fast VI Command | Speed of CV/CC Update | 10 ms Update Limit or No Speed Limit? | 0x0C | 0x8C | W_Byte | 0x0 | bit[0] | \{1\}: Disable 10 limit | msec update |
|  |  |  |  |  |  |  | bit[4:3] | \{11\}: 64 ms <br> \{10\}: 32 ms <br> \{01\}: 16 ms <br> \{00\}: 8 ms |  |
| CVO | ConstantVoltage Only | Only CV Mode |  |  | W_Byte | 0x04 | bit[2:1] | \{11\}: Disable-Ou <br> \{10\}: Auto-Resta <br> \{01\}: Latch-Off <br> \{00\}: No Respon | thut $^{A}$ <br> rt <br> se |
|  |  |  |  |  |  |  | bit[0] | \{1\}: CV Only Mo Regulation | de/No CC |
|  |  |  |  |  |  |  | bit[15] | High Byte Parity |  |
| CV | Output Voltage | 3 V to 30 V |  |  | W Word | 500 | bit[12:8] | Output Voltage | Range |
|  | Output Voltage | (10 mV/step) |  |  | W_Word | ( 5 V ) | bit[7] | Low Byte Parity | $10 \mathrm{mV} / \mathrm{LSB}$ |
|  |  |  |  |  |  |  | bit[6:0] | Output Voltage |  |

Table 2. Command Register Assignments.

| Name | Function | Adjustment Range | Register Address |  | Type | Default | Description |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Address | Address with Odd Parity |  |  |  |  |  |
| OVA | Overvoltage Programming | 3.3 V to 40 V <br> ( $100 \mathrm{mV} / \mathrm{step}$ ) | 0x12 | 0x92 | W_Word | AutoRestart 96 (9.6 V) | bit[15] | High Byte Parity | Range \{33 to 400\} $100 \mathrm{mV} / \mathrm{LSB}$ |
|  |  |  |  |  |  |  | bit[11:10] | $\begin{array}{\|c\|} \hline\{1\}: \text { Disable- } \\ \text { Output } \\ \{10\}: \text { Auto- } \\ \text { Restart } \\ \text { \{01\}: Latch-Off } \\ \text { \{00\}: } \begin{array}{c} \text { No } \\ \text { Response } \end{array} \\ \hline \end{array}$ |  |
|  |  |  |  |  |  |  | bit[9:8] | Threshold |  |
|  |  |  |  |  |  |  | bit[7] | Low Byte Parity |  |
|  |  |  |  |  |  |  | bit[6:0] | Threshold |  |
| UVA | Undervoltage Threshold | 2.7 V to 40 V <br> ( $100 \mathrm{mV} / \mathrm{step}$ ) | $0 \times 14$ | 0x94 | W_Word | 64 ms AutoRestart 36 (3.6 V) | bit[15] | High Byte Parity | $\begin{gathered} \text { Range } \\ \{27 \text { to } 400\} \\ 100 \mathrm{mV} / \mathrm{LSB} \end{gathered}$ |
|  |  |  |  |  |  |  | bit[14] | 0: Enable UVL timer <br> 1: Disable UVL timer |  |
|  |  |  |  |  |  |  | bit[13:12] | \{11\}: 64ms <br> \{10\}: 32 ms <br> \{01\}: 16 ms <br> \{00\}: 8ms |  |
|  |  |  |  |  |  |  | bit[11:10] |  |  |
|  |  |  |  |  |  |  | bit[9:8] | Threshold |  |
|  |  |  |  |  |  |  | bit[7] | Low Byte Parity |  |
|  |  |  |  |  |  |  | bit[6:0] | Threshold |  |
| CDC | Cable Drop Compensation | 0 mV to 600 mV ( $50 \mathrm{mV} / \mathrm{step}$ ) | 0x16 |  | W_Word | $\begin{gathered} 0 \\ (0 \mathrm{~V}) \end{gathered}$ | bit[3:0] | $\begin{aligned} & \text { Range }\{0 \text { to } 12\} \\ & 50 \mathrm{mV} / \mathrm{LSB} \end{aligned}$ |  |
| CC | Constant Current Regulation | $15 \%$ to $100 \%$ of CC, ( $0.17 \mathrm{mV} /$ step/Rs) | 0x18 | 0x98 | W_Word | $\begin{gathered} 192 \\ (100 \%) \end{gathered}$ | bit[15] | High Byte Parity | $\begin{gathered} \text { Range } \\ \{29(15 \%) \\ \text { to } 192 \\ (100 \%)\} \end{gathered}$ |
|  |  |  |  |  |  |  | bit[8] |  |  |
|  |  |  |  |  |  |  | bit[7] | Low Byte Parity |  |
|  |  |  |  |  |  |  | bit[6:0] |  |  |
| $\mathrm{V}_{\mathrm{KP}}$ | Constant Output Power Knee Voltage | $\begin{gathered} 5.3 \mathrm{~V} \text { to } 30 \mathrm{~V} \\ (100 \mathrm{mV} / \text { step }) \end{gathered}$ | $0 \times 1 \mathrm{~A}$ |  | W_Word | $\begin{gathered} 300 \\ (30 \mathrm{~V}) \end{gathered}$ | bit[15] | High Byte Parity | $\begin{gathered} \text { Range } \\ \{53 \text { to } 300\} \\ 100 \mathrm{mV} / \mathrm{LSB} \end{gathered}$ |
|  |  |  |  |  | bit[8] |  |  |  |
|  |  |  |  |  | bit[7] |  | Low Byte Parity |  |
|  |  |  |  |  | bit[6:0] |  |  |  |
| LS | Line Sense | Enable | $0 \times 1 \mathrm{C}$ |  |  | W_Byte | 0x00 | bit[0] | \{1\}: Line sense trigger, auto reset to 0 |  |
| CCSC | Output Short-Circuit Fault Detection | AR, Latch-off or No Response | 0x20 |  |  | W_Byte | $0 \times 02$ | bit[1:0] | \{10\}: Auto-Restart <br> \{01\}: Latch-Off <br> \{00\}: No Response |  |

Table 3. Command Register Assignments (cont.)
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| Name | Function | Adjustment Range | Register Address |  | Type | Default | Description |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Address | Address with Odd Parity |  |  |  |  |
| ISSC | IS pin Short Fault Response and Detection Frequency/ Threshold | Disable Output, AR, Latch-off or No Response | 0x22 | 0xA2 | W_Byte | $0 \times 32$ | bit[1:0] | $\{11\}$ : Disable-Output ${ }^{A}$ <br> \{10\}: Auto-Restart <br> \{01\}: Latch-Off <br> \{00\}: No Response |
|  |  | Frequency? (30kHz/60kHz/ $90 \mathrm{kHz} / 120 \mathrm{kHz})$ |  |  |  |  | bit[3:2] | Frequency Detection Threshold $\text { \{00\}: } 60 \mathrm{kHz}$ <br> \{01\}: 30 kHz <br> \{10\}: 90 kHz <br> \{11\}: 120 kHz |
|  |  | Threshold for Current Limit |  |  |  |  | bit[6:4] | $\begin{aligned} & \hline\{001\}: d^{\prime} 16 \\ & \{010\}: d^{\prime} 32 \\ & \{011\}: d^{\prime} 48 \\ & \{100\}: d^{\prime} 64 \\ & \{101\}: d^{\prime} 80 \\ & \{110\}: d^{\prime} 96 \\ & \{111\}: d^{\prime} 112 \\ & \hline \end{aligned}$ |
| Watchdog Time | Communication Rate Monitor | $\begin{gathered} \text { Disable/0.5 } \\ \mathrm{s} / 1 \mathrm{~s} / 2 \mathrm{~s} \end{gathered}$ | 0x26 |  | W_Byte | $\begin{gathered} 0 \times 01 \\ (0.5 \mathrm{sec}) \end{gathered}$ | bit[1:0] | $\begin{aligned} & \{00\}: \text { No Watch-Dog } \\ & \{01\}: 0.5 \mathrm{sec} \\ & \{10\}: 1 \mathrm{sec} \\ & \{11\}: 2 \mathrm{sec} \end{aligned}$ |
| Interrupt | Interrupt Mask | Writing a non-zero value enables interrupt |  |  |  |  | bit[8] | Operating Mode Flag (OMF) |
|  |  |  |  |  |  |  | bit[7] | Series Bus Switch Short |
|  |  |  |  |  |  |  | bit[6] | Control Secondary |
|  |  |  |  |  |  |  | bit[5] | BPS Current Latch-off |
|  |  | Interrupt is |  |  | WR_Byte | 0x00 | bit[4] | CVO Mode Peak load timer |
|  |  | automatically |  |  |  |  | bit[3] | IS pin Short |
|  |  | one interrupt |  |  |  |  | bit[2] | Output Short-Circuit |
|  |  | pulse sent out |  |  |  |  | bit[1] | Vout(UV) |
|  |  |  |  |  |  |  | bit[0] | Vout(OV) |
|  |  | Threshold for Current Sense |  |  |  |  | bit[5:4] | $\begin{aligned} & \{11\}: d^{\prime} 72 \\ & \{10\}: d^{\prime} 64 \\ & \{01\}: d^{\prime} 32 \\ & \{00\}: d^{\prime} 48 \end{aligned}$ |
| VBUSSC | Series BUS Switch Short-Circuit Fault | Number of Current Sense Samples | 0x36 | 0xB6 | W_Byte | 0x02 | bit[3:2] | \{11\}: 4 samples \{10\}: 3 samples \{01\}: 2 samples \{00\}: 1 sample |
|  |  | AR, Latch-off or No Response |  |  |  |  | bit[1:0] | \{10\}: Auto-Restart <br> \{01\}: Latch-Off <br> \{00\}: No Response |
| DCM-only | Discontinuous Conduction Mode Only | Enable or Disabled? | $0 \times 3 \mathrm{~A}$ | $0 \times B A$ | W_Byte | 0x00 | bit[2] | \{0\}: Disable <br> \{1\}: Enable |

Table 4. Command Register Assignments (cont).

InnoSwitch5-Pro

| Name | Function | Adjustment Range | Register Address |  | Type | Default | Description |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Address | Address with Odd Parity |  |  |  |
| SRZvS | SR based ZVS Mode | Enable or Disabled? | 0x3E |  | w_Byte | bit[11] | \{1\}: Enable FWD Valley Switching <br> \{0\}: Disable FWD Valley Switching |
|  |  |  |  |  | bit[10] | \{1\}: Enable SRZVS mode <br> \{0\}: Disabled SRZVS mode |  |
|  |  |  |  |  | bit[7:5] | SR-ZVS Delay Count ${ }^{\text {c }}$ |  |
|  |  |  |  |  | bit[4:0] | SR-ZVS ON Count ${ }^{\text {c }}$ |  |

Table 5. Command Registers Assignments (cont).

## Notes:

A. Disable Output Fault Response Disables VBEN with Reset at fault. Reset may trigger AR depending on the operating conditions.
B. Disable the weak bleeder by writing $0 x 0 x$ into $0 x 86$ at power-on to reduce no-load power.
C. The minimum values for SR-ZVS ON count and Delay count should be $>=d^{\prime} 3$ to observe the change of $\sim 85$ ns with each step.

## Telemetry (Read-Back) Registers Address Assignment and Description

\begin{tabular}{|c|c|c|c|c|c|c|c|}
\hline \& Name \& Register Name \& Register Address \& Type \& \multicolumn{3}{|c|}{Register Bit Assignments} <br>
\hline \& \multirow{4}{*}{READ1} \& \multirow{4}{*}{Output Voltage Set-Point} \& \multirow{4}{*}{$0 \times 02$} \& \multirow{4}{*}{R_Word} \& bit[15] \& High Byte Parity \& \multirow{4}{*}{\{Reg_CV \}} <br>
\hline \& \& \& \& \& bit[12:8] \& \& <br>
\hline \& \& \& \& \& bit[7] \& Low Byte Parity \& <br>
\hline \& \& \& \& \& bit[6:0] \& \& <br>
\hline \& \multirow{8}{*}{READ2

READ3} \& \multirow{4}{*}{Output Current Set-Point} \& \multirow{4}{*}{$0 \times 04$} \& \multirow{4}{*}{R_Word} \& bit[15] \& High Byte Parity \& \multirow{4}{*}{\{Reg_CC \}} <br>
\hline \& \& \& \& \& bit[8] \& \& <br>
\hline \& \& \& \& \& bit[7] \& Low Byte Parity \& <br>
\hline \& \& \& \& \& bit[6:0] \& \& <br>

\hline \multirow{24}{*}{} \& \& \multirow{4}{*}{Overvoltage Threshold} \& \multirow{4}{*}{$0 \times 06$} \& \multirow{4}{*}{R_Word} \& bit[15] \& High Byte Parity \& \multirow{4}{*}{| \{Reg_OVA\} |
| :--- |
| (10 mV/LSB) |} <br>

\hline \& \& \& \& \& bit[12:8] \& \& <br>
\hline \& \& \& \& \& bit[7] \& Low Byte Parity \& <br>
\hline \& \& \& \& \& bit[6:0] \& \& <br>

\hline \& \multirow{4}{*}{READ4} \& \multirow{4}{*}{Undervoltage Threshold} \& \multirow{4}{*}{$0 \times 08$} \& \multirow{4}{*}{R_Word} \& bit[15] \& High Byte Parity \& \multirow{4}{*}{| \{Reg_UVA\} |
| :--- |
| (10 mV/LSB) |} <br>

\hline \& \& \& \& \& bit[12:8] \& \& <br>
\hline \& \& \& \& \& bit[7] \& Low Byte Parity \& <br>
\hline \& \& \& \& \& bit[6:0] \& \& <br>
\hline \& READ5 \& Constant Power Threshold \& $0 \times 0 \mathrm{~A}$ \& R_Word \& bit[8:0] \& \{Reg_VKP\} \& <br>
\hline \& \multirow{8}{*}{READ6} \& Overvoltage Fault \& \multirow{8}{*}{0x0C} \& \multirow{8}{*}{R_Word} \& bit[15:14] \& \{Reg_OVA_Response\} \& <br>
\hline \& \& Undervoltage Fault \& \& \& bit[13:12] \& \{Reg_UVA_Response\} \& <br>
\hline \& \& Output Short-Circuit \& \& \& bit[11:10] \& \{Reg_CCSC_Response\} \& <br>
\hline \& \& IS pin Short \& \& \& bit[9:8] \& \{Reg_ISSC_Response\} \& <br>
\hline \& \& Undervoltage Time Out \& \& \& bit[7:6] \& \{Reg_UVA_TIMER\} \& <br>
\hline \& \& Watchdog Time Out \& \& \& bit[5:4] \& \{Reg_WD_TIMER\} \& <br>
\hline \& \& CV Mode \& \& \& bit[3:2] \& \{Reg_CVO_Response\} \& <br>
\hline \& \& CV Mode Timer \& \& \& bit[1:0] \& \{Reg_CVO_TIMER\} \& <br>
\hline \& \multirow{7}{*}{READ7} \& VBUS Switch Enable \& \multirow{7}{*}{0x0E} \& \multirow{7}{*}{R_Word} \& bit[14] \& \{Reg_VBEN\} \& <br>
\hline \& \& Minimum Load \& \& \& bit[13] \& \{Reg_BLEEDER\} \& <br>
\hline \& \& Turn PSU Off \& \& \& bit[12] \& \{Reg_PSUOFF\} \& <br>
\hline \& \& Fast VI Commands \& \& \& bit[11] \& \{Reg_FSTVIC\} \& <br>
\hline \& \& Constant-Voltage Mode Only \& \& \& bit[10] \& \{Reg_CVO\} \& <br>
\hline \& \& Over-Temperature Fault Hysteresis \& \& \& bit[9] \& \{Reg_OTP_HYS \& <br>
\hline \& \& Cable Drop Compensation \& \& \& bit[3:0] \& \{Reg_CDC\} \& <br>

\hline \multirow{10}{*}{} \& \multirow{4}{*}{READ8} \& \multirow{4}{*}{Measured Output Current} \& \multirow{4}{*}{$0 \times 10$} \& \multirow{4}{*}{R_Word} \& bit[15] \& High Byte Parity \& \multirow{4}{*}{$$
\begin{aligned}
& \text { \{Reg_} \\
& \text { MEASURED_I\} }
\end{aligned}
$$} <br>

\hline \& \& \& \& \& bit[8] \& \& <br>
\hline \& \& \& \& \& bit[7] \& Low Byte Parity \& <br>
\hline \& \& \& \& \& bit[6:0] \& \& <br>
\hline \& \multirow{6}{*}{READ9} \& \multirow{6}{*}{Measured Output Voltage} \& \multirow{6}{*}{$0 \times 12$} \& \multirow{6}{*}{R_Word} \& $\operatorname{bit}[15: 12$ ] \& \multicolumn{2}{|l|}{4'b0} <br>
\hline \& \& \& \& \& \& Vout Range \& Report-back resolution <br>
\hline \& \& \& \& \& \& 3-4V \& 20 mV <br>
\hline \& \& \& \& \& \& 4-8V \& 40 mV <br>
\hline \& \& \& \& \& \& 8-16 V \& 80 mV <br>
\hline \& \& \& \& \& \& 16-32 V \& 160 mV <br>
\hline
\end{tabular}

Table 6. Telemetry (Read-Back) Register Assignments.

| Name | Description | Register Address | Type |  | Register Name |
| :---: | :---: | :---: | :---: | :---: | :---: |
| READ10 <br> (Instantaneous) | Interrupt Enable | $0 \times 14$ | R_Word | bit[15] | \{Reg_INTERRUPT_EN\} |
|  | System Ready Signal |  |  | bit[14] | \{Reg_CONTROL_S\} |
|  | Output Discharge |  |  | bit[13] | \{Reg_VDIS\} |
|  | Line Sense Reporting Ready? |  |  | bit[12] | \{Reg_Line_Sense\} |
|  | Allow to Enter CV command |  |  | bit[10] | \{Reg_CV_EN\} |
|  | Over-Temperature Protection Fault? |  |  | bit[9] | \{Reg_OTP\} |
|  | VOUTADC > 1.04*Vout |  |  | bit[5] | \{Reg_VOUT4PCT\} |
|  | VOUTADC > 1.1*Vout |  |  | bit[4] | \{Reg_VOUT10PCT\} |
|  | IS pin Short-Circuit Detected |  |  | bit[3] | \{Reg_ISSC\} |
|  | Output Short-Circuit Detected |  |  | bit[2] | \{Reg_CCSC\} |
|  | Output Voltage UV Fault Comparator |  |  | bit[1] | \{Reg_VOUT_UV\} |
|  | Output Voltage OV Fault Comparator |  |  | bit[0] | \{Reg_VOUT_OV |
| READ11 | Operating Mode Flag (OMF) | $0 \times 16$ | R_Word | bit[2] | CC Mode |
|  |  |  |  | bit[1] | CP Mode |
|  |  |  |  | bit[0] | CV Mode |
| READ12 | Average Output Current | $0 \times 18$ | R_Word | bit[15:8] | 8b'0 |
|  |  |  |  | bit[7:0] | 16 sample average of READ 8 |
| READ13 | Average Output Voltage | 0x1A | R_Word | bit[15:12] | 4 b 0 |
|  |  |  |  | bit[11:0] | 16 sample average of READ 9 |
| READ14 | Voltage DAC | 0x1C | R_Word | bit[15:8] | DAC_100mV |
|  |  |  |  | bit[7:0] | DAC_10mV |
| READ15 | CVO Mode DO | $0 \times 1 \mathrm{E}$ | R_Word | bit[6] | \{Reg_DO_CVO\} |
|  | IS pin Short-Circuit DO |  |  | bit[4] | \{Reg_DO_ISSC\} |
|  | Output Voltage OV DO |  |  | bit[2] | \{Reg_DO_VOUT_OV\} |
|  | Output Voltage UV DO |  |  | bit[1] | \{Reg_DO_VOUT_UV\} |
|  | Watchdog triggered |  |  | bit[0] | \{Reg_Watchdog\} |
| READ16 | CVO Mode AR | 0x20 |  | bit[14] | \{Reg_ar_CVO\} |
|  | Bus switch Short-Circuit AR |  |  | bit[13] | \{Reg_ar_VBUSSC\} |
|  | IS pin Short-Circuit AR |  |  | bit[12] | \{Reg_ar_ISSC\} |
|  | Output Short-Circuit AR |  |  | bit[11] | \{Reg_ar_CCSC\} |
|  | Output Voltage OV AR |  |  | bit[10] | \{Reg_ar_VOUT_OV\} |
|  | Output Voltage UV AR |  |  | bit[9] | \{Reg_ar_VOUT_UV\} |
|  | PSU turn OFF command received |  |  | bit[7] | \{Reg_Lo_CMD\} |
|  | CVO Mode LO |  |  | bit[6] | \{Reg_Lo_CVO\} |
|  | Bus switch Short-Circuit LO |  |  | bit[5] | \{Reg_Lo_VBUSSC\} |
|  | IS-pin Short-Circuit LO |  |  | bit[4] | \{Reg_Lo_ISSC\} |
|  | Output Short-Circuit LO |  |  | bit[3] | \{Reg_Lo_CCSC\} |
|  | Output Voltage OV LO |  |  | bit[2] | \{Reg_Lo_VOUT_OV\} |
|  | Output Voltage UV LO |  |  | bit[1] | \{Reg_Lo_VOUT_UV\} |
|  | BPS pin LO |  |  | bit[0] | \{Reg_BPS_OV \} |

Table 7. Telemetry (Read-Back) Register Assignments (cont.)

InnoSwitch5-Pro

| Name | Description | Register Address | Type |  | Register Name |
| :---: | :---: | :---: | :---: | :---: | :---: |
| READ17 | Interrupts | 0x22 | R_Word | Status |  |
|  |  |  |  | Mask bit[8] | \{Reg_OMF\} |
|  |  |  |  | bit[7] | \{Reg_VBUSSC\} |
|  |  |  |  | bit[15] $\quad$ bit[6] | \{Reg_~CONTROL_S\} |
|  |  |  |  | bit[14] bit[5] | \{Reg_LO_Fault\} |
|  |  |  |  | bit[13] bit[4] | \{Reg_CVO_AR\} |
|  |  |  |  | bit[12] bit[3] | \{Reg_ISSC\} |
|  |  |  |  | bit[11] $\quad$ bit[2] | \{Reg_CCSC\} |
|  |  |  |  | bit[10] bit[1] | \{Reg_VOUT_UV\} |
|  |  |  |  | bit[9] bit[0] | \{Reg_VOUT_OV\} |
| READ21 | Line Sense TON report | $0 \times 2 \mathrm{~A}$ | R_Word | bit[15:12] | 4 b 0 |
|  |  |  |  | bit[11:0] | 16 sample accumulated value of $\sim$ primary switch ON time |
| READ22 | Line Sense TOFF report | 0x2C | R_Word | bit[15:0] | 16 sample accumulated value of $\sim$ SR switch ON time |
| READ23 | End of Line Calibration | 0x2E | R_Word | bit[3] | $\{0\}$ : Positive offset <br> \{1\}: Negative offset |
|  |  |  |  | bit[2:0] | Constant Current regulation offset |

Table 8. Telemetry (Read-Back) Register Assignments (cont.)

## Command Registers

## System Ready Status Register

The system ready bit \{Reg_control_s\} must be read prior to the start of any $\mathrm{I}^{2} \mathrm{C}$ transactions and after the InnoSwitch5-Pro has entered into a reset state resulting from auto-restart (AR), latch-off (LO), Disable Output (DO) or initial power-up.
When the \{Reg_control_s\} bit is set to " 1 ", it means InnoSwitch5-Pro is ready to receive $I^{2} \mathrm{C}$ commands.
To read the \{Reg_control_s\} bit, write the READ10 sub address 0x14 into the $0 \times 80$ address. Then read High Byte data back from address $0 \times 80$. The bit 14 is $\{$ Reg_control_s $\}$.

Constant current regulation is based on the average current measurement register (READ12).
For a 5 A CC threshold, the current sense resistor is $6.4 \mathrm{~m} \Omega$. The current limit step size for this example is $\sim 26 \mathrm{~mA} /$ step.
Example: For a power supply with maximum CC of $5 \mathrm{~A}\left(R_{S}=6.4 \mathrm{~m} \Omega\right)$, the following demonstrates changing the CC set point from 5A to 2.5 A . This corresponds to change in CC from 100\% (0xC0) to 50\% (0x60) with odd parity this becomes 0x80E0:

| PI_SLAVE_ADDRESS [W]: | $0 \times 30\left(8^{\prime}\right.$ b0011 0000 $)$ |
| :--- | :--- |
| PI_Command: | CC Register $(0 \times 98)$ |
| Low Byte: | $0 \times E 0\left(8^{\prime}\right.$ b0100 0000 $)$ |
| High Byte: | $0 \times 80\left(8^{\prime} b 10000000\right)$ |



Figure 12. $\{$ Reg_Control_s\} Telemetry Register (READ 10).
Example: Reading the \{Reg_control_s\} bit:
PI_SLAVE_ADDRESS [W]: $0 \times 30$ ( 8 'b0011 0000)
Read Register: 0×80
PI_Command: $\quad$ READ10 (0x14), READ10 (0x14) PI_SLAVE_
ADDRESS [r]: 0x31 (8'b0011 0001)

## Programming Output Voltage (CV), Output Constant Current <br> (CC), Constant Power Mode (CP), Cable Drop Compensation <br> (CDC) and Constant Voltage Only Mode (CVO)

## CV Register ( $0 \times 10$ )

The output voltage of the power supply is regulated on the VOUT pin. The valid programming range is from 3 V to 30 V with $10 \mathrm{mV} / \mathrm{Isb}$.
The default CV register value is 5 V . Below 5 V and at light load below 50 mA , output monotonicity may not be visible with $10 \mathrm{mV} /$ steps.
Example: to change CV from 5 V to 8 V
Convert 8 V to Isb representation: $8 /(10 \mathrm{mV} / / \mathrm{sb})=800$ Convert to hex format ( $800=0 \times 0320$ )
With odd parity bits added the hex data is $0 \times 8620$ )
The bit $I^{2} C$ command for this is shown below:
$\begin{array}{ll}\text { PI_SLAVE_ADDRESS [W]: } & 0 \times 30\left(8^{\prime} \mathrm{b} 00110000\right) \\ \text { PI_Command: } & \text { CV Register (0x10) } \\ \text { Low Byte: } & 0 \times 20\left(8^{\prime} \mathrm{b} 00100000\right) \\ \text { High Byte: } & 0 \times 86\left(8^{\prime} \mathrm{b} 10000110\right)\end{array}$
This sequence of commands is shown in Figure 10 and Figure 24.

## CC Register (0x98)

The constant current regulation register address is $0 \times 18$ and with odd parity it is $0 \times 98$. The constant current regulation threshold is adjustable from $15 \%$ (d'29) CC up to $100 \%$ (d'192) of the full scale.
The full-scale constant-current threshold is set with the sense resistor between the IS and GND pins. The typical value for the full-scale current voltage drop is $32 \mathrm{mV}\left(\mathrm{I}_{\text {sV(TH) }}\right)$. The resolution step size is ( $0.52 \% /$ step):
$32 \mathrm{mV} / 192=0.167 \mathrm{mV} /$ step $/$ Rs

## Constant Output Power Voltage Threshold VKP (0x1A)

A constant output power characteristic is programmed via the "knee power voltage" in conjunction with the $100 \%$ constant current regulation threshold (full-scale current setting). If the full-scale CC is 2.5 A and the knee power voltage is set to 8 V , the constant power is 20 W . If the VKP register were set to 12 V , the resultant constant power characteristic above the VKP threshold would be 30 W .


Figure 13. Constant Output Power Profile.

From no-load to heavy loading conditions, InnoSwitch5-Pro will operate in CV then transition into CP then into CC region below the VKP threshold. Setting VKP to maximum value ( 30 V ) results in no Constant Output Power regulation region.
Example: To change VKP from $30 V\left(d^{\prime} 300\right)(0 x F 0=0 \times 0170$ with odd parity) to 8 V ( $0 \times 50=0 \times 80 \mathrm{D} 0$ ):
PI_SLAVE_ADDRESS [W]: $0 \times 30$ ( 8 'b0011 0000)
PI_Command:
VKP Register ( $0 \times 1 \mathrm{~A}$ )
Low Byte: $\quad$ 0xD0 ( $8^{\prime} \mathrm{b} 11010000$ )
High Byte:
0x80 ( 8 'b1000 0000)

Reducing the constant current regulation threshold does not modify the maximum programmed output power with a given VKP setting. From the example shown above, setting CC regulation to 2 A (full-scale CC is still 2.5 A ), with VKP $=8 \mathrm{~V}$, would result in output profile shown below with CP characteristic intercept of 10 V for the same 20 W constant power characteristic.


Figure 14. Constant Output Power Profile with Reduced CC Regulation Threshold.


Figure 15. CDC as Function of Load Current.

## Cable Drop Compensation (CDC) ( $0 \times 16$ )

The amount of cable drop compensation has a controllable range of 0 V to 600 mV in $50 \mathrm{mV} / \mathrm{steps}$. CDC is applied as a function of the current through the sense resistor (resistor between IS and GND pins) used to program the constant current regulation threshold. At no-load there is no CDC and the compensation is increased linearly as load increases and reaches the maximum programmed value at the onset of the $100 \%$ constant-current regulation threshold (fullscale voltage across the current sense resistor).
The table below shows the register values to program the desired CDC:

| CDC (mV) | Hex Value | Binary |
| :---: | :---: | :---: |
| 0 | 0x00 | 4'b0000 |
| 100 | 0x02 | 4'b0010 |
| 150 | 0x03 | 4'b0011 |
| 200 | $0 \times 04$ | 4'b0100 |
| 250 | 0x05 | 4'b0101 |
| 300 | $0 \times 06$ | 4'b0110 |
| 350 | 0x07 | 4'b0111 |
| 400 | 0x08 | 4'b1000 |
| 450 | 0x09 | 4'b1001 |
| 500 | $0 \times 0 \mathrm{~A}$ | 4'b1010 |
| 550 | $0 \times 0 \mathrm{~B}$ | 4'b1011 |
| 600 | $0 \times 0 \mathrm{C}$ | 4'b1100 |

Table 9. Cable Drop Compensation.
If the current sense resistor between IS pin to GND pin is shorted, there will be neither any cable drop compensation nor any constant current regulation.
Example: To change CDC from 0 V to 300 mV ( $0 \times 06$ ):
PI_SLAVE_ADDRESS [W]: $0 \times 30(8$ 'b1011 0000) PI_Command: CDC Register ( $0 \times 16$ ) Byte: $\quad 0 x 06$ (4'b0110)

## Constant Voltage Only Mode (0x0E)

The InnoSwitch5-Pro can be programmed to operate with constantvoltage only and have no constant current regulation mode. The set output current register ( $0 \times 98$ ) sets the overload threshold instead of regulating the constant current when the CVO mode is enabled. Once the load current exceeds the programmed current a peak load timer $\left(\mathrm{t}_{\mathrm{pLT}}\right)$ is started. The options for the peak load timer (CVO timer bit [4:3] of Register $0 \times 0 \mathrm{E}$ ) are $8 \mathrm{~ms}, 16 \mathrm{~ms}, 32 \mathrm{~ms}$ or 64 ms . If the peak load exceeds the programmed timer, the InnoSwitch5-Pro can be programmed to respond to this fault as disable output, autorestart, latch-off or no-response through the CVO Register 0x0E bit [2:1]. The default response for peak overload is auto-restart with 8 ms timer.

In case of Disable - Output (DO) response, InnoSwitch5-Pro will open the series bus switch and reset to default configuration when the fault occurs. After reset, InnoSwitch5-Pro might annunciate other faults - example VOUT OV AR depending on the operating condition of the power supply.


Figure 16. Constant Voltage Only (CVO) Mode.
Example: Enable CVO Mode, set $t_{\text {PLT }}$ to 16 ms and fault response to Disable - Output (DO): (0x0F):
PI_SLAVE_ADDRESS [W]: 0x30 (8'b0011 0000)
PI_Command:
CVO Register (0x0E)
Byte:
0x0F (8'b0000 1111)

## Synchronous Rectifier based Zero Voltage Switching (SR-ZVS)

In Quasi-Resonant (QR) mode of operation of InnoSwitch5-Pro, zero voltage switching of the primary switch can be achieved using the secondary SRFET through an $\mathrm{I}^{2} \mathrm{C}$ command.
With SR-ZVS mode enabled, the secondary controller detects when the power supply enters in discontinuous-mode and turns ON SRFET for the duration programmed in SR-ZVS Register (0x3E, bit [4:0] -SR-ZVS ON-time). During this time magnetizing current is charged in negative direction at the rate determined by the reflected output voltage on the primary. At the end of SR-ZVS ON time, the magnetizing energy will start discharging the drain node capacitance on the primary switch. The duration for this discharge before sending out the secondary cycle request is programmable through SR-ZVS Register (0x3E, bit [7:5] - SR-ZVS Delay time). The minimum delay programmed should allow the SR gate to discharge below the gate threshold voltage before the switching request is sent. If the delay programmed is too short and the SR gate voltage has not discharged sufficiently, secondary will abort the switching request and device will auto-restart to prevent any kind of cross conduction.
Both the SR-ZVS ON-time and SR-ZVS Delay time can be adjusted through $\mathrm{I}^{2} \mathrm{C}$ commands in steps of $\sim 85 \mathrm{~ns}$ depending on the output voltage and load current to achieve highest efficiency at different operating conditions. Refer to Command Register Assignment Table for programmable limits. The timings measured are approximately one to two clock cycle more than the set values in the SR-ZVS Register.

In case of SR-ZVS ON-time, with the minimum programmed value of d'3, the measured value for SRZVS ON-time is $\sim 400$ ns whereas for SR-ZVS Delay time, it is ~350 ns.
In order to improve the thermals and reduce switching losses on the SR FET during this ZVS operation, SR FET can be forced to switch when the FW voltage is near its minimum voltage by writing 1 'b1 into SR-ZVS register (0x3E, bit [11] - Valley switching).


Figure 17. Waveforms for SR-ZVS Mode of Operation.
Example: Enable SR-ZVS mode:
SR-ZVS ON-time $=($ SRZVS ON count +1$) * 85 n s=(6+1) * 85 n s=$ ~600ns (bit [4:0] = d'6 or 5'b 00110)
SR-ZVS Delay time $=($ SRZVS Delay Count +1$) * 85 n s=(3+1) * 85 n s=$ ~350 ns (bit [7:5] = d'3 or 3'b 011)
SR-ZVS Enable = 1'b1 (bit [10])
Valley Switching Enable = 1'b1 (bit [11])
PI_SLAVE_ADDRESS [W]: $0 \times 30$ ( $8^{\prime}$ b0011 0000)
PI_Command: SR-ZVS Register (0x3E)
Low Byte: $\quad 0 x 66$ ( $8^{\prime}$ b0110 0110) High Byte: $\quad 0 x 0 \mathrm{C}$ (8'b0000 1100)
During disable of SR-ZVS, valley switching also need to be disabled to have Quasi-Resonant (QR) mode enabled.

## Mode of Operation Transition Sequence

While transitioning from Quasi-Resonant (QR) mode of operation to SR-ZVS mode of operation and vice-versa, it is recommended to follow the below sequence.

## Quasi-Resonant Mode to SR-ZVS Mode sequence:

Step 1: Enable SR-ZVS mode without Valley switching enabled.
Example:
SR-ZVS ON-time $=(6+1) * 85 n s=\sim 600 n s$ (bit [4:0] $=d^{\prime} 6$ )
SR-ZVS Delay time $=(3+1) * 85 \mathrm{~ns}=\sim 350$ ns (bit [7:5] $=d^{\prime} 3$ )
SR-ZVS Enable = 1'b1 (bit [10])
Valley Switching Enable = 1'b0 (bit [11])
PI_SLAVE_ADDRESS [W]: $\quad 0 \times 30$ ( 8 'b0011 0000)
PI_Command: SR-ZVS Register (0x3E)
Low Byte: $\quad 0 \times 66$ ( 8 'b0110 0110)
High Byte: $\quad 0 x 04(8 \prime b 00000100)$
Step 2: Enable Valley switching.
Example:
SR-ZVS ON-time $=(6+1) * 85 \mathrm{~ns}=\sim 600 \mathrm{~ns}$ (bit [4:0] $=d^{\prime} 6$ )
SR-ZVS Delay time $=(3+1) * 85 \mathrm{~ns}=\sim 350 \mathrm{~ns}$ (bit [7:5] $=d^{\prime} 3$ )
SR-ZVS Enable = 1'b1 (bit [10])
Valley Switching Enable = 1'b1 (bit [11])
PI_SLAVE_ADDRESS [W]: $\quad 0 \times 30(8$ 'b0011 0000)
PI_Command: SR-ZVS Register (0x3E)
Low Byte: $\quad 0 x 66$ ( 8 'b0110 0110)
High Byte: $0 x 0 \mathrm{C}\left(8^{\prime} \mathrm{b} 0000\right.$ 1100 $)$

## SR-ZVS Mode to Quasi-Resonant (QR) Mode sequence:

Step 1: Disable Valley Switching first.
Example:
SR-ZVS ON-time $=(6+1) * 85 n s=\sim 600 \mathrm{~ns}$ (bit [4:0] $=d^{\prime} 6$ )
SR-ZVS Delay time $=(3+1) * 85 \mathrm{~ns}=\sim 350 \mathrm{~ns}$ (bit [7:5] $=d^{\prime} 3$ )
SR-ZVS Enable = 1'b1 (bit [10])
Valley Switching Enable = 1'b0 (bit [11])
PI_SLAVE_ADDRESS [W]: $\quad 0 \times 30(8$ 'b0011 0000)
PI_Command: $\quad$ SR-ZVS Register ( $0 \times 3 \mathrm{E}$ )
Low Byte: $\quad 0 x 66$ ( 8 'b0110 0110)
High Byte: $\quad 0 \times 04$ ( $8^{\prime} \mathrm{b} 00000100$ )
Step 2: Disable SR-ZVS mode with settings provided below.
Example:
SR-ZVS ON-time $=$ bit [4:0] $=d^{\prime} 0$
SR-ZVS Delay time $=$ bit [7:5] $=d^{\prime} 2$
SR-ZVS Enable = 1'b0 (bit [10])
Valley Switching Enable = 1'b0 (bit [11])

| PI_SLAVE_ADDRESS [W]: | $0 \times 30\left(8^{\prime} \mathrm{b} 00110000\right)$ |
| :--- | :--- |
| PI_Command: | SR-ZVS Register (0x3E) |
| Low Byte: | $0 \times 40\left(8^{\prime} \mathrm{b} 01000000\right)$ |
| High Byte: | $0 \times 00\left(8^{\prime} \mathrm{b} 00000000\right)$ |

With SR-ZVS ON-time of d'0, SR gate drive signal will be observed for minimal ZVS period. The minimum delay programmed should allow the SR gate to discharge below the gate threshold voltage before the switching request is sent.

## Programmable Protection Mechanisms

## Output Overvoltage and Undervoltage Protection Thresholds/Fault Behavior

Besides the ability of programing the OV/UV thresholds on the fly as a function of the set CV, the behavior of the power supply once a fault occurs (a. No-Response which just sets the fault register, b. Latch-off (LO), c. Auto-restart (AR) or d. Disable Output (DO)) and timing for the UV fault detection ( $8 \mathrm{~ms}, 16 \mathrm{~ms}, 32 \mathrm{~ms}$ or 64 ms ) is programmable as well. In InnoSwitch5-Pro, for UV fault, there is an option to disable the UV timer, in which case the selected timer option will be ignored and the delay is same as the output overvoltage delay fixed at $\sim 80 \mu \mathrm{~s}$. All faults that are programmed to have no-response will be logged into the telemetry read-back fault register.
In case of Disable - Output (DO) response, InnoSwitch5-Pro will open the series bus switch and reset to default configuration when the fault occurs. After reset, InnoSwitch5-Pro might annunciate other faults - example VOUT OV AR depending on the operating condition of the power supply.
OVA(0×92) : write to this address to specify the overvoltage threshold and fault response to OV fault
UVA( $0 \times 94$ ) : write to this address to specify the undervoltage threshold, UV timer and fault response to UV fault

Example: To change the absolute output undervoltage threshold 3 V (d'30), fault response to Disable-Output (DO) and configure fault timer to 64ms: (0xBC9E with odd parity):
PI_SLAVE_ADDRESS [W]: $\quad 0 \times 30$ ( 8 'b0011 0000)
PI_Command:
Low Byte:
UVA Register ( $0 \times 94$ )
0x9E (8'b1001 1110)
0xBC ( $8^{\prime} \mathrm{b} 1011$ 1100)

## IS Pin and Output Short-Circuit Fault Protection

The InnoSwitch5-Pro can be configured to monitor whether a short-circuit fault occurs across the output current sense resistor or a short-circuit fault across the IS to GND pins.

A fault is annunciated in the event the sensed current through IS pin does not exceed the programmed current limit threshold (bit [6:4] of ISSC register 0xA2) and switching frequency exceeding the programmed threshold (bit [3:2] of ISSC register 0xA2). The switching frequency can be selected in a range from 30 to 120 kHz . This must be carefully selected to suit the expected operating conditions of the design.
An IS pin short (ISSC) can be programmed to have a response to be a. No-Response, b. Latch-off (LO), c. Auto-restart (AR) or d. Disable Output (DO). In the event the behavior is a No-Response, the Telemetry Read-Back Fault Register is logged.
ISSC (0xA2): write to this address to specify the behavior for an IS-GND short.

Example: To set the behavior of an IS pin short to AR for switching frequency exceeding 30 kHz and current limit threshold of d'48: (0x36):
PI_SLAVE_ADDRESS [W]: $\quad 0 \times 30$ ( 8 'b0011 0000)
PI_Command:
ISSC register ( $0 \times A 2$ )
Byte:
0x36 (8'b0011 0110)
The InnoSwitch5-Pro sets the CCSC fault register (READ 10 bit 2) once the voltage across the IS pin resistor exceeds more than $\sim 3$ times the $\mathrm{I}_{\text {sv(TH) }}$. The CCSC register can be programmed to have response of a. No-Response, b. Latch-off (LO), or c. Auto-restart (AR). In applications where the output capacitance after the series bus-switch exceeds $100 \mu \mathrm{~F}$, the response for CCSC should be set to

No-Response for proper start-up and may be programmed back to other fault response during normal operation after the series bus-switch is closed.
CCSC ( $0 \times 20$ ): write to this address to specify the behavior for an output short-circuit.

Example: Set behavior of output short-circuit to No-response:

| PI_SLAVE_ADDRESS [W]: | $0 \times 30\left(8^{\prime} \mathrm{b} 00110000\right)$ |
| :--- | :--- |
| PI_Command: | CCSC Register $(0 \times 20)$ |
| Byte: | $0 \times 00\left(2^{\prime} \mathrm{b} 00\right)$ |

Setting CCSC register to No-Response and creating a short-circuit condition at output will result in Auto-Restart if switching frequency is $>f_{\text {ovL }}$ parameter for longer than $t_{A R}$.

## Series Bus Switch Short-Circuit Fault Protection

Series bus switch short-circuit fault is set in the event when sensed current through IS pin exceeds the programmed threshold (bit [5:4] of VBUSSC register $0 \times B 6$ ) and VBEN is disabled. There is option to program the number of current samples (1,2,3 or 4 consecutive samples) exceeding the set threshold before annunciating the fault.
A VBUS switch short (VBUSSC) can be programmed to have a response to be a. No-Response, b. Latch-off (LO) or c. Auto-restart (AR). In the event the behavior is a No-Response, the Telemetry Read-Back Fault Register is logged.

VBUSSC fault once triggered can be cleared with secondary giving up control or by sending the VBEN enable command. Writing into interrupt mask will not clear the fault

## Watchdog Timer (0x26)

The Watchdog timer supervises the communication on the $\mathrm{I}^{2} \mathrm{C}$ command lines and has an adjustable time-out. InnoSwitch5-Pro will go into a reset state if $\mathrm{I}^{2} \mathrm{C}$ commands are not received within the programmable time interval. The watchdog timer does not engage until the master issues the first $\mathrm{I}^{2} \mathrm{C}$ command (Read or Write). In the reset state the following occurs:

1. VBUS switch is Disabled (Series switch is open).
2. VOUT pin voltage regulates at the default 5 V threshold.
3. All command registers are cleared.

By writing $0 \times 00$ into register $0 \times 26$, the Watchdog timer is disabled. Disabling this feature can be useful in initial software debugging or checking functionality of the device on the bench.

Example: To disable the Watchdog timer:

| PI_SLAVE_ADDRESS [W]: | $0 \times 30\left(8^{\prime} \mathrm{b} 00110000\right)$ |
| :--- | :--- |
| PI_Command: | Watchdog Timer Register (0x26) |
| Byte: | $0 \times 00\left(2^{\prime} \mathrm{b} 00\right)$ |

## Opening and Closing the Series VBUS Switch (0x04)

Enabling VBEN (closing the VBUS series switch) speeds up the ADC sampling frequency in order to achieve high control accuracy. Write commands to CV register ( $0 \times 10$ ) and CC register ( $0 \times 98$ ) cannot be accepted faster than 80 ms when the VBEN is disabled (Series VBUS switch open).
Write $0 \times 03$ (with odd parity this becomes $0 \times 83$ ) into the VBEN register ( $0 \times 04$ ) to close the series VBUS switch and write $0 \times 00$ (with odd parity this becomes $0 \times 80$ ) to this register to open the switch. When the VBUS switch is open (VBEN disabled), the system is reset to the default output voltage set point of 5 V . Disabling the series VBUS switch also resets all the programmable command registers to their default values. The InnoSwitch5-Pro controller is in a state of reset when VBEN is disabled or the VDIS register is enabled.

For both these commands, since the controller is in reset, an ACK or Nack at the end of the command should not be expected.

InnoSwitch5-Pro also includes the option of bus switch open and no system reset. Write $0 \times 01$ (with odd parity $0 \times 01$ ) into the VBEN register ( $0 \times 04$ ) to open the switch without system reset. In this case, series bus switch is opened and the output voltage before the switch remains as configured previously in the CV register. All the programmable command registers do not reset to default values, instead retain the previous programmed configuration.
Enabling the VBEN register automatically disables the VDIS register ( $0 \times 08$ ) described in Active VOUT Pin Bleeder and Output Load Discharge Functions section.

Example: Enabling (Closing) the Series VBUS switch (0x83):
PI_SLAVE_ADDRESS [W]: $\quad 0 \times 30(8$ 'b0011 0000 $)$
PI_Command: VBEN Register (0x04)
Byte: $\quad 0 \times 83$ ( 8 'b1000 0011)
Prior to sending command to open the series bus switch with system reset ( $0 \times 00$ ), a command to set the output voltage (CV register 0x10) to 5 V is recommended. In the event of an auto-restart or latch-off, the bus switch is not disabled. In the event of disable-output, the bus switch is disabled and system is reset to default configuration. The VBEN command must be sent to enable the series bus switch (close the switch) prior to increasing the output voltage above 16 V .

## Turn-Off the Power Supply (0x8A)

The $\mathrm{I}^{2} \mathrm{C}$ master has the ability to turn-off the power supply (through an $\mathrm{I}^{2} \mathrm{C}$ command), which will require AC power cycling to restart the power supply.
Example: Turn-off the power supply:
PI_SLAVE_ADDRESS [W]:
0x30 ( 8 'b0011 0000)
$\begin{array}{ll}\text { PI_Command: } & \text { Turn-Off PSU Register ( } 0 \times 8 \mathrm{~A} \text { ) } \\ \text { Byte: } & 0 \times 01\left(1^{\prime} \mathrm{b} 1\right)\end{array}$
Byte:
$0 \times 01$ (1'b1)

## Fast VI Command

By default, the maximum speed in which CV ( $0 \times 10$ ) and CC ( $0 \times 98$ ) commands can be sent to program output voltage/current respectively is 10 msec . However, the speed limit can be removed by setting $0 \times 1$ to the Fast VI Command Register ( $0 \times 8 \mathrm{C}$ ).
Example: To disable speed limit for V/I commands:

| PI_SLAVE_ADDRESS [W]: | $0 \times 30(8$ 'b0011 0000) |
| :--- | :--- |
| PI_Command: | Fast VI Speed Register (0x8C) |
| Byte: | $0 \times 01$ (1'b1) |

## Output Load Discharge Functions

The InnoSwitch5-Pro can discharge the VBUS output voltage by bringing the VB/D pin to ground. The discharge circuit is a series diode + resistor tied from the VBUS output to the VB/D pin shown in the typical application schematic. The resistor selected should limit the current into VB/D pin within the max current limit specified in the electrical specifications.

Load discharge function can be activated by writing 0x03 (0x83 with odd parity) into VDIS register (0x08). Enabling the VDIS register will automatically disable the VBEN register ( $0 \times 04$ ) and reset the device to the default state.
The $\mathrm{I}^{2} \mathrm{C}$ master can use telemetry to monitor the VOUT pin voltage or a fixed timer to help determine when to disable this function.
In circumstances where device reset is not desirable, load discharge function can be activated without reset by writing $0 \times 02$ into VDIS register ( $0 \times 08$ ). This command will enable load discharge without device reset.

Example: Activate the Vout Bleeder:

| PI_SLAVE_ADDRESS [W]: | $0 \times 30\left(8^{\prime}\right.$ b0011 0000) |
| :--- | :--- |
| PI_Command: | BLEEDER Register (0x86) |
| Byte: | $0 \times 01\left(8^{\prime} b 00000001\right)$ |

Example: Discharge the VBUS Output:

| PI_SLAVE_ADDRESS [W]: | $0 \times 30\left(8^{\prime} \mathrm{b} 00110000\right)$ |
| :--- | :--- |
| PI_Command: | VDIS Register (0x08) |
| Byte: | $0 \times 83\left(8^{\prime} \mathrm{b} 1000\right.$ 0011) |

## Active VOUT Pin Bleeder with Auto Disable Control for Reducing $\mathrm{I}^{2} \mathrm{C}$ Traffic

There may be circumstances where the VOUT pin strong bleeder function must be activated to discharge the output voltage from a high to low regulation set point. InnoSwitch5-Pro includes an option of Enable BLEEDER with Auto Disable feature. Writing $0 \times 03$ into the BLEEDER register ( $0 \times 86$ ) will enable the bleeder function with auto disable feature. The bleeder is automatically disabled when the VOUT10PCT or VOUT4PCT register is cleared. This selection is programmable through bit [2] of the BLEEDER command. The VOUT10PCT register is set once the output voltage is above $10 \%$ of the target regulation voltage. The VOUT4PCT register is set once the output voltage is above $4 \%$ of the target regulation voltage. Weak bleeder should be enabled $0 \times 86=0 \times D \times$ before exercising the auto bleeder control commands. During output voltage decrement process, it is recommended to have $\sim 1 \mathrm{~ms}$ delay between the CV command and enabling the strong bleeder with auto disable feature.
The BLEEDER register must not be enabled for extended period of time to prevent excessive power dissipation in the controller.
The InnoSwitch5-Pro automatically disables $\operatorname{SR}$ pin when strong bleeder is enabled as the switching is not expected when bleeder is used to reduce the output voltage.

## Transient Response

If faster transient response is required in the application the InnoSwitch5-Pro includes command registers to reduce the time for low to high output voltage transitions. The command register addresses and recommended settings are shown in the table below:

| Command <br> Register Address | Default |  | Recommended <br> for Speed Up |  |
| :---: | :---: | :---: | :---: | :---: |
|  | MSB | LSB | MSB | LSB |
| $0 \times 32$ | $0 \times 28$ | $0 \times 1 \mathrm{E}$ | $0 \times 14$ | $0 \times 0 \mathrm{~A}$ |
| $0 \times 34$ | $0 \times 18$ | $0 \times C 8$ | $0 \times 1 \mathrm{~F}$ | $0 \times 84$ |

Using values other than the default or recommended settings about could lead to oscillatory behavior.

## Constant Voltage Load

The constant current regulation mode in the InnoSwitch5-Pro can be optimized for constant voltage (CV) type load if this is required by the end application. Enabling this command register reduces the output current ripple for CV load only. The command register and setting below should only be used if CV load must be supported.

| Command <br> Register |  | Default |  | Recommended <br> for CV Lod |  |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Address | Address <br> with Odd <br> Parity | MSB | LSB | MSB | LSB |
| $0 \times 30$ | $0 \times B 0$ | $0 \times 00$ | $0 \times 1 \mathrm{~F}$ | $0 \times 0 \mathrm{~A}$ | $0 \times 20$ |

## DCM-Only

InnoSwitch5-Pro includes a feature to limit the switching cycle requests from secondary to primary such that converter always operates in the Discontinuous Conduction Mode (DCM).

At high line, when a step load occurs, it would normally introduce one or more CCM cycles and raise the peak FW pin voltage. Enabling the DCM-only feature will limit this peak voltage and thereby reduce the stress on SR-FET.

DCM-only feature can be enabled/disabled through $\mathrm{I}^{2} \mathrm{C}$ command. Writing 0x04 into DCM-only register ( $0 \times B A$ ) will enable this feature.

Example: Enable DCM-only mode:

| PI_SLAVE_ADDRESS [W]: | $0 \times 30(8$ 'b0011 0000) |
| :--- | :--- |
| PI_Command: | DCM-only Register (0xBA) |
| Byte: | $0 \times 04\left(8^{\prime} \mathrm{b} 00000100\right)$ |

## Telemetry (Read-Back) Registers

Telemetry read registers (READ1 to READ7) show the content of all the command registers in Table 3. Telemetry read register addresses are grouped to allow optimal polling to get the power supply status in single $I^{2} \mathrm{C}$ read back command with start and end telemetry addresses of interest.

## Fault Registers

All the command registers including set voltage, set current, constant-power knee voltage, control (Series VBUS switch, VOUT pin Bleeder, Load discharge etc.) and all fault status can be read-back using the Telemetry functionality of the InnoSwitch5-Pro through $I^{2} C$.

The READ10 telemetry registers are instantaneous and are cleared whenever the condition is no longer valid.

The READ15 ( $0 \times 1 \mathrm{E}$ ) and READ16 ( $0 \times 20$ ) Register contains fault register data for auto-restart, latch-off and disable output. This register is only cleared when the BPS pin falls below its undervoltage threshold.

Example: Read the Fault Telemetry Register to determine an autorestart occurred due to an output undervoltage (UV) Fault:

| PI_SLAVE_ADDRESS [W]: | $0 \times 30\left(8^{\prime} \mathrm{b} 0011\right.$ 0000 $)$ |
| :--- | :--- |
| Read Register: | $0 \times 80$ |
| Telemetry Register: | $0 \times 20$ |
| PI_SLAVE_ADDRESS [r]: | $0 \times 31\left(8^{\prime} \mathrm{b} 00110001\right)$ |
| PI_Slave Response: | Low Byte $8^{\prime} \mathrm{b} 00000000(0 \times 00)$ |
|  | High Byte $8^{\prime} \mathrm{b} 00000010(0 \times 02)$ |

## Operating Mode Flag (OMF)

InnoSwitch5-Pro reports the mode of operation in telemetry register READ11 (0x16). It reports if InnoSwitch5-Pro is operating in CV, CP or CC mode. If interrupt mask is enabled, interrupt is raised whenever operating mode changes between CV, CP and CC modes. The OMF status of the supply should be read when in steady-state operation.

## Main Regulation DAC Input

The READ14 telemetry register is the input into the main regulation loop that controls constant voltage, constant current and constant output power regulation. If this register is the same as the Set CV Register ( $0 \times 10$ ) the converter is operating in constant-voltage mode. If the READ14 is less than the Set CV Register ( $0 \times 10$ ) the converter is operating in constant-current (CC) or constant-power (CP) mode depending on the value of the Constant Power Knee Voltage Register ( $0 \times 1 \mathrm{~A}$ ).

The output voltage from the READ14 register is computed as:

$$
\mathrm{V}_{\text {OUT }}=5 \mathrm{~V}+(\mathrm{MSB} \times 100 \mathrm{mV})-(\mathrm{LSB} \times 10 \mathrm{mV})
$$

Example: READ14 ( $0 \times 1 \mathrm{C}$ ): MSB $=0 \times 00, \mathrm{LSB}=0 \times 0 \mathrm{E}$
LSB is d'14 so the computed $\mathrm{V}_{\text {out }}=5-(14 \times 10 \mathrm{mV})=4.86 \mathrm{~V}$


Figure 18. Interrupt Mask During Idle $\mathrm{I}^{2} \mathrm{C}$.


Figure 19. Interrupt Mask During Active $\mathrm{I}^{2} \mathrm{C}$ Transaction.

## Fault Signaling Interrupt Through SCL Pin

In order to improve the fault reporting, an active interrupt reporting scheme is featured on the SCL pin during $\mathrm{I}^{2} \mathrm{C}$ idle state (when both SDA and SCL pins are pulled high).
When a fault occurs, the SCL pin will behave in one of the following two conditions:

1. When the SCL pin is in idle mode (see Figure 15), the fault interrupt will happen as soon as the fault is detected. The interrupt pulls down the SCL pin for $50 \mu \mathrm{sec}$ then releases it back to HI State.
2. When the SCL pin is busy (active $I^{2} C$ transaction) (see Figure 16), the fault interrupt will wait for the $\mathrm{I}^{2} \mathrm{C}$ transaction to be completed, wait $\sim 22 \mu \mathrm{sec}$ and then pull down the SCL line for $50 \mu \mathrm{sec}$ (minimum) then releases it back to HI State.
The Interrupt Mask Write Register ( $0 \times 2 \mathrm{C}$ ) must be enabled for each of the individual fault conditions. See Figure 19. In order to activate this feature. Once a fault occurs, the Interrupt is reset and the particular faults of interest must be re-enabled to activate the SCL reporting scheme.
The Interrupt Mask read register ( $0 \times 22$ ) will not be auto cleared when the interrupt triggers and will only reset when the Interrupt Mask write register is re-enabled. The Control Secondary Interrupt bit [6] is an indication that the secondary controller is waiting to handshake with primary. Several system faults could trigger this event such as primary-side thermal shutdown or an input line under or overvoltage condition.
Note 1: Any fault response configured as a No Response and Interrupt Mask enabled will result in an interrupt signal on the SCL pin.
Note 2: Any fault response configured as a Disabled Output and Interrupt Mask enabled results in a system reset when the fault is annunciated and the status of Interrupt signal on the SCL pin is ambivalent. It is recommended not to enable the Interrupt Mask for the faults that are configured to Disable Output response.


Figure 20. Interrupt Mask Register.
Example: Set the Interrupt Write Register to flag SCL pin fault for output OV, UV or short-circuit only:

```
PI_SLAVE_ADDRESS [W]: 0x30 (8'b0011 0000)
PI_Command: INTM Register (0x2C)
Byte: 0x07 (8'b0000 0111)
```


## Output Voltage Measurement

The voltage on the VOUT pin is available on the Telemetry Register READ9 ( $0 \times 12$ ). The tolerance of this telemetry register is $\pm 3 \%$ over the entire regulation range of 3 to 30 V . When the output voltage is below 5 V at loads below $\sim 50 \mathrm{~mA}$, the voltage may fluctuate due to very low switching frequency of the converter but within the specified tolerance. This is normal and expected behavior.

The output voltage report back is in 12-bit format, but the resolution depends on the output voltage range as shown in Table 10. This telemetry register is for indication only, in steady-state operation the VOUT pin is very tightly regulated per the CV Write Register ( $0 \times 10$ ) discussed in CV Register ( $0 \times 10$ ) section.

The report back resolution step size depending on output voltage is tabulated below:

| Output Voltage Range (V) |  | Resolution <br> Step Size |
| :---: | :---: | :---: |
| 3 | 4 | 20 mV |
| 4 | 8 | 40 mV |
| 8 | 16 | 80 mV |
| 16 | 32 | 160 mV |

Table 10. Output Voltage Report Back Resolution.
Example: If the READ 9 read-back register value is 0xA801 recalling that low byte precedes the high byte, the proper hex to decimal conversion would be from $0 \times 01 \mathrm{~A} 8=424$ in decimal.
The full output voltage range the report back should be divided by 10 mV to convert into actual output voltage, which in this example results in an output voltage of 4.24 V .
Read-back of the output voltage set-point READ1 ( $0 \times 02$ ) as with all the read registers is formatted with low-byte preceding the high-byte.

## Output Current Measurement

The load output current is also available on the Telemetry Register.
Telemetry Register READ8 ( $0 \times 10$ ) contains the instantaneous measured relative output load current data. The load current is available on a relative basis with respect to the full-scale constant current regulation threshold programmed by the sense resistor tied between the IS and GND pin of the InnoSwitch5-Pro.

The ADC full range is 192, which denotes $100 \%$ threshold across the current sense resistor.
Example: If a $10 \mathrm{~m} \Omega$ sense resistor is used and the read-back register is $0 \times 8040$.
Removing the odd parity bit from high byte results in $0 \times 40=64$ in decimal.
Sense current value $=N\left(\right.$ Decimal) $\times 0.167 / R_{\text {SENSE }}$
$64 \times 0.167 / 10=1.068 \mathrm{~A}$. This is the measured output current value:
( $0.167 \mathrm{mV}=32 \mathrm{mV} / 192$, where $32 \mathrm{mV}=\mathrm{IS}_{(\text {тН) }}$ and 192 is ADC full range).
The READ12 and READ13 are 16 sample rolling averages of the measured output current and output voltage respectively. The value of these average registers is more stable than the instantaneous registers (READ8 and READ9) but take slightly longer to stabilize.
When the series BUS switch is opened these registers are cleared and values are reset to zero until the measurement start to accumulate. The resolution of READ 12 and READ 13 is the same as the READ8 and READ 9 respectively.
The output voltage and current measurement registers are updated every $100 \mu \mathrm{~s}$.

## Input Line Voltage Measurement

InnoSwitch5-Pro reports the primary switch conduction time and the secondary switch (synchronous rectifier) conduction time which could be used in the volt-second balance equation to estimate the line input voltage. Primary switch conduction time referred to as TON is reported in READ21 ( $0 \times 2 \mathrm{~A}$ ) and Secondary switch (SR) conduction time referred to as TOFF is reported in READ22 ( $0 \times 2 \mathrm{C}$ ).

The telemetry is updated only when the Line Sense Enable command is sent by writing $0 \times 01$ into command register $0 \times 1 \mathrm{C}$. After the command is sent, InnoSwitch5-Pro updates the TON and TOFF telemetry with 16 sample accumulated value and the Line Sense Reporting Ready flag is set in READ10 register bit [12]. To extract the average TON and TOFF, these values should be divided by 16 . To optimize the power consumption, the telemetry of TON and TOFF is updated only when the Line Sense Enable command is sent.

Example: Read the TON and TOFF telemetry:
Line Sense Enable Command
PI_SLAVE_ADDRESS [W]: $0 \times 30$ ( 8 'b0011 0000)
PI_Command: Line Sense Register ( $0 \times 1 \mathrm{C}$ )
Byte: $\quad 0 x 01\left(8^{\prime} b 00000001\right)$

## Read Line Sense Reporting Ready Flag

PI_SLAVE_ADDRESS [W]: 0x30 (8'b0011 0000)
Read Register: $0 \times 80$
Telemetry Register:
$0 \times 14$
PI_SLAVE_ADDRESS [r]:
$0 \times 31$ ( $8^{\prime} \mathrm{b} 0011$ 0001)
PI_Slave Response:
Low Byte 8'b0000 0000 ( $0 \times 00$ )
High Byte 8'b0101 0000 ( $0 \times 50$ )
Read TON and TOFF telemetry registers
PI_SLAVE_ADDRESS [W]: $0 \times 30$ ( $8^{\prime} \mathrm{b} 0011$ 0000)
Read Register: 0x80
Telemetry Register: $0 \times 2 \mathrm{~A}$
PI_SLAVE_ADDRESS [r]: $\quad 0 \times 31$ ( 8 'b0011 0001)
PI_Slave Response: Low Byte 8'b0010 1110 (0x2E)
High Byte 8'b0000 0110 ( $0 \times 06$ )
PI_SLAVE_ADDRESS [W]: $\quad 0 \times 30(8$ 'b0011 0000)
Read Register:
$0 \times 80$
Telemetry Register:
$0 \times 2 \mathrm{C}$
PI_SLAVE_ADDRESS [r]: $\quad 0 \times 31$ ( 8 'b0011 0001)
PI_Slave Response: Low Byte 8'b1111 0010 (0xF2) High Byte 8'b0000 0011 (0x03)

Equation to convert TON and TOFF to estimate line input voltage:

$$
\mathrm{VIN}=\frac{\mathrm{N}_{\mathrm{P}}}{\mathrm{~N}_{\mathrm{S}}} \times\left(\mathrm{VOUT}+\mathrm{V}_{\mathrm{SD}(\text { SR })}\right) \times \frac{\mathrm{TOFF}}{\mathrm{TON}}
$$

Example: At 100 V input and 30 V output, using TON, TOFF and average VOUT telemetry reported to estimate the input line voltage

Method 1: Directly using the 16 -sample accumulated values (more accurate)
$\mathrm{N}_{\mathrm{p}}=25 \mathrm{~T} ; \mathrm{N}_{\mathrm{s}}=5 \mathrm{~T}$
Average VOUT, READ13 ( $0 \times 1 \mathrm{~A}$ ) $=\mathrm{h}^{\prime} 0 \times 0 \mathrm{~B} 9 \mathrm{C}$ or d'2972 (29.72 Volts) 16 sample accumulated TON count, READ21 $=h^{\prime} 0 \times 062 E$ or d'1582 16 sample accumulated TOFF count, READ22 $=h^{\prime} 0 \times 03 F 2$ or d'1010

$$
\mathrm{VIN}=\frac{25}{5} \times 30 \mathrm{~V} \times \frac{1010}{1518}=99.8 \mathrm{~V}
$$

Note: For TON count telemetry value, $4 \times 16=d^{\prime} 64$ needs to be subtracted to account for the delays in the system

Method 2: By converting the reported count values into time.
Convert hex to decimal format:
READ21: 0x062E (hex) to d'1582 (decimal)
$T O N_{\text {AVG }}=1582 / 16 * 85 n s=8.4 \mu \mathrm{~S}$
READ22: 0x03F2 (hex) to d'1010 (decimal)
TOFF $_{\text {AVG }}=1010 / 16 * 85 \mathrm{~ns}=5.36 \mu \mathrm{~S}$
Note: TON $_{\text {Avg }}$ includes extra delay of $250 \sim 350$ ns which needs to be subtracted to account for the delays in the system.


Figure 21. Measurement of TON Time and TOFF Time.


Figure 22. Accuracy of Input Line Voltage Measurement.


Figure 23. Accuracy of Input Line Voltage Measurement Centered.

The accuracy of the line sense feature requires regular switching pattern with complete SR conduction period. It also depends on how accurately the volt-second balance equation is modeled. At light load, with irregular switching pattern and ON/OFF time approaching minimum conduction time, the accuracy of line sense feature will be compromised. If SR is disabled, this feature cannot be used.
If the SR conduction period is short, then the accuracy will be compromised if the TOFF telemetry is directly used in calculations without compensating for the short SR conduction. For such cases, it is recommended to characterize the design across different operating conditions and include the additional time into TOFF parameter before estimating the line input voltage. This accuracy can be further improved by centering the curves around the ideal line with a correction factor in the firmware.

In the case of SRZVS mode of operation, before exercising the Line Sense Enable command, the SRZVS operation needs to be optimized i.e., the SRZVS ON time and SRZVS delay time need to be set to have optimal ZVS. Excessive SRZVS ON times and delay times lead to inaccuracies in the volt-second balance equation used here for input line voltage estimation. To the reported TOFF parameter, add SRZVS ON time before computing the input line voltage.
Example: At 200 V input and 30 V output, using TON, TOFF and average VOUT telemetry reported to estimate the input line voltage
Method 1: Directly using the 16 -sample accumulated value (more accurate)
$N_{p}=25 \mathrm{~T} ; \mathrm{N}_{\mathrm{s}}=5 \mathrm{~T}$
Average VOUT, READ13 ( $0 \times 1 \mathrm{~A}$ ) $=\mathrm{h}^{\prime} 0 \times 0 \mathrm{~B} 9 \mathrm{~A}$ or d'2970 (29.70 Volts)
SRZVS ON time $=4 * 85 \mathrm{~ns}=\sim 350 \mathrm{~ns}$
16 sample accumulated TON count, READ21 $=h^{\prime} 0 \times 03 A 3$ or d'931
16 sample accumulated TOFF count, READ22 $=\mathrm{h}^{\prime} 0 \times 0465$ or d'1125

$$
\begin{gathered}
\left.\mathrm{VIN}=\frac{\mathrm{N}_{\mathrm{p}}}{\mathrm{~N}_{\mathrm{s}}} \times\left(\text { VOUT }+\mathrm{V}_{\text {DS(SR) }}\right) \times \frac{(\text { TOFF }+ \text { SRZVS }}{\text { TON }} \text { ontime }\right) \\
\mathrm{VIN}=\frac{25}{5} \times 30 \mathrm{~V} \times \frac{1125+4 \times 16}{867}=205.7 \mathrm{~V}
\end{gathered}
$$

Note: For TON count telemetry value, $4^{*} 16=d^{\prime} 64$ is subtracted to account for the delays in the system.
Method 2 is applicable with the changes described above for SRZVS mode of operation.

## End of Line Calibration

To enhance the output current tolerance performance, InnoSwitch5-Pro provides End of Line Calibration feature where the variation in the device offset can be independently canceled for each device in the application. InnoSwitch5-Pro provides telemetry of the offset measured during test in READ23 register. This offset can be added or subtracted to the code sent to CC register ( $0 \times 18$ ) that sets the constant current regulation threshold.

Example: If READ23 telemetry data is 0x0004. The least significant 4 bits are 4'b0100.

End of line calibration telemetry $=4 \mathrm{~b} 0100$ (binary) or d'4 (decimal)
Constant Current Regulation Offset bit [2:0] = 3'b100 or d'4 (decimal)
Offset sign bit [3] = 1'b0, implies positive
CC Regulation Code ( $0 \times 18$ )
$=$ CC CODE $_{\text {withoffsetzero }}+$ End of Line Calibration
If the CC regulation code for 2 A is d'64 (calibrated using device with end of line calibration offset $=0$ ), the CC regulation code for this part will be d'64 + d'4 = d'68 to have the same CC performance as the part with ' 0 ' offset and tolerance due to part-to-part variation is completely canceled.
Procedure would be to calibrate and derive the CC regulation codes with zero offset part on the application design and then add or subtract the device offset using the end of line calibration telemetry. If the sign bit is positive, add the offset to the CC regulation codes. If the sign bit is negative, subtract the offset from the CC regulation codes.

## $\mathbf{I}^{2} \mathbf{C}$ Connection

## uVCC External Power Supply

The uVCC pin provides an accurately regulated 3.6 V supply to an external controller. The maximum load current capability of this supply is 40 mA for 0.5 seconds when the VOUT pin is greater than or equal to 5 V . For steady-state operation, it is expected the current drawn from uVCC is less than 10 mA . The uVCC pin should be decoupled to the GND pin with at least a $2.2 \mu \mathrm{~F}$ ceramic capacitor. When the VOUT pin voltage is less than 3.9 V , the internal LDO will droop and follow VOUT pin voltage. Under these conditions, the uVCC pin voltage is dependent on load current and internal series impedance. At VOUT pin $=3 \mathrm{~V}$ and 6 mA load current on UVCC , the expected output on uVCC will be $3 \mathrm{~V}-\mathrm{R}_{\mathrm{uvcc}}(\Omega) \times 6 \mathrm{~mA}$.

If the VOUT pin voltage falls sufficiently to cause the uVCC pin to go below the uVCCRST threshold, communication through $\mathrm{I}^{2} \mathrm{C}$ is no longer available.

## SCL/SDA Pull-Up Requirements

The SCL and SDA-pins should be pulled-up to the uVCC pin with a resistor. The maximum pull-up resistance is dependent on the capacitance of the SCL/SDA pins and $\mathrm{I}^{2} \mathrm{C}$ Master. The resultant voltage fall-time to the VIL threshold assuming a total capacitance of 20 pF is tabulated as function of SCL clock frequency in the table below.

The InnoSwitch5-Pro part can be used with $\mathrm{I}^{2} \mathrm{C}$ frequency above 535 kHz , however there are specific timing requirements that need to be met as described in the data sheet parameter table and associated notes below the table. Meeting these requirements at frequencies above 535 kHz may require the interface IC to have the ability to produce asymmetrical $\mathrm{I}^{2} \mathrm{C}$ CLK signals. If such ability is not available in the interface IC (or micro-controller connected to the InnoSwitch5-Pro through the $\mathrm{I}^{2} \mathrm{C}$ bus), it is recommended that $\mathrm{I}^{2} \mathrm{C}$ frequency of 535 kHz or lower is used.

| Max Frequency <br> (kHz) | Max Pull-Up <br> Resistance (k $\Omega)$ | $\mathbf{t}_{\mathbf{F}}$ (ns) |
| :---: | :---: | :---: |
| 400 | 13 | 300 |
| 500 | 10 | 240 |
| 600 | 8 | 200 |
| 700 | 7 | 178 |

Table 11. $I^{2} C$ Pull-Up Resistor Values.

## I ${ }^{2}$ C Example Waveforms

## Setting The Output Voltage To 8 V

Same as Example shown in Figure 10.


Figure 24. $I^{2} \mathrm{C}$ Waveforms for Setting Output Voltage to 8 V .

## Reading Telemetry Fault Register After AR Event Caused by Undervoltage



Figure 25. $I^{2} C$ Waveforms for Writing Address of Fault Register READ11 in Read Register (READO) in Order to Read Back READ11.


Figure 26. $\mathrm{I}^{2} \mathrm{C}$ Waveforms for Read Value From READ11 Register.

## InnoSwitch5-Pro

## Applications Example



Flyback Section


Figure 27. Schematic of 140 W USB PD Power Supply using INN5477F InnoSwitch5-Pro.

Circuit shown in Figure 27 is a USB PD 3.1 Extended Power Range (EPR) power supply using InnoSwitch5-Pro INN5477F flyback switcher IC with a PFC stage using PFS5277F IC and Injoinic IP2756 as USB PD controller. It is designed to deliver a nominal power of 140 W and peak power of 280W. The USB PD source capabilities supported are $5 \mathrm{~V} / 5 \mathrm{~A}, 9 \mathrm{~V} / 5 \mathrm{~A}, 15 \mathrm{~V} / 5 \mathrm{~A}, 20 \mathrm{~V} / 5 \mathrm{~A}, 28 \mathrm{~V} / 5 \mathrm{~A}$, and $15 \mathrm{~V}-28 \mathrm{~V}$ / 5A EPR AVS. Peak power capability is $28 \mathrm{~V} / 10 \mathrm{~A}$ for 1 ms at $5 \%$ duty cycle. This USB PD power supply is DOE level 6 and EC CoC v5 compliant.
Input fuse F1 isolates the circuit and provides protection from component failure. Common mode chokes L2, L3 and Y capacitor C1 provide common mode noise filtering, while $X$ capacitor C24, differential choke L1 and capacitors C23, C43 provide differential mode EMI filtering. MOV RV1 is used for surge protection. Bridge rectifiers BR1 and BR2 rectify AC line voltage and provide full wave rectified DC.
One end of the transformer primary is connected to rectified DC bus; other end is connected to the drain terminal of InnoSwitch5-Pro IC. Resistors R9, R12 and R17 provide input voltage sense for under and overvoltage (UV/OV) protection feature. Primary RCD clamp formed by diode D2, capacitor C7, resistors R10, R11, R5, R6 limits the peak drain voltage of INN5477F IC (U2) at the instant of the primary switch turn-off. Energy stored in the leakage inductance of the transformer will be transferred to capacitor C7 and later dissipated primarily across R5 and R6. Resistors R10 and R11 are used to reduce ringing on Drain voltage of U2, when it is turned off and during reverse recovery of diode D2. Due to their damping effect, R10 and R11 help improve EMI performance. TVS diode VR1 is used to limit the peak drain voltage of U2 during abnormal transient events such as ESD or EFT. High-voltage ceramic capacitor C35 is used to decouple the bulk voltage and when placed close to transformer pin connected to positive of bulk capacitor and SOURCE pin of InnoSwitch5-Pro IC, helps reduce the loop area of high frequency switching currents.

The InnoSwitch5-Pro IC operates with either SR zero-voltage switching (SR-ZVS) or quasi-resonant (QR) flyback control-scheme, wherein both methods use variable frequency and variable primary current limit to regulate power delivery to the secondary-side. The power supply can operate in continuous conduction mode (CCM), discontinuous conduction mode (DCM), and critical conduction mode (CRM), providing seamless transition between states. Secondary-side control of both synchronous rectifier gate drive and instant of turn-on of primary-side power switch helps avoid any possibility of cross conduction of the two switches and ensures extremely reliable operation.
In QR mode of operation, SR FET is turned on only once in a switching cycle - during secondary conduction time for both CCM and DCM cycles. For CCM pulses, SR gate drive is turned off just prior to secondary-side commanding a new switching cycle to primary through FluxLink, while for DCM pulses, SR gate drive is turned off when magnitude of voltage drop across SR FET drops below $\mathrm{V}_{\mathrm{SR}(\mathrm{TH)}}$ as defined in this data sheet.
When SR-ZVS mode of operation is enabled, for a CCM pulse, SR FET is turned on at the beginning of secondary conduction time and turned off just before secondary controller commanding a new switching cycle to primary. Therefore, a CCM switching cycle looks exactly alike for QR and SR-ZVS modes. With DCM mode, apart from the usual turn-on and off of SR FET at the beginning and end of secondary conduction time, SR FET is turned on and off for a second time in a switching cycle (referred to as SR-ZVS pulse) just prior to secondary controller requesting for the next primary switch turn-on.

The SR-ZVS pulse ON-time is user programmable through an $\mathrm{I}^{2} \mathrm{C}$ command. Since current through SR FET flows from Drain to Source during this interval, some energy from the output is stored in the
magnetizing inductance. Once the SR-ZVS pulse ON-time elapses, SR FET is turned off and the secondary controller waits for a duration defined by SR-ZVS delay time, which is user programmable, before sending the request for the next primary switch turn-on. During this SR-ZVS delay time, primary magnetizing inductance resonates with switching node capacitance, facilitating ZVS turn-on of primary switch in the subsequent cycle. Full ZVS can be achieved through proper tuning of SR. In SR-ZVS mode, a TVS clamp is required to limit $\mathrm{BV}_{\text {DSs }}$ of the primary device in abnormal operation conditions.
Different input and output voltage cases might require different SR-ZVS ON and delay times to achieve ZVS turn-on of primary to achieve maximum efficiency. Unnecessarily large values of SR-ZVS ON-time might lead to excess negative current in the primary, leading to a drop in efficiency. Similarly, extremely large delay times might lead to primary switch voltage resonating back again from its valley, thereby preventing ZVS turn-on of primary switch. It is advisable to tune the SR-ZVS delay time to be closer to half the time period of resonance ring between magnetizing inductance and switch node capacitance to achieve optimal turn-on. To reduce turn-on loss across SR FET, it is recommended to enable FWD valley switching when SR-ZVS mode is enabled. When QR mode is enabled, it is desirable to turn on the primary switch when FWD voltage is at its peak (primary drain voltage at its valley) to reduce turn on loss.
By default, InnoSwitch5-Pro operates in QR mode of operation. SR-ZVS can be enabled or disabled through $\mathrm{I}^{2} \mathrm{C}$ commands. On disabling SR-ZVS feature, secondary controller would automatically revert to QR mode of operation. It is important to note that when SR-ZVS feature is enabled, secondary controller would implement the SR-ZVS pulse only for DCM cycles. In case of CCM operation, SR-ZVS pulse would not be generated, and therefore, switching cycle would look exactly like the QR mode.
InnoSwitch5-Pro IC is self-starting, using its internal high-voltage current source to charge the BPP pin capacitor C22 when input is first applied. During normal operation, primary-side block is powered from an auxiliary winding on transformer T1. Output of auxiliary (or bias) winding is rectified using diode D5 and filtered using capacitor C21. Linear regulator circuit comprises of BJT Q6, R54, R23 and Zener Diode VR4. This circuit ensures that sufficient current is supplied into BPP pin of InnoSwitch5-Pro IC. By injecting sufficient current into BPP pin, internal current source of U2 is not required to charge C22, thereby reducing no-load power consumption and improving efficiency during normal operation. Current consumption of BPP pin increases with switching frequency. A resistor, if connected in series with VR4 provides positive slope in emitter voltage of BJT Q6 with load, thereby ensuring increasing current supplied into BPP pin as load increases. This improves overall efficiency. The HSD pin is required to be connected to SOURCE pin.

Zener diode ZD2 offers primary sensed output overvoltage protection. In a flyback converter, output of auxiliary winding tracks output voltage of the converter. In case of overvoltage at output of the power supply, auxiliary winding voltage increases and causes breakdown of ZD2. If the current injected into BPP of InnoSwitch5-Pro IC exceeds $\mathrm{I}_{\mathrm{SD}}$ threshold, InnoSwitch5-Pro controller will latch-off the power supply and prevent any further increase in output voltage. Resistor R53 limits current injected into BPP pin when output overvoltage protection is triggered.
Output regulation is achieved using modulation control where frequency and $\mathrm{I}_{\mathrm{LIM}}$ of switching cycles are adjusted based on output load. At higher load, secondary controller requests switching cycles more often, leading to higher $\mathrm{I}_{\text {Lim }}$, while at lighter load or no-load, switching frequency is reduced leading to lower $\mathrm{I}_{\mathrm{LIM}}$ values. In a switching cycle, primary switch remains ON until the primary current ramps to the device current limit for the specific operating state.

Secondary-side of InnoSwitch5-Pro IC has output voltage and current sensing and provides gate drive to a FET for synchronous rectification. Voltage across transformer secondary winding is rectified by secondaryside synchronous rectifier FETs (SR FETs) Q2 and Q3, and filtered by capacitors C3, C5 and C6. C6 $(330 \mu \mathrm{~F})$ is added to support peak power of 280 W . For a power supply with 140 W rated power, C3 and C5 ( $680 \mu \mathrm{~F}$ each) are generally sufficient. High frequency ringing during switching transients that would otherwise create radiated EMI are reduced by the RCD snubber, resistors R4, R55, capacitor C4, and Diode D10. Diode D10 minimizes dissipation across resistors R4 and R55 when capacitor C4 discharges. This RCD snubber also helps reduce voltage stress on SR FETs. TVS diode VR5 is added to limit the peak drain voltage of Q2 and Q3 for peak power operation.

Gates of Q2 and Q3 are driven by the circuit in secondary-side controller inside U2. SR FET Q2 and Q3 are turned on based on the secondary winding voltage sensed by FWD pin of the IC via resistor R15.
Secondary-side of U2 is self-powered from either the secondary winding forward voltage or output voltage. For designs with InnoSwitch5-Pro, especially with 28 V output cases, use of secondary bias winding circuit is strongly suggested to ensure high system efficiency and that secondary-side die temperature remains within acceptable levels. In this design, secondary bias winding voltage is rectified by diode D4 and filtered by capacitor C15. Resistor R13 limits current flowing into BPS pin. In case of designs with higher output voltages ( $>24 \mathrm{~V}$ ), it is suggested to choose a value for R13 such that the secondary bias winding supplies $\sim 7 \mathrm{~mA}$ of current into BPS pin at full load condition with max output voltage. Capacitor C11 connected to the BPS pin of InnoSwitch5-Pro IC provides decoupling for the internal circuitry.
IC U2 monitors output current by sensing the voltage drop across resistor R19. Measurement is then filtered by resistor R21 and capacitor C14, and monitored across the IS and SECONDARY GROUND pins. An internal current sense threshold of up to 32 mV configured by the USB PD controller via $\mathrm{I}^{2} \mathrm{C}$ interface is used to reduce losses. Once the output current threshold is exceeded, the InnoSwitch5-Pro IC responds depending on its configuration to either maintain a fixed output current by using variable frequency and variable primary switch peak current control schemes or to shut down the power supply.

For constant current (CC) operation, when output voltage falls below 5 V , secondary-side controller inside InnoSwitch5-Pro IC will directly power itself from the secondary winding. During on-time of the primary-side power switch, forward voltage that appears across secondary winding is used to charge the SECONDARY BYPASS pin decoupling capacitor C11 via an internal regulator. This allows output current regulation to be maintained down to the minimum value of UV threshold. Below this level, the unit enters auto-restart until output load is reduced.

When output current is below the CC threshold, the converter operates in constant voltage (CV) mode. Output voltage is monitored by the VOUT pin of the InnoSwitch5-Pro IC. Measured output voltage is compared to an internal voltage threshold that is set via the integrated secondary controller of InnoSwitch5-Pro IC and USB PD controller IC. Output voltage regulation is achieved by variable frequency and variable primary switch peak current limit control schemes. Capacitor C44 serves as a decoupling capacitor and is suggested to be placed closer to the VOUT pin.

N-channel MOSFET Q1 functions as the bus switch which connects or disconnects output of the flyback converter from USB Type-C receptacle. MOSFET Q1 is controlled by the VB/D pin on InnoSwitch5-Pro IC. Diode D9 is connected across the Source and Gate terminals of Q1 and resistor R50 is connected from the Gate terminal of Q1 to the VB/D pin. These 2 components provide a discharge path for bus
voltage when Q1 is turned off. Capacitor C2 is used at the output for ESD protection and output voltage ripple reduction.

In this design, Injoinic IP2756 (U1) is used as the USB Type-C and PD controller. Output of InnoSwitch5-Pro IC powers IP2756 device directly from the flyback output voltage VBUS_IN. USB PD protocol is communicated over either CC1 or CC2 line depending on the orientation of Type-C plug.

The IP2756 IC communicates with the InnoSwitch5-Pro IC through the $I^{2} C$ interface using SCL and SDA lines through which it configures the power supply operating parameters such as set points (output voltage CV, constant current CC, cable drop compensation CDC), protection thresholds and responses (output overvoltage OVA / undervoltage UVA), and gathers telemetry status (output voltage, output current). The complete list of available PI Command and Telemetry registers can be found in this data sheet. Capacitor C16 is used as the decoupling capacitor for uVCC pin. U1 monitors output current by sensing the voltage drop across resistor R29 and is filtered by resistor R27 and capacitor C17.

Capacitors C9 and C10 are used as decoupling capacitors on VCC and VIN pins of U1. Resistors R14, R16, R18, R20, TVS diodes TVS1-TVS4 are used to protect CC1, CC2, DP and DM lines from ESD surge events. Capacitors C8 and C13 are used to protect CC1 and CC2.

## Key Application Considerations

## Output Power Table

The data sheet output power table (Table 1) represents the maximum practical continuous output power level that can be obtained under the following conditions:

1. The minimum DC input voltage is 90 V or higher for 85 VAC input, 220 V or higher for 230 VAC input or 115 VAC with a voltage doubler. Voltage rating of the Input capacitor selected should meet the criteria for $A C$ input designs.
2. Efficiency assumptions depend on power level. Smallest device power level assumes efficiency $>88 \%$ increasing to $>93 \%$ for the largest device.
3. Transformer primary inductance tolerance of $\pm 5 \%$.
4. Reflected output voltage (VOR) is set to maintain $\mathrm{K}_{\mathrm{p}} \geq 0.7$ at minimum input voltage for universal line and $K_{p} \geq 1$ for high-line input designs (for thermally constrained environment efficiency should be $>94 \%$ with larger devices). $K_{p} \geq 1.2$ is suggested to utilize the full advantage of SR-ZVS at a given operating condition.
5. Maximum conduction losses for adapters and open frame designs are limited to 0.6 W and 0.8 W respectively.
6. Increased current limit is selected for peak and open frame power columns and standard current limit for adapter columns.
7. The part is board mounted with SOURCE pins soldered to a sufficient area of copper and/or a heat sink to keep the SOURCE pin temperature at or below $110{ }^{\circ} \mathrm{C}$.
8. Ambient temperature of $50^{\circ} \mathrm{C}$ for open frame designs and $40^{\circ} \mathrm{C}$ for sealed adapters.
9. Below a value of $1, \mathrm{~K}_{\mathrm{p}}$ is the ratio of ripple to peak primary current. To prevent reduced power delivery, due to premature termination of switching cycles, a transient $K_{p}$ limit of $\geq 0.25$ is recommended. This prevents the initial current limit $\left(\mathrm{I}_{\mathrm{INT}}\right)$ from being exceeded at switch turn-on.

## Primary-Side Sensed Output Overvoltage Protection

Primary-side sensed output overvoltage protection provided by the InnoSwitch5-Pro IC uses internal protection that is triggered when current into PRIMARY BYPASS pin exceeds the threshold current of $\mathrm{I}_{\mathrm{SD}}$. Protection response in this case is dependent on the feature code of the device, either latch-off or auto-Restart. In addition to serving as an internal filter, the PRIMARY BYPASS filter capacitor provides noise immunity. For the bypass capacitor to be effective as
a high frequency filter, the capacitor should be located as close as possible to the PRIMARY BYPASS and SOURCE pins of the device.

Primary sensed OVP function can be realized by connecting a series combination of Zener diode and resistor from the rectified and filtered bias winding voltage supply to the PRIMARY BYPASS pin. The ratio of rectified and filtered bias winding voltage to winding voltage may be higher or lower than the expected value (between $0.7 x$ to $1.5 x$ the turns ratio). Poor coupling of primary bias winding with secondary winding contributes to lower than expected value, while peak charging of the primary bias winding capacitor leads to higher than expected voltage. The rectified and filtered bias winding voltage is determined by an interplay between the two factors. It is therefore recommended that the rectified bias winding voltage be measured prior to selecting primary bias component values. This measurement should be ideally done at the lowest input voltage and with the highest load at the output. This measured voltage should be used to select the components required to achieve primary sensed OVP. For resistor in the OVP circuit (R53), it is suggested to use 1) $47 \Omega$ OVP resistor and Zener diode in series, or 2 ) $\geq 47 \Omega$ OVP resistor, Zener diode, and general purpose blocking diode in series, oriented to allow current into BPP during OVP event, but prevent BPP capacitor discharge through the OVP circuit.

Zener diode and resistor values must be chosen such that the current drawn by BPP at the target OVP level exceeds minimum limit of BPP pin fault shutdown threshold current $\mathrm{I}_{\mathrm{SD}}$. The Zener diode must not conduct during normal steady-state and transient conditions. So, the clamping voltage of OVP circuit must be higher than the difference between bias capacitor voltage and BPP voltage during those conditions. It is recommended to use a 500 mW rated Zener diode in the OVP circuit.

## Reducing No-Load Consumption

The InnoSwitch-5 Pro IC can start in self-powered mode, drawing energy from the BYPASS pin capacitor charged through an internal current source. To reduce no-load power consumption and to improve overall efficiency at other conditions, use of primary bias winding is suggested to provide supply current to the PRIMARY BYPASS pin, once the InnoSwitch-5 Pro IC has started switching. An auxiliary (bias) winding in the transformer serves this purpose. Bias winding driver supply to the PRIMARY BYPASS pin enables the design of power supplies with low no-load power consumption of less than 30 mW . Resistor R23 shown in Figure 27 should be adjusted to achieve the lowest no-load input power. It is recommended to measure rectified bias winding voltage at max input voltage, 5 V , no-load condition prior to choosing a value for R23.

## Secondary-Side Overvoltage Protection

Secondary-side sensed output overvoltage protection is provided by InnoSwitch5-Pro IC. Users can program the magnitude of over voltage threshold and the type of response through $\mathrm{I}^{2} \mathrm{C}$ commands.

## Selection of Components

Components for InnoSwitch5-Pro Primary-Side Circuit

## BPP Capacitor

A capacitor connected from PRIMARY BYPASS pin of the InnoSwitch5-Pro IC to GND provides decoupling for the primary-side controller, and its value also determines the current limit. A $0.47 \mu \mathrm{~F}$ or $4.7 \mu \mathrm{~F}$ capacitor may be used for Standard and Increased ILIM respectively. Even though electrolytic capacitors can be used; surface mount multi-layer ceramic capacitors are highly preferred for use on double sided boards as they enable placement of capacitors close to the IC and offer lower ESL. Their small size also makes them ideal for compact power supplies. Capacitors rated for at least $10 \mathrm{~V}, 0805$ or larger sizes with X5R or X7R dielectric are recommended to ensure that minimum capacitance requirement is met. Ceramic capacitor type designations, such as $\mathrm{X} 7 \mathrm{R}, \mathrm{X} 5 \mathrm{R}$ from different manufacturers or different product families do not have the same voltage coefficients.

It is recommended that capacitor data sheets be reviewed to ensure that the selected capacitor does not have more than $20 \%$ drop in capacitance at 5 V. Do not use Y5U or Z5U / 0603 rated MLCC as these types of SMD ceramic capacitors have very poor voltage and temperature coefficient characteristics.

## Bias Winding and External Bias Circuit

The internal regulated current source present between DRAIN pin of Primary switch to PRIMARY BYPASS pin of InnoSwitch5-Pro primaryside controller charges the capacitor connected to PRIMARY BYPASS pin to achieve start-up. A bias winding should be provided on the transformer with a suitable rectifier and filter capacitor to create a bias supply that can be used to supply the required current for BPP. turns ratio for bias winding should be selected such that 7 V to 8 V minimum is developed across the capacitor at the highest input voltage and 5 V , no-load output condition. If the voltage across bias winding is lower than this, the bias circuit may not be able to inject sufficient current into BPP, resulting in the turn-on of internal source, leading to increased no-load power consumption.
For designs with a single output voltage, a single resistor regulator circuit might be sufficient. However, in USB PD applications, output voltage range can be very wide - such as 5 V to 28 V in EPR designs. Such a wide output voltage variation results in a large change on primary bias winding voltage. Therefore, for wide output range designs, a linear regulator circuit is generally required to regulate current injected into the PRIMARY BYPASS pin of InnoSwitch5-Pro IC.

Primary bias current from the external circuit during 5 V no-load condition should be set to max of $\mathrm{I}_{51}$ for InnoSwitch5-Pro IC to achieve lowest power consumption. BPP voltage can be used as an indicator of whether the injected BPP current is sufficient. When the BPP voltage reaches $\mathrm{V}_{\text {SHuNT }}$ ( 5.36 V typical), there is enough current externally supplied into BPP. Otherwise, primary controller consumes power from the DRAIN pin using the internal regulated current source, which increases overall power consumption. BPP current required to achieve $\mathrm{V}_{\text {SHunt }}$ is directly proportional to the operating switching frequency and can be interpolated using $\mathrm{I}_{\mathrm{S} 1}$ and $\mathrm{I}_{\mathrm{s} 2}$ parameters from the data sheet.
A glass passivated standard recovery rectifier diode with low junction capacitance is recommended to avoid the snappy recovery typically seen with fast or ultrafast diodes that can lead to higher radiated EMI.
An aluminum capacitor of at least $22 \mu \mathrm{~F}$ with a voltage rating 1.2 times greater than the highest voltage developed across the capacitor is recommended. The highest voltage is typically developed across this capacitor when the supply is operated at the highest rated output voltage and load with the lowest input voltage. For designs with 28 V output, a BJT rated for at least $80 \mathrm{~V}, 500 \mathrm{~mW}$ is recommended.

## Line UV and OV Protection

Resistors connected from the UNDER/OVER INPUT VOLTAGE pin to the DC bus enable sensing of input voltage for line undervoltage and overvoltage protection. For a typical universal input application, 2 or 3 resistors with 1206 packages each of value 1.2 to $2 \mathrm{M} \Omega$ amounting to a total $V$ pin resistance of 3.6 to $4 \mathrm{M} \Omega$ is recommended.
The InnoSwitch5-Pro IC features primary sensed line OV protection that can be used to inhibit further switching cycles when current through V pin exceeds UV/OV Pin Line Overvoltage Threshold ( $\mathrm{I}_{\mathrm{ov}+}$ ) with a deglitch filter $\left(\mathrm{t}_{\mathrm{ovt}}\right)$. Switching resumes when current through $\checkmark$ pin drops below UV/OV Pin Line Overvoltage Recovery Threshold( $\mathrm{I}_{\text {ov }}$ ). A fast AC reset can be achieved using the modified circuit configuration shown in Figure 28. The voltage across capacitor CS reduces rapidly after input supply is disconnected, reducing current into the INPUT VOLTAGE MONITOR pin of InnoSwitch5-Pro IC and resetting the InnoSwitch5-Pro controller. Line UV/OV protection feature can be disabled by shorting V pin to SOURCE pin of InnoSwitch5-Pro IC.

## Primary-Side Clamp

In Figure 27 once primary switch is turned off, leakage energy is transferred to the clamp capacitor C7 through resistors R10 and R11. Later this energy is dissipated as heat across parallel resistors R5 and R6. A glass passivated standard recovery rectifier diode with low junction capacitance is recommended to avoid the snappy recovery typically seen with fast or ultrafast diodes that can lead to higher radiated EMI.

Increasing the value of C7 capacitor helps better clamp the Drain voltage of primary switch. However, it is important to note that this might also lead to a larger loss.
The clamp capacitor voltage rating must be higher than $\mathrm{V}_{\mathrm{OR}}$. Since $\mathrm{V}_{\mathrm{OR}}$ is usually within 135 V to 185 V range for designs with 28 V output, 1206 size capacitors rated for at least 200 V with values in the
range of 1.5 nF to 3.3 nF are typically suitable for the primary RCD clamp circuit. In addition to reducing ringing due to reverse recovery of clamp diode, resistors R10 and R11 help improve EMI performance. Since current with a large initial spike flows through resistors R10 and R11 after primary switch turn-off, it is recommended to use resistors with values in the range of a few tens of ohms and 1206 size for the series clamp resistors. Parallel resistors R5 and R6 dissipate energy stored across clamp capacitor as heat. Even though using low value resistors helps clamp the Drain voltage better, that leads to higher losses. Since the energy dissipated in these resistors is proportional to the square of $\mathrm{I}_{\mathrm{LIM}}$ of the InnoSwitch5-Pro IC, for higher $\mathrm{I}_{\mathrm{LI}}$ devices, especially, it suggested to use 2 or more resistors with 1206 package.
For a 28 V output design with universal AC input, a TVS with reverse stand-off voltage of 200 V and with power rating of 3.3 W or 5 W continuous is typically sufficient.


Figure 28. Fast $A C$ Reset Configuration.

## Components for InnoSwitch5-Pro Secondary-Side Circuit

## SECONDARY BYPASS Pin - Decoupling Capacitor

A $2.2 \mu \mathrm{~F}, 10 \mathrm{~V} / \mathrm{X} 7 \mathrm{R}$ or X5R / 0805 or larger size multi-layer ceramic capacitor should be used for decoupling the SECONDARY BYPASS pin of InnoSwitch5-Pro IC. Since SECONDARY BYPASS pin voltage needs to be 4.5 V before output voltage reaches regulation voltage level, a significantly higher BPS capacitor value could lead to output voltage overshoot during start-up. Values lower than $1.5 \mu \mathrm{~F}$ may not offer enough capacitance and cause unpredictable operation. The capacitor must be located adjacent to the IC pins. At least 10 V rating is recommended for the BPS capacitor to give enough margin from BPS voltage. 0805 size is necessary to guarantee the actual value in operation since the capacitance of ceramic capacitors drops significantly with applied DC voltage especially with small package SMD such as 0603. $6.3 \mathrm{~V} / 0603$ / X5U or Z5U type of MLCCs are not recommended for this reason. Ceramic capacitor type designations, such as $X 7 R, X 5 R$ from different manufacturers or different product families do not have the same voltage coefficients. It is recommended that capacitor data sheets be reviewed to ensure that the selected capacitor will not have more than $20 \%$ drop in capacitance at 4.5 V . Capacitors with X5R or X7R dielectrics should be used for the best results.

When output voltage of the power supply is 5 V or higher, the supply current for the secondary-side controller is provided by the OUTPUT VOLTAGE (VOUT) pin of the IC as the voltage at this pin is higher than the SECONDARY BYPASS pin voltage. During start-up and operating conditions where the output voltage of the power supply is below 5 V , the secondary-side controller is supplied by current from an internal current source connected to the FORWARD pin.
If the power supply operates at higher output voltages, deriving secondary bias supply from $\mathrm{V}_{\text {out }}$ will incur significant losses across the internal linear regulator, leading to increased secondary-side die temperature. A bias winding may be provided from the transformer with suitable rectifier and filter to supply the required current to BPS pin at the highest output voltage. This bias supply may not be able to supply the current required at lower output voltages since it scales with the output and should be greater than $\mathrm{V}_{\text {BPS }}(4.5 \mathrm{~V})$. Ratio of number of secondary bias winding turns to secondary winding turns determines the output voltage beyond which the bias winding current starts supplying current into BPS pin. It is suggested that the value of resistor located between BPS capacitor and secondary bias winding filter capacitor be chosen to ensure that at least 7 mA current flows into BPS pin at 28 V , Full load condition.

## FORWARD Pin Resistor

A $47 \Omega, 5 \%$ resistor is recommended to ensure sufficient IC supply current. A lower resistor value should not be used as it can affect device operation such as timing of synchronous rectifier drive. A higher resistance value up to $1 \mathrm{k} \Omega$ can be used with an optional parallel fast recovery diode to adjust the synchronous rectifier gate drive duty. The diode anode is connected to the transformer winding while the cathode is connected to the FORWARD pin. Figures 29, 30, 31 and 32 show examples of unacceptable and acceptable FORWARD pin voltage waveforms. $V_{D}$ is forward voltage drop across the $S R$.


Figure 29. Unacceptable FORWARD Pin Waveform After Handshake with SR Switch Conduction During Flyback Cycle.


Figure 30. Acceptable FORWARD Pin Waveform After Handshake with SR Switch Conduction During Flyback Cycle.


Figure 31. Unacceptable FORWARD Pin Waveform Before Handshake with Body Diode Conduction During Flyback Cycle


Figure 32. Acceptable FORWARD Pin Waveform Before Handshake with Body Diode Conduction During Flyback Cycle.

## Synchronous Rectifier FET

Although a simple diode rectifier works for the output, use of SR FET enables significant improvement in operating efficiency often necessary to meet the European CoC and the U.S. DoE energy efficiency requirements. SR FET gate should be tied directly to the SYNCHRONOUS RECTIFIER DRIVE pin of the InnoSwitch5-Pro IC (no additional resistors should be connected in the gate circuit of the SR FET). Following a secondary controller takeover after primary-secondary handshake during start-up, the secondary-side controller turns on the SR FET once the flyback cycle begins. The SR FET is turned off once the magnitude of $\mathrm{V}_{\mathrm{DS}}$ of SR FET drops below $\mathrm{V}_{\mathrm{SR}(\mathrm{TH})}$. Once SR FET is turned off, any remaining portion of the flyback cycle is completed with the current commutating through the body diode of SR FET. It is to be noted that the length of the FWD trace involving SR drain pin - FWD resistor - FWD pin determines the duty ratio of SR FET. In case this trace is longer, SR FET might turn off earlier than expected during flyback cycle, leading to undesirable longer diode conduction and therefore, reduction in efficiency. In other cases, where SR FET conducts for a duration little bit longer than secondary conduction time, leading to a negative secondary current, it is recommended to increase the resistance connected to FWD pin (up to $1 \mathrm{k} \Omega$ ) until the desired behavior is observed.

The following table provides a recommendation for the SR FET $\mathrm{R}_{\mathrm{DS}(\mathbf{O N})}$ selection for different designs. For designs rated for 100 W or more, it is recommended to use 2 SR FETs in parallel to reduce effective $\mathrm{R}_{\mathrm{DS}(\mathrm{ON})}$, thereby improving efficiency and reducing SR FET part temperature for the same secondary RMS current.

| Output | FET $\mathbf{R}_{\text {DS(ON })}$ |
| :---: | :---: |
| $20 \mathrm{~V} / 3 \mathrm{~A}$ | $7 \mathrm{~m} \Omega$ |
| $28 \mathrm{~V} / 3 \mathrm{~A}$ and above | $3 \mathrm{~m} \Omega$ or lower |

Table 12. Recommended SR FET $\mathrm{R}_{\mathrm{DS(ON)}}$ for Different Designs.
The SR FET driver uses SECONDARY BYPASS pin for its supply rail, and this voltage is typically 4.5 V . A FET with a high threshold voltage is therefore not suitable; FETs with a threshold voltage of 1.5 V to 2.5 V are ideal although switches with a threshold voltage (absolute maximum) as high as 4 V may be used provided their data sheets specify $\mathrm{R}_{\mathrm{DS}(\mathrm{ON})}$ across temperature for a gate voltage of 4.5 V .

For designs with InnoSwitch5-Pro IC, a Schottky diode across SR FET is generally not necessary. The rise and fall time of the SR FET gate-source voltage is determined by its Gate-Source capacitance and the drive strength of InnoSwitch5-Pro IC. Therefore, these timings would be longer when two SR FETs connected in parallel are used, instead of just one.
The SR FET drain-source voltage rating should have enough margin compared to the expected worst-case peak inverse voltage (PIV) based on the transformer turns ratio, input and output voltages, and SR FET turn-off voltage spike. 120 V rated FETs are suitable for designs with output voltage 20 V and above.

The interaction between the leakage reactance of the output windings and the SR FET capacitance ( $\mathrm{C}_{\text {oss }}$ ) leads to ringing on the voltage waveform at the instance of voltage reversal at the winding due to the primary switch turn-on. This ringing can be suppressed using an RC or RCD snubber connected across the SR FET. A snubber resistance in the range of $5 \Omega$ to $47 \Omega$ may be used (higher values lead to a noticeable drop in efficiency). The number of resistors used, and their device package must be selected such that they can handle the power loss in snubber circuit. A switching diode can also be paralleled with the snubber resistor to minimize its dissipation. An X7R capacitor of value 220 pF to 3.3 nF is adequate for most designs. For higher $\mathrm{I}_{\mathrm{LIM}}$ designs, to reduce SR FET voltage stress during start-up, aside from the SR snubber described above, an RCD clamp is recommended across the secondary winding. In this additional clamp circuit, the anode of diode is connected to SR FET DRAIN pin, followed by a parallel RC circuit connected in series to the diode. 1206 size resistors in the range of $5 \mathrm{k} \Omega$ to $20 \mathrm{k} \Omega$ are recommended along with 1206 size 200 V rated capacitor in the range of 10 nF to 100 nF range.

## Output Capacitor

Low ESR aluminum electrolytic capacitors are suitable for use with most high frequency flyback switching power supplies though the use of aluminum-polymer solid capacitors has gained considerable popularity due to their compact size, stable temperature characteristics, extremely low ESR and high RMS ripple current rating. These capacitors enable the design of ultra-compact chargers and adapters.

Typically, $200 \mu \mathrm{~F}$ to $300 \mu \mathrm{~F}$ of aluminum-polymer capacitance per ampere of output current is adequate. The other factor that influences the choice of capacitance is the output ripple. Ensure that capacitors with a voltage rating higher than the highest output voltage plus sufficient margin is used.

## Output Overload Protection

The maximum power which can be delivered by the power supply is obtained by the product of the programmed $\mathrm{V}_{\mathrm{KP}}$ and the full-scale current limit. For output voltage below the programmed $\mathrm{V}_{\mathrm{Kp}}$ threshold, the InnoSwitch5-Pro IC will limit the output current once the programmed current limit is reached. The full-scale current limit is set by the resistor between the IS and GND pins. A lower value of the current limit can be programmed over $\mathrm{I}^{2} \mathrm{C}$. For any output voltage above the programmed $\mathrm{V}_{\mathrm{KP}}$ threshold, InnoSwitch5-Pro IC will provide a constant power characteristic. An increase in load current within the programmed current limit will result in a drop in output voltage such that the product of output voltage and current equals the maximum power set by the product of $\mathrm{V}_{\mathrm{KP}}$ and the full-scale current limit.

## Decoupling Capacitor on uVCC Pin

It is recommended that at least a $2.2 \mu \mathrm{~F}, \mathrm{X} 7 \mathrm{R}$ ceramic capacitor be placed between the uVCC and GND pins. In case of 28 V output designs where the external micro-controller is powered from uVCC, an optional linear regulator circuit is suggested from the secondary bias winding to uVCC.

## Pull-Up Resistors for SDA and SCL Pins

A $4.7 \mathrm{k} \Omega$ pull-up resistor from each of the SDA and SCL pin to the uVCC pin is recommended for communication at a frequency of 400 kHz . The maximum value of the pull-up resistor is dependent on the capacitance presented by the SDA/SCL lines and the $\mathrm{I}^{2} \mathrm{C}$ master. The resultant voltage rises to the $\mathrm{V}_{\mathrm{IL}}$ threshold assuming a total capacitance of 20 pF is tabulated as a function of SCL clock frequency in Table 11.

## Decoupling Capacitor at VOUT Pin

It is recommended that a X 7 R rated $1 \mu \mathrm{~F}-2.2 \mu \mathrm{~F}$ ceramic capacitor be placed close to the VOUT pin. It is recommended to tie the ground of BPS, uVCC and VOUT pin decoupling capacitors together and located closer to the IC, while having a kelvin connection through a thin trace with power GND to ensure good noise immunity.

## IS to GND Pin Current Sense Resistor

This sense resistor is chosen such that the required full-scale current produces a 32 mV drop across IS and GND pins. A 1\% or lower tolerance resistor is recommended. This sense resistor must have a kelvin connection to the IS pin filter circuit (formed by a $10 \Omega$ resistor and at least $1 \mu \mathrm{~F}$ capacitor) and is preferred to be placed as close as possible to the InnoSwitch5-Pro IC pins for accurate current measurement and CC regulation.

## Output Decoupling Capacitor

A ceramic output decoupling capacitor helps improve ESD performance. This capacitor must be placed as close as possible to output terminals or Type-C connector of the power supply.

## Bus Switch

A low $\mathrm{R}_{\mathrm{DS}(\mathrm{ON})} \mathrm{N}$-channel FET bus switch is recommended to reduce the impact of high load currents on efficiency. The FET need not be a logic level FET. VB/D pin can supply typically 7 V above $\mathrm{V}_{\text {out }}$ so it can sufficiently enhance FETs with gate threshold of 4 V . The FET drain-source voltage rating must have sufficient margin from the maximum output voltage of the power supply. For designs with 28 V output, it is recommended to use FETs rated for at least 40 V .

## Bus Discharge

The resistor value for bus discharge is chosen as per the discharge time requirements to bring down the output voltage at the Type-C connector to 0 V (i.e., when the bus switch needs to be opened), also considering the VB/D pin internal current discharge limit $\mathrm{I}_{\mathrm{B} /(\mathrm{DS})}$ of $50 \mathrm{~mA} .1 \mathrm{k} \Omega$ resistor is recommended for 28 V designs to meet the USB PD discharge time specification and also provide sufficient margin from $\mathrm{I}_{\mathrm{B} /(\mathrm{DS})}$ : A general-purpose diode in series is recommended across the bus switch SOURCE to GATE pins for unidirectional current flow.

## External Controller

An external controller is needed to send the $\mathrm{I}^{2} \mathrm{C}$ commands to the InnoSwitch5-Pro IC over the SDA and SCL lines. For standalone applications, the external controller can get its supply from the uVCC pin of the InnoSwitch5-Pro IC. It should be able to sustain operation for a supply voltage as low as 2.8 V .

## Recommendations for Circuit Board Layout

See Figure 33 and 34 for a recommended circuit board layout for an InnoSwitch5-Pro based power supply.

## Single-Point Grounding

Use a single-point ground connection from the input filter capacitor to the area of copper connected to the SOURCE pins.

## Bypass Capacitors

PRIMARY BYPASS and SECONDARY BYPASS pin capacitor must be located directly adjacent to the PRIMARY BYPASS-SOURCE and SECONDARY BYPASS-SECONDARY GROUND pins respectively and connections to these capacitors should be routed with short traces.

## Primary Loop Area

The area of primary loop that connects input filter capacitor, transformer primary and IC should be kept as small as possible.

## IS to GND pin Capacitor

A $1 \mu \mathrm{~F}$ or higher ceramic capacitor is recommended to be used between the IS and GND pins of the InnoSwitch5-Pro IC for accurate constant current regulation.

## Primary Clamp Circuit

To reduce leakage related voltage stress on Drain of primary switch and EMI, minimize the loop involving clamp components to transformer and Innoswitch5-Pro IC.

## Thermal Considerations

SOURCE pin is internally connected to the IC lead frame and provides the main path to remove heat from the device. Therefore, the SOURCE pin should be connected to a copper area underneath the IC to act not only as a single point ground, but also as a heat sink. As this area is connected to the quiet source node, it can be maximized for good heat sinking without compromising EMI performance. Similarly, for the output SR switch, maximize the PCB area connected to the pins on the package through which heat is dissipated from the SR switch.
Sufficient copper area should be provided on the board to keep IC temperature safely below absolute maximum limits. It is recommended that the copper area provided for copper plane on which the SOURCE pin of the IC is soldered is sufficiently large to keep the IC temperature below $110^{\circ} \mathrm{C}$ when operating the power supply at full rated load and at the lowest rated input AC supply voltage.

## Y Capacitor

The $Y$ capacitor should be placed directly between the primary input filter capacitor positive terminal and the output positive or return
terminal of the transformer secondary. This routes high amplitude common-mode surge currents away from the IC. Note - if an input pi-filter ( $C, L, C$ ) is used as an EMI filter, then the inductor in the filter should be placed between the negative terminals of the input filter capacitors.

## Output SR FET

For best performance, area of the loop connecting secondary winding, output SR FET and output filter capacitor, should be minimized.

## IS-GND Pin, Sense Resistor Traces

It is recommended to have traces from the current sense resistor to IS-GND pins be in a star connection at the respective two nodes of current sense resistor to have an accurate CC set-point. IS-GND sense traces should be at the innermost of the solder pads of current sense resistor to avoid measuring any drop across solder pads of the resistor or load traces coming in and out of the sense resistor.

## uVCC, SDA and SCL Pins

Traces to SDA and SCL pins should be kept away from any noisy node or trace. If possible, a shield trace should be made in parallel to the SDA and SCL traces.

## ESD

Sufficient clearance should be maintained ( $>8 \mathrm{~mm}$ ) between the primary-side and secondary-side circuits to enable easy compliance with any ESD / HIPOT requirements. Spark gap is best placed directly between output positive rail and one of the AC inputs. In this configuration, a 6.2 mm spark gap is often sufficient to meet the creepage and clearance requirements of many applicable safety standards. This is less than the primary to secondary spacing because the voltage across spark gap does not exceed the peak of the $A C$ input.

If there is a controller used for USB PD communication then the Ground of the controller should be connected to the GND pin of the InnoSwitch5-Pro IC and not the GND pin of the type C connector, this helps for ESD performance. However, if there is a separate daughter board connected with the controller IC on it and the Ground path becomes long then the Ground of the controller IC can be connected closer to the USB connector GND pins to help in the eye diagram during USB PD compliance tests.

## Drain Node

Drain switching node is the dominant noise generator. As such, components connected to drain node should be placed close to the IC and away from sensitive feedback circuits. Clamp circuit components should be located physically away from the PRIMARY BYPASS pin and trace lengths minimized.
Area of the loop comprising of the input rectifier filter capacitor, primary winding and the IC primary-side switch should be kept as small as possible.

## Layout Example



Figure 33. PCB Layout Recommendation - Bottom Layer.


Figure 34. PCB Layout Recommendation - Top Layer.

## Recommendations for EMI Reduction

1. Appropriate component placement and small loop areas of the primary and secondary power circuits help minimize radiated and conducted EMI. Care should be taken to achieve a compact loop area.
2. Resistor in series with diode in the primary RCD clamp circuit helps ringing, thereby aiding with EMI.
3. Resistor in series with the primary bias winding helps reduce radiated EMI.
4. Common mode chokes are typically required at the input of the power supply to sufficiently attenuate common mode noise. However, the same performance can be achieved by using shield windings on the transformer. Shield windings can also be used in conjunction with common mode filter inductors at the input to improve conducted and radiated EMI margins.
5. Adjusting SR switch RC snubber component values can help reduce high frequency radiated and conducted EMI.
6. A pi-filter comprising differential inductors and capacitors can be used in the input rectifier circuit to reduce low frequency differential EMI.
7. A $1 \mu \mathrm{~F}$ ceramic capacitor connected at the output of the power supply helps to reduce radiated EMI.

Transformer design must ensure that the power supply delivers rated power at the lowest input voltage. The lowest voltage on the rectified DC bus depends on capacitance of the filter capacitor used. At least $2 \mu \mathrm{~F} / \mathrm{W}$ is recommended to always keep DC bus voltage above 70 V , though $3 \mu \mathrm{~F} / \mathrm{W}$ provides sufficient margin. Ripple on DC bus should be measured to confirm the design calculations for transformer primary-winding inductance selection. PI Expert Online (https://piexpertonline.power.com/) can be used to easily create designs for InnoSwitch5-Pro.

## Switching Frequency ( $f_{s w}$ )

It is a unique feature in InnoSwitch5-Pro IC that for full load, the designer can set the switching frequency to between 50 kHz to 130 kHz . For a smaller transformer, full load switching frequency could be set to 130 kHz . When setting the full load switching frequency it is important to consider primary inductance and peak current tolerances to ensure that average switching frequency does not exceed minimum threshold of overload detection frequency $f_{\text {ovL }}$ to prevent auto-restart.

Table 13 provides a guide for switching frequency selection based on device size. This represents the best compromise between the overall device losses based on the internal high-voltage switch and transformer size.

| Device | Recommended Full Load <br> Switching Frequency |
| :---: | :---: |
| INN5375F | $90-110 \mathrm{kHz}$ |
| INN5377F | $70-90 \mathrm{kHz}$ |
| INN5477F | $60-80 \mathrm{kHz}$ |

Table 13. Recommended Switching Frequency for Different Devices*.

* Higher size devices have lower $\mathrm{R}_{\mathrm{DS}(\mathrm{ON})}$ and larger $\mathrm{I}_{\mathrm{LIM}}$. They are intended for use in higher power applications (>75 W). In accordance with IEC standards, these designs must meet the harmonic current requirements and thus need a power factor correction front end. It is assumed for these designs that the input voltage to the DC-DC section is in the range of $380-400 \mathrm{VDC}$.

Reflected Output Voltage, $\mathbf{V}_{\mathrm{OR}}(\mathbf{V})$
This parameter is the primary winding voltage reflected from the secondary winding (through the transformer turns ratio) during secondary conduction-time. To make full use of ZVS capability and ensure flattest efficiency over line/load, set reflected output voltage $\left(\mathrm{V}_{\mathrm{OR}}\right)$ to maintain $\mathrm{K}_{\mathrm{P}}=0.7$ at minimum input voltage for universal input and $K_{p}=1$ for high-line-only conditions.
Consider the following for design optimization:

1. Higher $\mathrm{V}_{\mathrm{OR}}$ allows increased power delivery at $\mathrm{V}_{\text {MIN }}$, which minimizes the value of the input capacitor and maximizes power delivery from a given InnoSwitch5-Pro device.
2. Higher $\mathrm{V}_{\mathrm{OR}}$ reduces the voltage stress on the output diodes and SR switches.
3. Higher $\mathrm{V}_{\mathrm{oR}}$ increases leakage inductance which reduces power supply efficiency.
4. Higher $\mathrm{V}_{\mathrm{OR}}$ increases peak and RMS current on the secondary-side which may increase secondary-side copper and diode losses.
There are some exceptions to this. For very high output currents, $\mathrm{V}_{\mathrm{OR}}$ should be reduced to get the highest efficiency. For output voltages above $15 \mathrm{~V}, \mathrm{~V}_{\mathrm{OR}}$ should be higher to maintain an acceptable PIV across the output synchronous rectifier.
Ripple to Peak Current Ratio, KP
$K_{p}$ below 1 indicates continuous conduction mode, where $K_{p}$ is the ratio of ripple-current to peak-primary-current (Figure 35).

$$
\mathrm{K}_{\mathrm{P}} \equiv \mathrm{~K}_{\mathrm{RP}}=\mathrm{I}_{\mathrm{R}} / \mathrm{I}_{\mathrm{P}}
$$

$K_{p}$ higher than 1 , indicates discontinuous conduction mode (Figure 36). In this case, $K_{p}$ is the ratio of primary switch off-time to the secondary diode conduction-time.

$$
\begin{aligned}
& \mathrm{K}_{\mathrm{P}} \equiv \mathrm{~K}_{\mathrm{DP}}=(1-\mathrm{D}) \times \mathrm{T} / \mathrm{t}=\mathrm{V}_{\mathrm{OR}} \times\left(1-\mathrm{D}_{\mathrm{MAX}}\right) / \\
&\left(\left(\mathrm{V}_{\mathrm{MIN}}-\mathrm{V}_{\mathrm{DS}}\right) \times \mathrm{D}_{\mathrm{MAX}}\right)
\end{aligned}
$$

It is recommended that $K_{p} \geq 0.7$ at the minimum expected $D C$ bus voltage be used for InnoSwitch5-Pro designs. Since SR-ZVS with the InnoSwitch5-Pro IC ensures ZVS turn-on of primary switch only DCM cycles (i.e. $K_{p} \geq 1$ ), it is recommended that designs completely operate in DCM at high-line input. Ensuring this also ensures lower SR FET voltage stress. In case of SR-ZVS operation, $\mathrm{K}_{\mathrm{p}} \geq 1.2$, at least at high-line, is suggested to utilize the full advantage of this feature and thereby achieve ZVS turn-on.

For a typical USB PD and rapid charge designs which require a wide output voltage range, $\mathrm{K}_{\mathrm{p}}$ will change significantly as the output voltage changes. $\mathrm{K}_{\mathrm{p}}$ will be high for high output voltage conditions and will drop as the output voltage is lowered. PIXIs spreadsheet can be used to effectively optimize selection of $K_{p}$, inductance of primary winding, transformer turns ratio, and operating frequency while ensuring appropriate design margins.

## Core Type

Choice of a suitable core is dependent on the physical limits of the power supply enclosure. It is recommended that only cores with low loss be used to reduce thermal challenges.

## Safety Margin, M (mm)

For designs that require safety isolation between primary and secondary that do not use triple insulated wire, width of the safety margin to be used on each side of the bobbin is important. For universal input designs, a total margin of 6.2 mm is typically required -3.1 mm being used on either side of the winding. For vertical bobbins, margin may not be symmetrical. However, if a total margin of 6.2 mm is required then the physical margin can be placed on only one side of the bobbin. For designs using triple insulated wire it may still be necessary to add a small margin to meet required creepage distances. Many bobbins exist for every core size, each with different

## InnoSwitch5-Pro

mechanical spacings. Refer to the bobbin data sheet or seek guidance to determine what specific margin is required. As margin reduces, available area for windings, winding area will disproportionately reduce for small core sizes. It is recommended that for compact
power supply designs using an InnoSwitch5-Pro IC, triple insulated wire should be used for the secondary windings which then eliminates the need for margins.

$$
K_{P} \equiv K_{R P}=\frac{\mathbf{I}_{R}}{\mathbf{I}_{\mathbf{P}}}
$$

Primary

(a) Continuous, $\mathrm{K}_{\mathrm{P}}<1$

Primary

(b) Borderline Continuous/Discontinuous, $K_{P}=1$

Figure 35. Continuous Conduction Mode Current Waveform $K_{p} \leq 1$. SR-ZVS Mode will Automatically be Disabled for CCM Cycles.


Figure 36. Discontinuous Conduction Mode Current Waveform at High-Line, $K_{p}>1 . S R-Z V S$ On and Delay Times are Included in the Primary Off Duration.

## Primary Layers, L

Primary layers should be in the range of $1 \leq \mathrm{L} \leq 3$ and in general should be the lowest number that meets the primary current density limit (CMA). A value of $\geq 200$ Cmils / Amp can be used as a starting point for most designs. Higher values may be required due to thermal constraints. It is recommended to minimize leakage inductance to reduce primary switch voltage stress. Designs with more than 3 layers are possible, but the increased leakage inductance and the physical fit of the windings within the bobbin might be constraining factors that need be carefully considered.

## Maximum Operating Flux Density, $\mathbf{B}_{\mathbf{M}}$ (gauss)

A maximum value of 3800 gauss at the peak device current limit (at 180 kHz ) is recommended to limit the peak flux density during worst-case output transient and output short-circuit conditions. Under these conditions the output voltage is low and little reset of the transformer occurs during the switch off-time. This allows transformer flux density to staircase beyond the normal operating level. A value of 3800 gauss at the peak current limit of the selected device together with the built-in protection features of InnoSwitch5-Pro IC provide sufficient margin to prevent core saturation under start-up or output short circuit conditions.
Transformer Primary Inductance, (LP)
Once the lowest operating input voltage, switching frequency at full load, and required $V_{O R}$ are determined, the transformers primary inductance can be calculated. The PIXIs design spreadsheet can be used to assist in designing the transformer.

## Quick Design Checklist

As with any power supply, the operation of all InnoSwitch5-Pro designs should be verified on the bench to make sure that component limits are not exceeded under worst-case conditions.

As a minimum, the following tests are strongly recommended:

1. Maximum Drain Voltage - Verify that $\mathrm{V}_{\mathrm{DS}}$ of InnoSwitch5-Pro IC and SR FET do not exceed $90 \%$ of breakdown voltages at the highest input voltage and peak (overload) output power in normal operation and during start-up.
2. Maximum Drain Current - At maximum ambient temperature, maximum input voltage and peak output (overload) power. Review drain current waveforms for any signs of transformer saturation or excessive leading-edge current spikes at start-up. Repeat tests under steady-state conditions and verify that the leading edge current spike is below $\mathrm{I}_{\text {Limitimin) }}$ at the end of $\mathrm{t}_{\text {LEB(MiN) }}$. Under all conditions, the maximum drain current for the primary switch should be below the specified absolute maximum ratings.
3. Thermal Check - At specified maximum output power, minimum input voltage and maximum ambient temperature, verify that temperature specification limits for InnoSwitch5-Pro IC, transformer, output SR FET, and output capacitors are not exceeded. Enough thermal margin should be allowed for part-to-part variation of the $\mathrm{R}_{\mathrm{DS}(\mathrm{ON})}$ of the InnoSwitch5-Pro IC.
4. Under low-line, maximum power, a maximum InnoSwitch5-Pro SOURCE pin temperature of $110^{\circ} \mathrm{C}$ is recommended to allow for these variation.

## Design Considerations When Using PowiGaN Devices

For a flyback converter configuration, typical voltage waveform at the DRAIN pin of the IC is shown in Figure 37.
$\mathrm{V}_{\mathrm{OR}}$ is the reflected output voltage across the primary winding when the secondary is conducting. $\mathrm{V}_{\text {Bus }}$ is the DC voltage connected to one end of the transformer primary winding. The peak drain voltage of the primary switch is the total of $V_{\text {BUS }}$ and $V_{O R}$. $V_{O R}$ and the clamp voltage $\mathrm{V}_{\text {cLM }}$ should be selected such that the peak drain voltage is lower than 650 V for all normal operating conditions. This provides sufficient margin to ensure that occasional increase in voltage during line transients such as line surges will maintain the peak drain voltage well below 750 V under abnormal transient operating conditions. This ensures excellent long-term reliability and design margin.
To make full use of ZVS capability and ensure flattest efficiency over line/load, set reflected output voltage $\left(\mathrm{V}_{\mathrm{OR}}\right)$ to maintain $\mathrm{K}_{\mathrm{p}}=0.7$ at minimum input voltage for universal input and $K_{p} \geq 1$ for high-lineonly conditions.
Consider the following for design optimization:

1. Higher $\mathrm{V}_{\mathrm{OR}}$ allows increased power delivery at $\mathrm{V}_{\text {MIN }}$, which minimizes the value of the input capacitor and maximizes power delivery from a given PowiGaN device.
2. Higher $\mathrm{V}_{\mathrm{OR}}$ reduces the voltage stress on the output diodes and SR FETs.

Higher $\mathrm{V}_{\mathrm{OR}}$ increases peak and RMS current on the secondary-side which may increase secondary-side copper and diode losses.


Figure 37. Peak Drain Voltage for 264 VAC Input Voltage.

There are some exceptions to this. For very high output currents the $\mathrm{V}_{\mathrm{OR}}$ should be reduced to get the highest efficiency. For output voltages above $15 \mathrm{~V}, \mathrm{~V}_{\mathrm{OR}}$ should be maintained higher to maintain an acceptable PIV across the output synchronous rectifier. $\mathrm{V}_{\mathrm{OR}}$ choice will affect operating efficiency and should be selected carefully.

Table 14 shows the typical range of $\mathrm{V}_{\mathrm{OR}}$ for optimal performance:

| Output Voltage | Optimal Range for $\mathbf{V}_{\mathbf{O R}}$ |
| :---: | :---: |
| 5 V | $45-70$ |
| 12 V | $80-120$ |
| 15 V | $100-135$ |
| 20 V | $120-160$ |
| 28 V | $135-180$ |

Table 14. Recommended $\mathrm{V}_{\mathrm{OR}}$ for Optimal Performance.

Absolute Maximum Ratings ${ }^{1,2}$

| Absolute Maximum Ratings ${ }^{\mathbf{1}}$ |
| :---: |
| DRAIN Pin Voltage ${ }^{6}$ :PowiGaN device INN537xF.......... -0.3 V to 750 V  <br> PowiGaN device INN547xF........ -0.3 V to 750 V  <br>  PowiGaN device INN5x96F........ -0.3 V to 900 V 9 |
|  |  |
|  |  |
|  |
|  |
| PowiGaN device INN5x77F................ $26 \mathrm{~A}^{7}$ |
| PowiGaN device INN5396F ............... $19 \mathrm{~A}^{7}$ |
| PowiGaN device INN5496F ............... $19 A^{7}$ |
| BPP/BPS Pin Voltage .................................................-0.3 to 6 V |
| BPP/BPS Pin Current .................................................... 100 mA |
| SCL, SDA, uVCC Pin Voltage $\qquad$ -0.3 to 6 V uVCC Pin Current ${ }^{5}$ $\qquad$ 12 mA |
|  |  |
|  |
| SR Pin Voltage .....................................................-0.3 V to 6 V |
| V Pin Voltage .................................................... 0.3 V to 650 V |
| VOUT Pin Voltage .................................................-0.3 V to 34 V |
| VB/D Pin Current .......................................................... 50 mA |
| VB/D Pin Voltage .................................................. 0.3 V to 40 V |
| IS Pin Voltage ...................................................-0.3 V to $0.3 \mathrm{~V}^{8}$ |
| Storage Temperature ............................................-65 to $150^{\circ} \mathrm{C}$ |
| Operating Junction Temperature ${ }^{3}$............................. 40 to $150{ }^{\circ} \mathrm{C}$ |
| Ambient Temperature ........................................... 40 to $105{ }^{\circ} \mathrm{C}$ |
|  |

DRAIN Pin Voltage ${ }^{6}$ : PowiGaN device INN537xF.......... -0.3 V to 750 V
PowiGaN device INN547xF........ 0.3 V to 750 V
PowiGaN device INN5x96F......... 0.3 V to $900 \mathrm{~V}^{9}$
DRAIN Pin Peak Current: PowiGaN device INN5x75F.................. 14 A $^{7}$
PowiGaN device INN5x76F.................. $19 A^{7}$
PowiGaN device INN5x77F.................. $26 A^{7}$
PowiGaN device INN5396F ................. $19 A^{7}$
PowiGaN device INN5496F ................. $19 \mathrm{~A}^{7}$
BPP/BPS Pin Voltage .......................................................-0.3 to 6 V
BPP/BPS Pin Current ............................................................................................ 100 mA to 6 V
uVCC Pin Current ${ }^{5}$................................................................ 12 mA
FWD Pin Voltage .................................................... -1.5 V to 150 V
SR Pin Voltage ...........................................................-0.3 V to 6 V
V Pin Voltage ........................................................ 0.3 V to 650 V
in Voltage
.......... 50 mA
VB/D Pin Voltage .......................................................-0.3 V to 40 V
IS Pin Voltage .........................................................-0.3 V to $0.3 \mathrm{~V}^{8}$
Storage Temperature ................................................... 65 to $150{ }^{\circ} \mathrm{C}$
Ambient Temperature ................................................-40 to $105^{\circ} \mathrm{C}$
Lead Temperature ${ }^{4}$.............................................................. $260^{\circ} \mathrm{C}$

## Thermal Resistance

Thermal Resistance: INN5x75F

| $\left(\theta_{\text {JA }}\right)$........ | . $70{ }^{\circ} \mathrm{C} / \mathrm{W}^{2}, 64^{\circ} \mathrm{C} / \mathrm{W}^{3}$ |
| :---: | :---: |
| $\left(\theta_{\text {Jc }}\right)$.. | ........... $21^{\circ} \mathrm{C} / \mathrm{W}^{1}$ |
| INN5x77F |  |
| $\left(\theta_{\text {JA }}\right)$.. | . $55^{\circ} \mathrm{C} / \mathrm{W}^{2}, 51^{\circ} \mathrm{C} / \mathrm{W}^{3}$ |
| $\left(\theta_{\text {Jc }}\right)$ | ............ $16^{\circ} \mathrm{C} / \mathrm{W}^{1}$ |
| INN5x96F |  |
| $\left(\theta_{\text {JA }}\right)$ | . $71{ }^{\circ} \mathrm{C} / \mathrm{W}^{2}, 66^{\circ} \mathrm{C} / \mathrm{W}^{3}$ |
| $\left(\theta_{\mathrm{JC}}\right) .$. | ...... $25^{\circ} \mathrm{C} / \mathrm{W}^{1}$ |

## Notes:

1. All voltages referenced to SOURCE and Secondary GROUND, $T_{A}=25^{\circ} \mathrm{C}$.
2. Maximum ratings specified may be applied one at a time without causing permanent damage to the product. Exposure to Absolute Maximum Ratings conditions for extended periods of time may affect product reliability.
3. Normally limited by internal circuitry.
4. $1 / 16^{\prime \prime}$ from case for 5 seconds.
5. Only at 5 V output, the uVCC pin can supply 40 mA maximum current for 0.5 seconds.
6. PowiGaN devices: INN5x7xF

Maximum drain voltage (non-repetitive pulse); for derating calculation ........................................................... 0.3 V to 750 V. Maximum continuous drain voltage ......................... 0.3 V to 650 V .
7. Please refer to Figure 42 for maximum allowable voltage and current combinations.
8. Absolute maximum voltage for less that $500 \mu \mathrm{~s}$ is 3 V .
9. PowiGaN devices: INN5×96F

Maximum continuous drain voltage
-0.3 to 725 V .
Maximum drain voltage (non repetitive pulse)........ -0.3 to 900 V .

## Notes:

1. The case temperature is measured on the top of the package.
2. Soldered to 0.36 sq. inch ( 232 mm 2 ), 2 oz . ( $610 \mathrm{~g} / \mathrm{m} 2$ ) copper clad.
3. Soldered to 1.0 sq . inch $(645 \mathrm{~mm} 2), 2 \mathrm{oz}$. $(610 \mathrm{~g} / \mathrm{m} 2)$ copper clad.

| Parameter | Symbol | Conditions SOURCE $=0 \mathrm{~V}$ $\mathrm{T}_{\mathrm{J}}=-40^{\circ} \mathrm{C}$ to $125^{\circ} \mathrm{C}$ (Unless Otherwise Specified) |  | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Control Functions |  |  |  |  |  |  |  |
| Start-Up Switching Frequency | $\mathrm{f}_{\text {sw }}$ | $\mathrm{T}_{\mathrm{j}}=25^{\circ} \mathrm{C}$ |  |  | 25 | 27 | kHz |
| Jitter Modulation Frequency | $\mathrm{f}_{\mathrm{M}}$ | $\begin{gathered} \mathrm{T}_{\mathrm{J}}=25^{\circ} \mathrm{C}, \\ \mathrm{f}_{\mathrm{sw}}=100 \mathrm{kHz} \end{gathered}$ |  |  | 1.25 |  | kHz |
| Maximum On-Time | $\mathrm{t}_{\text {ON(MAX) }}$ | $\mathrm{T}_{\mathrm{j}}=25^{\circ} \mathrm{C}$ |  |  | 16.5 |  | $\mu \mathrm{S}$ |
| BPP Supply Current | $\mathrm{I}_{51}$ | $\begin{gathered} \mathrm{V}_{\text {Bpp }}=\mathrm{V}_{\text {BPP }}+0.1 \mathrm{~V} \\ \text { (Switch not Switching) } \\ \mathrm{T}_{\mathrm{j}}=25^{\circ} \mathrm{C} \end{gathered}$ |  |  | 300 | 460 | $\mu \mathrm{A}$ |
|  | $\mathrm{I}_{\text {S2 }}$ | $V_{B P P}=V_{B P P}+0.1 \mathrm{~V}$ <br> (Switch Switching at 180 kHz ) $\mathrm{T}_{\mathrm{j}}=25^{\circ} \mathrm{C}$ | INN5375F |  | 3.2 | 3.7 | mA |
|  |  |  | INN5376F |  | 4.29 | 5.15 |  |
|  |  |  | INN5377F |  | 4.3 | 5.16 |  |
|  |  |  | INN5396F |  | 4.38 |  |  |
|  |  |  | INN5475F |  | 2.96 | 3.55 |  |
|  |  |  | INN5476F |  | 4.2 | 5.04 |  |
|  |  |  | INN5477F |  | 4.29 | 5.15 |  |
|  |  |  | INN5496F |  | 4.36 |  |  |
| BPP Pin Charge Current | $\mathrm{I}_{\mathrm{CH} 1}$ | $\mathrm{V}_{\mathrm{BP}}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{j}}=25^{\circ} \mathrm{C}$ |  |  | -1.35 |  | mA |
|  | $\mathrm{I}_{\mathrm{CH} 2}$ | $\mathrm{V}_{\mathrm{BP}}=4 \mathrm{~V}, \mathrm{~T}_{\mathrm{j}}=25^{\circ} \mathrm{C}$ |  |  | -4.65 |  |  |
| BPP Pin Voltage | $\mathrm{V}_{\text {BPP }}$ | $\mathrm{T}_{\mathrm{j}}=25^{\circ} \mathrm{C}$ |  | 4.8 | 5.00 | 5.16 | V |
| BPP Pin Voltage Hysteresis | $\mathrm{V}_{\text {BPP(H) }}$ | $\mathrm{T}_{\mathrm{j}}=25^{\circ} \mathrm{C}$ |  |  | 0.5 |  | V |
| BPP Shunt Voltage | $\mathrm{V}_{\text {SHuNT }}$ | $\begin{aligned} & \mathrm{I}_{\mathrm{BPP}}=2 \mathrm{~mA} \\ & \mathrm{~T}_{\mathrm{J}}=25^{\circ} \mathrm{C} \end{aligned}$ |  | 5.16 | 5.36 | 5.7 | V |
| UV/OV Pin Brown-In Threshold | $\mathrm{I}_{\mathrm{uv}+}$ | $\mathrm{T}_{\mathrm{j}}=25^{\circ} \mathrm{C}$ |  | 23.1 | 25.2 | 27.5 | $\mu \mathrm{A}$ |
| UV/OV Pin Brown-Out Threshold | $\mathrm{I}_{\text {uv- }}$ | $\mathrm{T}_{\mathrm{j}}=25^{\circ} \mathrm{C}$ |  | 20.5 | 23 | 25 | $\mu \mathrm{A}$ |
| Brown-Out Delay Time | $\mathrm{t}_{\text {uv- }}$ | $\mathrm{T}_{\mathrm{j}}=25^{\circ} \mathrm{C}$ |  |  | 35 |  | ms |
| UV/OV Pin Line Overvoltage Threshold | $\mathrm{I}_{\text {ov }+}$ | $\mathrm{T}_{\mathrm{j}}=25^{\circ} \mathrm{C}$ |  | 106 | 115 | 118 | $\mu \mathrm{A}$ |
| UV/OV Pin Line Overvoltage Hysteresis | $\mathrm{I}_{\text {ov(H) }}$ | $\mathrm{T}_{\mathrm{j}}=25^{\circ} \mathrm{C}$ |  |  | 8 |  | $\mu \mathrm{A}$ |
| UV/OV Pin Line Overvoltage Recovery Threshold | $\mathrm{I}_{\text {ov- }}$ | $\mathrm{T}_{\mathrm{j}}=25^{\circ} \mathrm{C}$ |  | 100 | 107 |  | $\mu \mathrm{A}$ |
| Line Fault Protection |  |  |  |  |  |  |  |
| VOLTAGE Pin Line Overvoltage Deglitch Filter | $\mathrm{t}_{\text {ov }+}$ | $\mathrm{T}_{\mathrm{j}}=25^{\circ} \mathrm{C}$ <br> See Note B |  |  | 3 |  | $\mu \mathrm{S}$ |


| Parameter | Symbol | $\begin{gathered} \text { Conditions } \\ \text { SOURCE }=0 \mathrm{~V} \\ \mathrm{~T}_{3}=-40^{\circ} \mathrm{C} \text { to } 125^{\circ} \mathrm{C} \\ \text { (Unless Otherwise Specified) } \end{gathered}$ |  | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Circuit Protection |  |  |  |  |  |  |  |
| Standard Current Limit (BPP) Capacitor = $0.47 \mu \mathrm{~F}$ | $\begin{gathered} \mathrm{I}_{\text {LIMIT }} \\ \text { (Switching } \\ \text { at } 100 \mathrm{kHz}) \end{gathered}$ | $\begin{gathered} \mathrm{di} / \mathrm{dt}=500 \mathrm{~mA} / \mu \mathrm{s} \\ \mathrm{~T}_{\mathrm{J}}=25^{\circ} \mathrm{C} \end{gathered}$ | INN5375F | 2139 | 2300 | 2461 | mA |
|  |  | $\begin{gathered} \mathrm{di} / \mathrm{dt}=660 \mathrm{~mA} / \mu \mathrm{s} \\ \mathrm{~T}_{\mathrm{J}}=25^{\circ} \mathrm{C} \end{gathered}$ | INN5376F | 2697 | 2900 | 3103 |  |
|  |  | $\begin{gathered} \text { di } / \mathrm{dt}=770 \mathrm{~mA} / \mu \mathrm{s} \\ \mathrm{~T}_{\mathrm{J}}=25^{\circ} \mathrm{C} \end{gathered}$ | INN5377F | 3162 | 3400 | 3638 |  |
|  |  | $\begin{gathered} \text { di } / \mathrm{dt}=660 \mathrm{~mA} / \mu \mathrm{s} \\ \mathrm{~T}_{\mathrm{j}}=25^{\circ} \mathrm{C} \end{gathered}$ | INN5396 |  | 2900 |  |  |
|  |  | $\begin{gathered} \text { di } / \mathrm{dt}=1300 \mathrm{~mA} / \mu \mathrm{s} \\ \mathrm{~T}_{\mathrm{j}}=25^{\circ} \mathrm{C} \end{gathered}$ | INN5475F | 3534 | 3800 | 4066 |  |
|  |  | $\begin{gathered} \mathrm{d} / \mathrm{dt}=1600 \mathrm{~mA} / \mu \mathrm{s} \\ \mathrm{~T}_{\mathrm{j}}=25^{\circ} \mathrm{C} \end{gathered}$ | INN5476F | 3906 | 4200 | 4494 |  |
|  |  | $\begin{gathered} \text { di/dt }=1700 \mathrm{~mA} / \mu \mathrm{s} \\ \mathrm{~T}_{\mathrm{j}}=25^{\circ} \mathrm{C} \end{gathered}$ | INN5477F | 4278 | 4600 | 4922 |  |
|  |  | $\begin{gathered} \mathrm{d} / \mathrm{dt}=1600 \mathrm{~mA} / \mu \mathrm{s} \\ \mathrm{~T}_{\mathrm{j}}=25^{\circ} \mathrm{C} \end{gathered}$ | INN5496F |  | 4200 |  |  |
| Increased Current Limit (BPP) Capacitor = $4.7 \mu \mathrm{~F}$ | $\begin{gathered} \mathrm{I}_{\text {Lumirti }} \\ \text { (Switching } \\ \text { at } 100 \mathrm{kHz} \text { ) } \end{gathered}$ | $\begin{gathered} \mathrm{di} / \mathrm{dt}=500 \mathrm{~mA} / \mu \mathrm{s} \\ \mathrm{~T}_{\mathrm{J}}=25^{\circ} \mathrm{C} \end{gathered}$ | INN5375F | 2374 | 2580 | 2786 | mA |
|  |  | $\begin{gathered} \text { di } / \mathrm{dtt}=660 \mathrm{~mA} / \mathrm{\mu s} \\ \mathrm{~T}_{\mathrm{J}}=25^{\circ} \mathrm{C} \end{gathered}$ | INN5376F | 2990 | 3250 | 3510 |  |
|  |  | $\begin{gathered} \text { di/dt }=770 \mathrm{~mA} / \mathrm{\mu s} \\ \mathrm{~T}_{\mathrm{J}}=25^{\circ} \mathrm{C} \end{gathered}$ | INN5377F | 3505 | 3810 | 4115 |  |
|  |  | $\begin{gathered} \mathrm{di} / \mathrm{dt}=660 \mathrm{~mA} / \mathrm{\mu s} \\ \mathrm{~T}_{\mathrm{J}}=255^{\circ} \mathrm{C} \end{gathered}$ | INN5396F |  | 3250 |  |  |
|  |  | $\begin{gathered} \text { di } / \mathrm{dt}=1300 \mathrm{~mA} / \mu \mathrm{s} \\ \mathrm{~T}_{\mathrm{j}}=25^{\circ} \mathrm{C} \end{gathered}$ | INN5475F | 3919 | 4260 | 4601 |  |
|  |  | $\begin{gathered} \mathrm{di} / \mathrm{dt}=1600 \mathrm{~mA} / \mathrm{\mu s} \\ \mathrm{~T}_{\mathrm{J}}=25^{\circ} \mathrm{C} \end{gathered}$ | INN5476F | 4324 | 4700 | 5076 |  |
|  |  | $\begin{gathered} \mathrm{d} / \mathrm{dt}=1700 \mathrm{~mA} / \mu \mathrm{s} \\ \mathrm{~T}_{\mathrm{j}}=25^{\circ} \mathrm{C} \end{gathered}$ | INN5477F | 4738 | 5150 | 5562 |  |
|  |  | $\begin{gathered} \mathrm{d} / \mathrm{dt}=1600 \mathrm{~mA} / \mathrm{Ms} \\ \mathrm{~T}_{\mathrm{J}}=25^{\circ} \mathrm{C} \end{gathered}$ | INN5496F |  | 4700 |  |  |
| Overload Detection Frequency | fov | $\mathrm{T}_{3}=25^{\circ} \mathrm{C}$ |  | 148 | 155 | 161 | kHz |
| BYPASS Pin Latching Shutdown Threshold Current | $\mathrm{I}_{\text {SD }}$ | $\mathrm{T}_{\mathrm{j}}=25^{\circ} \mathrm{C}$ |  | 6.0 | 7.5 |  | mA |
| Auto-Restart On-Time | $\mathrm{t}_{\text {AR }}$ | $\mathrm{T}_{\mathrm{J}}=25^{\circ} \mathrm{C}$ |  |  | 82 |  | ms |
| Auto-Restart Trigger Skip Time | $\mathrm{t}_{\text {ARSK) }}$ | $\begin{aligned} & T_{J_{1}}=25^{\circ} \mathrm{C} \\ & \text { See Note A } \end{aligned}$ |  |  | 1.3 |  | sec |
| Auto-Restart Off-Time | $\mathrm{t}_{\text {AR(OFF) }}$ | $\mathrm{T}_{\mathrm{J}}=25^{\circ} \mathrm{C}$ |  |  | 2.00 |  | sec |
| Short Auto-Restart Off-Time | $\mathrm{t}_{\text {AR(OFF)SH }}$ | $\mathrm{T}_{\mathrm{j}}=25^{\circ} \mathrm{C}$ |  |  | 0.20 |  | sec |


| Parameter | Symbol | $\begin{gathered} \text { Conditions } \\ \text { SOURCE }=0 \mathrm{~V} \\ \mathrm{~T}_{\mathrm{J}}=-40^{\circ} \mathrm{C} \text { to } 125^{\circ} \mathrm{C} \\ \text { (Unless Otherwise Specified) } \end{gathered}$ |  | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Output |  |  |  |  |  |  |  |
| ON-State Resistance | $\mathrm{R}_{\text {os(on) }}$ | inN5375F$\mathrm{I}_{\mathrm{D}}=\mathrm{I}_{\mathrm{LMIT+1}}$ | $\mathrm{T}_{\mathrm{j}}=25^{\circ} \mathrm{C}$ |  | 0.29 | 0.39 | $\Omega$ |
|  |  |  | $\mathrm{T}_{\mathrm{j}}=100^{\circ} \mathrm{C}$ |  | 0.41 | 0.54 |  |
|  |  | $\begin{aligned} & \text { INN5376F } \\ & \mathrm{I}_{\mathrm{D}}=\mathrm{I}_{\text {LIMIT+1 }} \end{aligned}$ | $\mathrm{T}_{\mathrm{j}}=25^{\circ} \mathrm{C}$ |  | 0.18 | 0.28 |  |
|  |  |  | $\mathrm{T}_{\mathrm{j}}=100^{\circ} \mathrm{C}$ |  | 0.27 | 0.37 |  |
|  |  | $\begin{aligned} & \text { INN5377F } \\ & \mathrm{I}_{\mathrm{D}}=\mathrm{I}_{\text {LluTr }} \end{aligned}$ | $\mathrm{T}_{\mathrm{j}}=25^{\circ} \mathrm{C}$ |  | 0.145 | 0.21 |  |
|  |  |  | $\mathrm{T}_{\mathrm{j}}=100^{\circ} \mathrm{C}$ |  | 0.23 | 0.29 |  |
|  |  | INN5396F$\mathrm{I}_{\mathrm{D}}=\mathrm{I}_{\mathrm{LIMTIT}+1}$ | $\mathrm{T}_{\mathrm{J}}=25^{\circ} \mathrm{C}$ |  | 0.21 |  |  |
|  |  |  | $\mathrm{T}_{\mathrm{j}}=100^{\circ} \mathrm{C}$ |  | 0.32 |  |  |
|  |  | $\begin{aligned} & \text { INN5475F } \\ & \mathrm{I}_{\mathrm{D}}=\mathrm{I}_{\mathrm{LIMTIT}} \end{aligned}$ | $\mathrm{T}_{\mathrm{J}}=25^{\circ} \mathrm{C}$ |  | 0.29 | 0.39 |  |
|  |  |  | $\mathrm{T}_{\mathrm{j}}=100^{\circ} \mathrm{C}$ |  | 0.41 | 0.54 |  |
|  |  | INN5476F$\mathrm{I}_{\mathrm{D}}=\mathrm{I}_{\mathrm{LumTr}}$ | $\mathrm{T}_{\mathrm{J}}=25^{\circ} \mathrm{C}$ |  | 0.18 | 0.28 |  |
|  |  |  | $\mathrm{T}_{\mathrm{j}}=100^{\circ} \mathrm{C}$ |  | 0.27 | 0.37 |  |
|  |  | $\begin{aligned} & \text { INN5477F } \\ & \mathrm{I}_{\mathrm{D}}=\mathrm{I}_{\text {LIMIT+1 }} \end{aligned}$ | $\mathrm{T}_{\mathrm{J}}=25^{\circ} \mathrm{C}$ |  | 0.145 | 0.21 |  |
|  |  |  | $\mathrm{T}_{\mathrm{j}}=100^{\circ} \mathrm{C}$ |  | 0.23 | 0.29 |  |
|  |  | $\begin{aligned} & \text { INN5496F } \\ & I_{D}=I_{\text {LIMIT+1 }} \end{aligned}$ | $\mathrm{T}_{\mathrm{j}}=25^{\circ} \mathrm{C}$ |  | 0.21 |  |  |
|  |  |  | $\mathrm{T}_{\mathrm{j}}=10{ }^{\circ} \mathrm{C}$ |  | 0.32 |  |  |
| OFF-State Drain Leakage Current | $\mathrm{I}_{\text {oss } 1}$ | $\begin{gathered} \mathrm{V}_{\text {Bpp }}=\mathrm{V}_{\text {Bpo }}+0.1 \mathrm{~V} \\ \mathrm{~V}_{\mathrm{DS}}=80 \% \text { Peak Drain Voltage } \\ \mathrm{T}_{\mathrm{J}}=125^{\circ} \mathrm{C} \end{gathered}$ |  |  |  | 200 | $\mu \mathrm{A}$ |
|  | $\mathrm{I}_{\text {oss2 }}$ | $\begin{gathered} \mathrm{V}_{\text {BPP }}=\mathrm{V}_{\text {Bpp }}+0.1 \mathrm{~V} \\ \mathrm{~V}_{\text {DS }}=325 \mathrm{~V} \\ \mathrm{~T}_{\mathrm{J}}=25^{\circ} \mathrm{C} \end{gathered}$ |  |  | 15 |  | $\mu \mathrm{A}$ |
| Drain Supply Voltage |  | See Note B |  |  |  |  | $v$ |
| Thermal Shutdown | $\mathrm{T}_{\text {so }}$ | See Note A |  | 135 | 142 | 150 | ${ }^{\circ} \mathrm{C}$ |
| Thermal Shutdown Hysteresis | $\mathrm{T}_{\text {S0(H) }}$ | See Note A |  |  | 70 |  | ${ }^{\circ} \mathrm{C}$ |


| Parameter | Symbol | Conditions $\text { SOURCE = } 0 \text { V }$ $\mathrm{T}_{\mathrm{J}}=-40^{\circ} \mathrm{C} \text { to } 125^{\circ} \mathrm{C}$ <br> (Unless Otherwise Specified) | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Secondary |  |  |  |  |  |  |
| Maximum Secondary Frequency | $\mathrm{f}_{\text {SREQ }}$ | $\mathrm{T}_{\mathrm{j}}=25^{\circ} \mathrm{C}$ | 164 | 180 |  | kHz |
| Minimum Off-time | $\mathrm{t}_{\text {off(MIN) }}$ | $\mathrm{C}_{\text {LoAD }}=5 \mathrm{nF}$ with SR enabled |  | 1.9 | 2.2 | $\mu \mathrm{S}$ |
| Start-Up VOUT Pin Regulation Voltage | $\mathrm{VOUT}_{\text {REG }}$ | $\mathrm{T}_{\mathrm{j}}=25^{\circ} \mathrm{C}$ | 4.85 | 5 | 5.15 | V |
| Output Voltage Programming Range | $\mathrm{V}_{\text {OUT(R) }}$ | Default $=5 \mathrm{~V}$ | 3.00 |  | 30 | V |
|  | TOL ${ }_{\text {vout }}$ | Tolerance $\mathrm{T}_{\mathrm{j}}=25^{\circ} \mathrm{C}$ | -3 |  | +3 | \% |
| Output Voltage Step Size | $\Delta \mathrm{V}_{\text {out }}$ | $\mathrm{T}_{\mathrm{j}}=25^{\circ} \mathrm{C}$ |  | 10 |  | mW |
| Report-Back Output Voltage Tolerance | $\mathrm{V}_{\text {out(T) }}$ | $\mathrm{T}_{\mathrm{j}}=25^{\circ} \mathrm{C}$ | -3 |  | +3 | \% |
| Normalized Output Current | $\mathrm{I}_{\text {out }}$ | $\begin{gathered} 0.6-1.0 \\ \mathrm{~T}_{\mathrm{J}}=25^{\circ} \mathrm{C} \text {, See Note } \mathrm{C} \end{gathered}$ | -5 |  | +5 | \% |
|  |  | $\begin{gathered} 0.2 \\ \mathrm{~T}_{\mathrm{J}}=25^{\circ} \mathrm{C} \text {, See Note } \mathrm{C} \end{gathered}$ | -15 |  | +15 |  |
| Normalized Output Current Step Size | $\Delta \mathrm{I}_{\text {OUT }}$ | $\mathrm{T}_{\mathrm{j}}=25^{\circ}$ |  | 0.52 |  | \% |
| Maximum V/I Update Rate | $\mathrm{t}_{\mathrm{VI}}$ | See Note B |  | 10 |  | ms |
| Minimum Time Delay Between $\mathrm{I}^{2} \mathrm{C}$ Commands | $\mathrm{t}_{\text {DELAY }}$ | See Note B | 150 |  |  | $\mu \mathrm{S}$ |
| Internal Current Limit Voltage Threshold | $\mathrm{I}_{\text {SV(T) }}$ | $\mathrm{T}_{\mathrm{J}}=25^{\circ} \mathrm{C}$ <br> Across External IS to GND Pin Resistor See Note F |  | 32 |  | mV |
| Cable Drop <br> Compensation (CDC) <br> Programming Range | $\varphi_{\text {CD }}$ | $\begin{gathered} \mathrm{T}_{\mathrm{J}}=25^{\circ} \mathrm{C} \\ \text { Default }=0 \mathrm{~V} \end{gathered}$ | 0 |  | 600 | mV |
| CDC Tolerance | $\mathrm{TOL} \varphi_{\mathrm{CD}}$ | $\begin{aligned} C D C & \geq 100 \mathrm{mV} \\ \mathrm{~T}_{\mathrm{j}} & =25^{\circ} \mathrm{C} \end{aligned}$ | -35 |  | +35 | mV |
| CDC Programming Step Size | $\Delta \varphi_{\mathrm{CD}}$ | $\mathrm{T}_{\mathrm{j}}=25^{\circ} \mathrm{C}$ |  | 50 |  | mV |
| Output Overvoltage Programming Range | $\mathrm{V}_{\text {ova }}$ | Default $=6.2 \mathrm{~V}$ | 3.3 |  | 40 | V |
| Output Overvoltage Tolerance | TOL ${ }_{\text {ova }}$ | $\mathrm{T}_{\mathrm{j}}=25^{\circ} \mathrm{C}$ | -3 |  | +3 | \% |
| Output Overvoltage Programming Step Size | $\Delta \mathrm{V}_{\text {ova }}$ |  |  | 100 |  | mV |
| Output Undervoltage Programming Range | $\mathrm{V}_{\text {UvA }}$ | Default $=3.6 \mathrm{~V}$ | 2.7 |  | 40 | V |
| Output Undervoltage Tolerance | TOL ${ }_{\text {UVA }}$ | $\mathrm{T}_{\mathrm{j}}=25^{\circ} \mathrm{C}$ | -3 |  | +3 | \% |


| Parameter | Symbol | Conditions $\text { SOURCE }=0 \mathrm{~V}$ $\mathrm{T}_{3}=-40^{\circ} \mathrm{C} \text { to } 125^{\circ} \mathrm{C}$ <br> (Unless Otherwise Specified) |  | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Secondary (cont.) |  |  |  |  |  |  |  |
| Output Undervoltage Programming Step Size | $\Delta \mathrm{V}_{\text {UVA }}$ |  |  |  | 100 |  | mV |
| Output Undervoltage Timer Programming Options | $\mathrm{t}_{\text {uvL }}$ | $\begin{gathered} T_{j}=25^{\circ} \mathrm{C} \\ \text { See Notes } \mathrm{B}, \mathrm{E} \end{gathered}$ | Programming Option 1 |  | 8 |  | ms |
|  |  |  | Programming Option 2 |  | 16 |  |  |
|  |  |  | Programming Option 3 |  | 32 |  |  |
|  |  |  | Default Programming Option 4 |  | 64 |  |  |
| Constant Output Power Onset Threshold Programming Range | $V_{\text {KP }}$ | Default $=30 \mathrm{~V}$ |  | 5.3 |  | 30 | V |
| Constant Output Power Tolerance | TOLP ${ }_{\text {out }}$ | At 85\% of Full Scale Current |  | -10 |  | +10 | \% |
| Constant Output Power Onset Threshold Programming Step Size | $\Delta \mathrm{V}_{\text {KP }}$ |  |  |  | 100 |  | mV |
| Constant Voltage Mode Timer Programming Options | $\mathrm{t}_{\text {cvo }}$ | $\mathrm{T}_{\mathrm{J}}=25^{\circ} \mathrm{C}$ <br> See Notes B, E | Programming Option 1 |  | 8 |  | ms |
|  |  |  | Programming Option 2 |  | 16 |  |  |
|  |  |  | Programming Option 3 |  | 32 |  |  |
|  |  |  | Programming Option 4 |  | 64 |  |  |
| Watchdog Timer | $\mathrm{t}_{\text {WDT }}$ | Default Programming Option 1 See Note B |  |  | 0.5 |  | sec |
|  |  | Programming Option 2, See Note B |  |  | 1 |  |  |
|  |  | Programming Option 3, See Note B |  |  | 2 |  |  |
| VB/D Drive Voltage | $\mathrm{V}_{\mathrm{VB} / \mathrm{D}}$ | With Respect to VOUT Pin |  | 4 | 7 |  | V |
| VB/D Pin Internal Current Discharge | $\mathrm{I}_{\mathrm{B/D(DS})}$ |  |  | 50 |  |  | mA |
| Secondary Over-Temperature Hysteresis | $\mathrm{T}_{\text {SEC(HYS }}$ | Progr | ming Option 1 Note B |  | 40 |  | ${ }^{\circ} \mathrm{C}$ |
|  |  | Progr | ming Option 2 <br> Note B |  | 60 |  |  |
| VOUT Pin Bleeder Current | $\mathrm{IVO}_{\text {BLD }}$ |  | UT $=5 \mathrm{~V}$ |  | 270 |  | mA |
| uVCC Supply Voltage | uVCC | $\begin{gathered} V_{\text {out }}=5 \mathrm{~V}, \\ \mathrm{~T}_{\mathrm{j}}=25^{\circ} \mathrm{C}, \text { See } \end{gathered}$ | $\mathrm{mA}<\mathrm{I}_{\text {uvcc }} \leq 40 \mathrm{~mA} \text {, }$ <br> 5 in Absolute Maximum ings Table | 3.42 | 3.6 | 3.78 | V |
|  |  |  | $\begin{aligned} & \geq 3.9 \mathrm{~V} \\ & \mathrm{~T} \\ & \leq 10 \mathrm{~mA} \\ & =25^{\circ} \mathrm{C} \end{aligned}$ | 3.42 | 3.6 | 3.78 |  |


| Parameter | Symbol | $\begin{gathered} \text { Conditions } \\ \text { SOURCE }=0 \mathrm{~V} \\ \mathrm{~T}_{3}=-40^{\circ} \mathrm{C} \text { to } 125^{\circ} \mathrm{C} \\ \text { (Unless Otherwise Specified) } \end{gathered}$ |  | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Secondary (cont.) |  |  |  |  |  |  |  |
| uVCC Pin Output Resistance | $\mathrm{R}_{\text {uvce }}$ | $\mathrm{T}_{3}=25^{\circ} \mathrm{C}$ |  |  |  | 20 | $\Omega$ |
| uVCC Reset Voltage Threshold | $\mathrm{uVCC}_{\text {RST }}$ | See Note A |  |  | 2.5 | 2.65 | v |
| BPS Pin Voltage | $\mathrm{V}_{\text {BPS }}$ |  |  | 4.3 | 4.5 |  | v |
| BPS Pin Current | $\mathrm{I}_{\text {SNL }}$ | $\mathrm{T}_{\mathrm{J}}=25^{\circ} \mathrm{C}$ <br> VBUS Switch Open |  |  | 0.7 | 0.980 | mA |
|  |  | $\mathrm{T}_{3}=25^{\circ} \mathrm{C}$ <br> VBUS Switch Closed |  |  | 1 | 1.550 |  |
| BPS Pin Current | $\mathrm{I}_{52}$ | $\begin{gathered} \mathrm{F}_{\mathrm{SW}}=180 \mathrm{kHz} \\ \mathrm{~T}_{\mathrm{J}}=25^{\circ} \mathrm{C} \end{gathered}$ |  | 7 | 8.2 | 9.5 | mA |
| BPS Pin Undervoltage Threshold | $\mathrm{V}_{\text {BPS(IULOTH }}$ |  |  |  | 3.8 | 4.0 | v |
| BPS Pin Undervoltage Hysteresis | $\mathrm{V}_{\text {BPs(uvion }}$ |  |  |  | 0.7 |  | v |
| FORWARD Pin Breakdown Voltage | $\mathrm{BV}_{\text {fwo }}$ |  |  | 150 |  |  | v |
| Synchronous Rectifier @ $\mathrm{T}_{3}=25^{\circ} \mathrm{C}$ |  |  |  |  |  |  |  |
| SR Pin Drive Voltage | $\mathrm{V}_{\text {SR }}$ |  |  |  | 4.5 |  | v |
| SR Pin Voltage Threshold | $\mathrm{V}_{\text {SR(TH) }}$ |  |  |  | -3 |  | mV |
| Rise Time | $\mathrm{t}_{\text {R(SR) }}$ | $\begin{aligned} & \mathrm{T}_{\mathrm{j}}=25^{\circ} \mathrm{C} \\ & \mathrm{C}_{\text {Load }}=2 \mathrm{nF} \\ & \text { See Note } \end{aligned}$ | 10-90\% |  | 50 |  | ns |
| Fall Time | $\mathrm{t}_{\text {FSR) }}$ | $\begin{aligned} & \mathrm{T}_{\mathrm{J}}=25^{\circ} \mathrm{C} \\ & \mathrm{C}_{\text {Load }}=2 \mathrm{nF} \\ & \text { See Note } \end{aligned}$ | 90-10\% |  | 30 |  | ns |
| Output Pull-Up Resistance | $\mathrm{R}_{\text {pu }}$ | $\begin{gathered} \mathrm{T}_{\mathrm{J}}=25^{\circ} \mathrm{C} \\ \mathrm{~V}_{\mathrm{BPS}}+0.1 \mathrm{~V} \\ \mathrm{I}_{\mathrm{SR}}=30 \mathrm{~mA} \\ \hline \end{gathered}$ |  |  | 8.9 | 11.5 |  |
| Output Pull-Down Resistance | $\mathrm{R}_{\text {po }}$ | $\begin{gathered} \mathrm{T}_{j}=25^{\circ} \mathrm{C} \\ \mathrm{~V}_{\mathrm{BPSP}}+0.2 \mathrm{~V} \\ \mathrm{I}_{\mathrm{SR}}=30 \mathrm{~mA} \end{gathered}$ |  |  | 4.7 | 5 |  |


|  |  | Conditions |
| :---: | :---: | :---: |
| Parameter | Symbol | SOURCE $=0 \mathrm{~V}$ <br> $\mathrm{~T}_{3}=-40^{\circ} \mathrm{C}$ to $1255^{\circ} \mathrm{C}$ <br> (Unless Otherwise Specified) |


| SCL Clock Frequency | $\mathrm{f}_{\text {scl }}$ | See Note G | 50 | 400 | 535 | kHz |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Low-level Input Voltage | $\mathrm{V}_{\mathrm{IL}}$ |  | -0.5 |  | $\begin{aligned} & 0.3 \times \\ & \text { uVCC } \end{aligned}$ | V |
| High-level Input Voltage | $\mathrm{V}_{\mathrm{IH}}$ |  | $\begin{aligned} & 0.7 \times \\ & \text { uVCC } \end{aligned}$ |  | $\begin{gathered} \text { uVCC + } \\ 0.5 \mathrm{~V} \end{gathered}$ | V |
| Hysteresis of Schmitt Trigger Inputs | $\mathrm{V}_{\mathrm{HYS}}$ |  | $\begin{aligned} & 0.05 \times \\ & \text { uVCC } \end{aligned}$ |  |  | V |
| Low-Level Output Voltage (Open Drain or Collector) | $\mathrm{V}_{\text {oL }}$ | uVCC $>2.8 \mathrm{~V}$ 3 mA Sink Current | 0 |  | 0.4 | V |
| Low-level Output Current | $\mathrm{I}_{\mathrm{OL}}$ |  | 3 |  |  | mA |
| Output Fall-Time from $\mathbf{V}_{\text {IH(MIN) }}$ to $\mathrm{V}_{\text {IL(MAX) }}$ | $\mathrm{t}_{\text {OF }}$ | Bus Capacitance from 10 pF to 400 pF | - |  | 250 | ns |
| SDA/SCL Input Current | $\mathrm{I}_{\mathrm{I}}$ | $(0.1 \times \mathrm{uVCC})<\left(\mathrm{V}_{\text {scl }} / \mathrm{V}_{\text {SDA }}\right)<(0.9 \times \mathrm{uVCC})$ | -1 |  | 1 | $\mu \mathrm{A}$ |
| SDA/SCL Capacitance | $\mathrm{C}_{1}$ |  | - |  | 10 | pF |
| Pulse Width of Spike Suppressed by Input Filter | $\mathrm{t}_{\text {SP }}$ |  | 50 |  |  | ns |
| High Period for SCL Clock | $\mathrm{t}_{\text {HIGH }}$ | $\mathrm{f}_{\mathrm{scL}}=400 \mathrm{kHz}$ | 0.6 |  |  | $\mu \mathrm{s}$ |
| Low Period for SCL Clock | $\mathrm{t}_{\text {Low }}$ | $\mathrm{f}_{\mathrm{scL}}=400 \mathrm{kHz}$ | 1.3 |  |  | $\mu \mathrm{s}$ |
| Serial Data Set-up Time | $\mathrm{t}_{\text {SU:DAT }}$ |  | 100 |  |  | ns |
| Serial Data Hold time | $\mathrm{t}_{\text {HD:DAT }}$ |  | 0 |  |  | sec |
| Valid Data Time | $\mathrm{t}_{\text {vo }{ }_{\text {DAT }}}$ | SCL Low to SDA Output Valid |  |  | 0.9 | $\mu \mathrm{s}$ |
| Valid Data Time for ACK | $\mathrm{t}_{\text {VD:ACK }}$ | ACK from SCL Low to SDA Low |  |  | 0.9 | $\mu \mathrm{s}$ |
| $I^{2} \mathrm{C}$ Bus Free Time Between Start and Stop | $\mathrm{t}_{\text {BuF }}$ |  | 1.3 |  |  | $\mu \mathrm{S}$ |
| $I^{2} \mathrm{C}$ Fall Time <br> (Both SCL and SDA) | $\mathrm{t}_{\mathrm{fCL}}$ |  |  |  | 300 | ns |
| $I^{2} \mathrm{C}$ Rise Time (Both SCL and SDA) | $\mathrm{trab}_{\text {cl }}$ |  |  |  | 300 | ns |
| $\mathbf{I}^{2} \mathbf{C}$ Start or Repeated Start Condition Set-up Time | $\mathrm{t}_{\text {Su:STA }}$ |  | 0.6 |  |  | $\mu \mathrm{S}$ |
| $\mathbf{I}^{2} \mathbf{C}$ Start or Repeated Start Condition Hold Time | $\mathrm{t}_{\text {HD:STA }}$ |  | 0.6 |  |  | $\mu \mathrm{S}$ |


| Parameter | Symbol | Conditions <br> SOURCE $=0 \mathrm{~V}$ <br> $\mathrm{~T}_{\mathrm{J}}=-40^{\circ} \mathrm{C}$ to $125^{\circ} \mathrm{C}$ <br> (Unless Otherwise Specified) | Min | Typ | Max | Units |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: |

A. This parameter is derived from characterization.
B. This parameter is guaranteed by design.
C. Use $1 \%$ tolerance resistor.
D. To ensure correct current limit it is recommended that nominal $0.47 \mu \mathrm{~F} / 4.7 \mu \mathrm{~F}$ capacitors are used. In addition, the BPP capacitor value tolerance should be equal or better than indicated below across the ambient temperature range of the target application. The minimum and maximum capacitor values are guaranteed by characterization.

| Nominal BPP Pin <br> Capacitor Value | BPP Capacitor Value Tolerance |  |
| :---: | :---: | :---: |
|  | Minimum | Maximum |
| $0.47 \mu \mathrm{~F}$ | $-60 \%$ | $+100 \%$ |
| $4.7 \mu \mathrm{~F}$ | $-50 \%$ | $\mathrm{~N} / \mathrm{A}$ |

Recommended to use at least $10 \mathrm{~V} / 0805$ / X7R SMD MLCC.
E. Settling delay in averaging register will increase total observed time under light and no-load conditions.
F. This parameter should be used only for calculation of typical value of current sense resistor. The value programmed in CC register ( $0 \times 98$ ) regulates the output current. The tolerance is specified in the Normalized Output Current parameter ( $\mathrm{I}_{\text {out }}$ ).
G. Guarantee minimum low period for SCL clock of 930 ns while operating at any SCL clock frequency. This may require using asymmetrical SCL clock (reduced duty cycle) at higher frequencies.


Figure 38. $\mathrm{I}^{2} \mathrm{C}$ Timing Diagram.

## Typical Performance Curves



Figure 39. Output Characteristics.


Figure 41. Drain Capacitance Power.


Figure 43. SYNCHRONOUS RECTIFIER DRIVE Pin Negative Voltage.


Figure 40. $\mathrm{C}_{\text {oss }}$ vs. Drain Voltage.


Figure 42. Maximum Allowable Drain Current vs. Drain Voltage.


Figure 44. Standard Current Limit vs. di/dt.

## PACKAGE MARKING

## InSOP-T28D


A. Power Integrations Registered Trademark
B. Assembly Date Code (last two digits of year (YY) followed by 2-digit work week (WW)
C. Product Identification (Part \#/Package Type)
D. Lot Identification Code
E. Pin 1 Indicator
F. Test Lot Information and Feature Code

Safety Certification Specifications (Safety approval pending)

| Parameter | Conditions | Rating | Units |
| :---: | :---: | :---: | :---: |
| Ratings for UL1577 |  |  |  |
| Primary-Side Current Rating | Current from pin (16-19) to pin 24 | 1.5 | A |
| Primary-Side Power Rating | $\mathrm{T}_{\mathrm{AMB}}=25^{\circ} \mathrm{C}$ <br> (Device mounted in socket resulting in $\mathrm{T}_{\text {CASE }}=120^{\circ} \mathrm{C}$ ) | 1.35 | W |
| Secondary-Side Power Rating | $\mathrm{T}_{\text {AMB }}=25^{\circ} \mathrm{C}$ <br> (Device mounted in socket) | 0.125 | W |
| Package Characteristics |  |  |  |
| Clearance |  | 11.4 | mm (min) |
| Creepage |  | 11.4 | mm (min) |
| Distance Through Insulation (DTI) |  | 0.4 | mm (min) |
| Transient Isolation Voltage |  | 6 | kV (min) |
| Comparative Tracking Index (CTI) |  | >600 | V |

## Feature Code Table

| Summary Features |  |
| :--- | :--- |
| $\mathbf{I}_{\text {LIM }}$ Selectable | H901 |
| Over-Temperature Protection | Hysteretic |
| Line OV/UV | Enabled |
| Line UV Timer (35 ms or 400 ms) | 35 ms |

## MSL Table

| Part Number | MSL Rating |
| :---: | :---: |
| INN5x7xF | 3 |

## ESD and Latch-Up Table

| Test | Conditions | Results |
| :---: | :---: | :---: |
| Latch-up at $125^{\circ} \mathrm{C}$ | JESD78D | $> \pm 100 \mathrm{~mA}$ or $>1.5 \times \mathrm{V}_{\text {MAX }}$ on all pins |
| Charge Device Model ESD | ANSI/ESDA/JEDEC JS-002-2014 | $> \pm 1 \mathrm{kV}$ on all pins |

## Part Ordering Information



| Revision | Notes | Date |
| :---: | :--- | :---: |
| C | Production release. | $01 / 24$ |

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